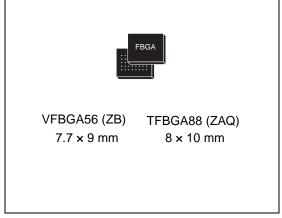


M58WR016KT M58WR032KT M58WR064KT M58WR016KB M58WR032KB M58WR064KB

16-, 32-, 64-Mbit (x16, multiple bank, burst) 1.8 V supply Flash memories

Features

- Supply voltage
 - V_{DD} = 1.7 V to 2 V for program, erase and read
 - V_{DDO} = 1.7 V to 2 V for I/O buffers
 - V_{PP} = 9 V for fast program
- Synchronous/asynchronous read
 - Synchronous burst read mode: 66 MHz
 - Asynchronous/synchronous page read mode
 - Random access times: 70 ns
- Synchronous burst read suspend
- Programming time
 - 10 µs by word typical for fast factory program
 - Double/quadruple word program option
 - Enhanced factory program options
- Memory blocks
 - Multiple bank memory array: 4 Mbit banks
 - Parameter blocks (top or bottom location)
- Dual operations
 - Program erase in one bank while read in others
 - No delay between read and write operations
- Block locking
 - All blocks locked at power-up
 - Any combination of blocks can be locked
 - WP for block lock-down
- Security
 - 128-bit user programmable OTP cells
 - 64-bit unique device number
- Common Flash interface (CFI)
- 100 000 program/erase cycles per block



- Electronic signature
 - Manufacturer code: 20h
 - Device codes:M58WR016KT (top): 8812hM58WR016KB (bottom): 8813h
 - M58WR032KT (top): 8814h
 M58WR032KB (bottom): 8815h
 - M58WR064KT (top): 8810h
 M58WR064KB (bottom): 8811h
- ECOPACK® package available

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1 Description

The M58WR016KT/B, M58WR032KT/B and M58WR064KT/B are 16 Mbit (1 Mbit ×16), 32 Mbit (2 Mbit ×16) and 64 Mbit (4 Mbit ×16) non-volatile Flash memories, respectively. They may be erased electrically at block level and programmed in-system on a word-byword basis using a 1.7 V to 2 V $_{\rm DD}$ supply for the circuitry and a 1.7 V to 2 V $_{\rm DDQ}$ supply for the Input/Output pins. An optional 9 V $_{\rm PP}$ power supply is provided to speed up customer programming.

The M58WRxxxKT/B feature an asymmetrical block architecture.

- The M58WR016KT/B has an array of 39 blocks, and is divided into 4 Mbit banks. There
 are 3 banks each containing 8 main blocks of 32 Kwords, and one parameter bank
 containing 8 parameter blocks of 4 Kwords and 7 main blocks of 32 Kwords.
- The M58WR032KT/B has an array of 71 blocks, and is divided into 4 Mbit banks. There
 are 7 banks each containing 8 main blocks of 32 Kwords, and one parameter bank
 containing 8 parameter blocks of 4 Kwords and 7 main blocks of 32 Kwords.
- The M58WR064KT/B has an array of 135 blocks, and is divided into 4 Mbit banks.
 There are 15 banks each containing 8 main blocks of 32 Kwords, and one parameter bank containing 8 parameter blocks of 4 Kwords and 7 main blocks of 32 Kwords.

The multiple bank architecture allows dual operations. While programming or erasing in one bank, read operations are possible in other banks. Only one bank at a time is allowed to be in program or erase mode. It is possible to perform burst reads that cross bank boundaries. The bank architectures are summarized in *Table 2*, *Table 3* and *Table 4* and the memory maps are shown in *Figure 4*, *Figure 5* and *Figure 6*. The parameter blocks are located at the top of the memory address space for the M58WR016KT, M58WR032KT and M58WR064KT, and at the bottom for the M58WR016KB, M58WR032KB and M58WR064KB.

Each block can be erased separately. Erase can be suspended to perform program in any other block, and then resumed. Program can be suspended to read data in any other block and then resumed. Each block can be programmed and erased over 100 000 cycles using the supply voltage V_{DD} . Two enhanced factory programming commands are available to speed up programming.

Program and erase commands are written to the command interface of the memory. An internal Program/Erase Controller manages the timings necessary for program and erase operations. The end of a program or erase operation can be detected and any error conditions identified in the Status Register. The command set required to control the memory is consistent with JEDEC standards.

The device supports synchronous burst read and asynchronous read from all blocks of the memory array; at power-up the device is configured for asynchronous read. In synchronous burst mode, data is output on each clock cycle at frequencies of up to 66 MHz. The synchronous burst read operation can be suspended and resumed.

The device features an automatic standby mode. When the bus is inactive during asynchronous read operations, the device automatically switches to the automatic standby mode. In this condition the power consumption is reduced to the standby value I_{DD4} and the outputs are still driven.

The M58WRxxxKT/B feature an instant, individual block locking scheme that allows any block to be locked or unlocked with no latency, enabling instant code and data protection. All blocks have three levels of protection. They can be locked and locked-down individually preventing any accidental programming or erasure. There is additional hardware protection against program and erase. When $V_{PP} \leq V_{PPLK}$ all blocks are protected against program or erase. All blocks are locked at power-up.

The device includes a Protection Register to increase the protection of a system's design. The Protection Register is divided into two segments: a 64-bit segment containing a unique device number written by Numonyx, and a 128-bit segment one-time-programmable (OTP) by the user. The user programmable segment can be permanently protected. *Figure* 7 shows the Protection Register memory map.

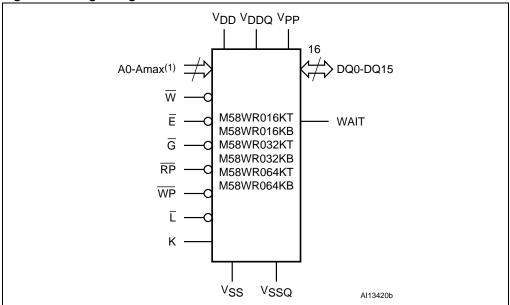
The memory is offered in either of the following packages:

- VFBGA56 7.7 x 9 mm, 8 x 7 active ball array, 0.75 mm pitch
- TFBGA88 8 x 10 mm, 8 x 10 active ball array, 0.8 mm pitch

The device is supplied with all the bits erased (set to '1').

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Figure 1. Logic diagram



Amax is equal to A19 in the M58WR016KT/B, to A20 in the M58WR032KT/B and, to A21 in the M58WR064KT/B.

Table 1. Signal names

Signal name	Function	Direction
A0-Amax ⁽¹⁾	Address inputs	Inputs
DQ0-DQ15	Data input/outputs, command inputs	I/O
Ē	Chip Enable	Input
G	Output Enable	Input
W	Write Enable	Input
RP	Reset	Input
WP	Write Protect	Input
К	Clock	Input
Ī	Latch Enable	Input
WAIT	Wait	Output
V_{DD}	Supply voltage	Input
V_{DDQ}	Supply voltage for input/output buffers	Input
V _{PP}	Optional supply voltage for fast program and erase	Input
V _{SS}	Ground	
V_{SSQ}	Input/output supply ground	
NC	Not connected internally	
DU	Do not use	

Amax is equal to A19 in the M58WR016KT/B, to A20 in the M58WR032KT/B and, to A21 in the M58WR064KT/B.

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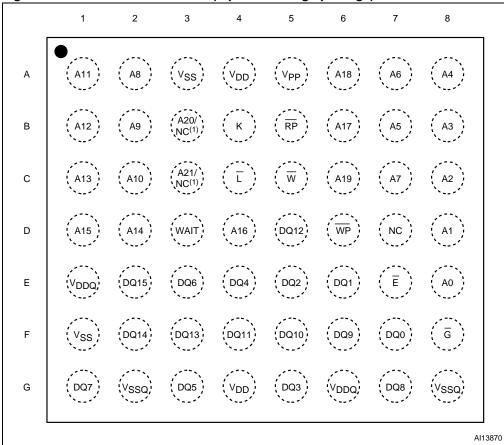


Figure 2. VFBGA56 connections (top view through package)

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Ball B3 is A20 in the M58WR032KT/B and M58WR064KT/B, it is not connected internally (NC) in the M58WR016KT/B. Ball C3 is A21 in the M58WR064KT/B, it is not connected internally in the M58WR016KT/B and M58WR032KT/B.

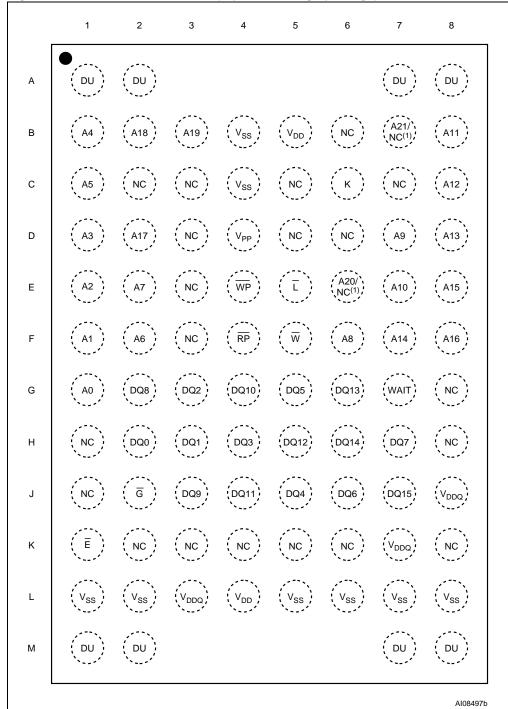


Figure 3. TFBGA88 connections (top view through package)

Ball E6 is A20 in the M58WR032KT/B and M58WR064KT/B, and is not connected internally (NC) in the M58WR016KT/B. Ball B7 is A21 in the M58WR064KT/B, and is not connected internally in the M58WR016KT/B and M58WR032KT/B.

Table 2. M58WR016KT/B bank architecture

Number	Bank size	Parameter blocks	Main blocks
Parameter bank	4 Mbit	8 blocks of 4 Kword	7 blocks of 32 Kword
Bank 1	4 Mbit	-	8 blocks of 32 Kword
Bank 2	4 Mbit	-	8 blocks of 32 Kword
Bank 3	4 Mbit	-	8 blocks of 32 Kword

Table 3. M58WR032KT/B bank architecture

Number	Number Bank size		Main blocks
Parameter bank	4 Mbit	8 blocks of 4 Kword	7 blocks of 32 Kword
Bank 1	4 Mbit	-	8 blocks of 32 Kword
Bank 2	4 Mbit	-	8 blocks of 32 Kword
Bank 3	4 Mbit	-	8 blocks of 32 Kword
Bank 6	4 Mbit	-	8 blocks of 32 Kword
Bank 7	4 Mbit	-	8 blocks of 32 Kword

Table 4. M58WR064KT/B bank architecture

Number	Bank size	Parameter blocks	Main blocks
Parameter Bank	4 Mbit	8 blocks of 4 Kword	7 blocks of 32 Kword
Bank 1	4 Mbit	-	8 blocks of 32 Kword
Bank 2	4 Mbit	-	8 blocks of 32 Kword
Bank 3 4 Mbit		-	8 blocks of 32 Kword
Bank 14	4 Mbit	-	8 blocks of 32 Kword
Bank 15	4 Mbit	-	8 blocks of 32 Kword

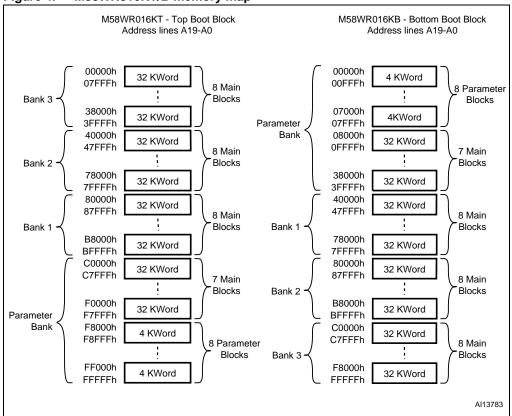


Figure 4. M58WR016KT/B memory map

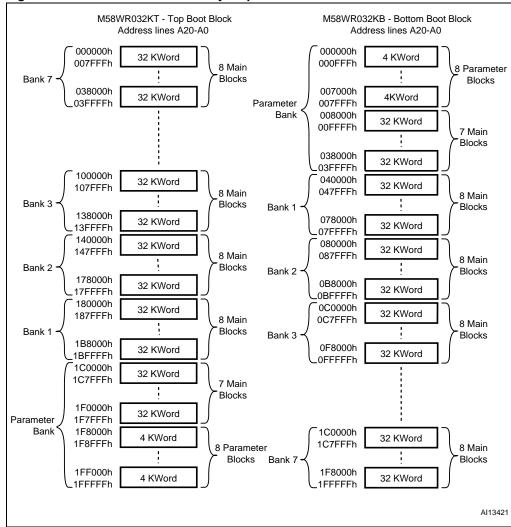


Figure 5. M58WR032KT/B memory map

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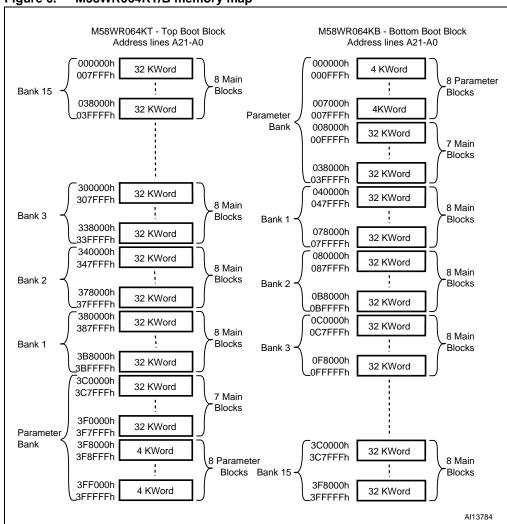


Figure 6. M58WR064KT/B memory map

2 Signal descriptions

See Figure 1: Logic diagram and Table 1: Signal names for a brief overview of the signals connected to this device.

2.1 Address inputs (A0-Amax)

Amax is the highest order address input. It is equal to A19 in the M58WR016KT/B, to A20 in the M58WR032KT/B and, to A21 in the M58WR064KT/B. The address inputs select the cells in the memory array to access during bus read operations. During bus write operations they control the commands sent to the command interface of the Program/Erase Controller.

2.2 Data inputs/outputs (DQ0-DQ15)

The data I/O output the data stored at the selected address during a bus read operation or input a command or the data to be programmed during a bus write operation.

2.3 Chip Enable (\overline{E})

The Chip Enable input activates the memory control logic, input buffers, decoders and sense amplifiers. When Chip Enable is at V_{IL} and Reset is at V_{IH} the device is in active mode. When Chip Enable is at V_{IH} the memory is deselected, the outputs are high impedance and the power consumption is reduced to the standby level.

2.4 Output Enable (G)

The Output Enable input controls data outputs during the bus read operation of the memory.

2.5 Write Enable (\overline{W})

The Write Enable input controls the bus write operation of the memory's command interface. The data and address inputs are latched on the rising edge of Chip Enable or Write Enable, whichever occurs first.

2.6 Write Protect (WP)

Write Protect is an input that provides additional hardware protection for each block. When Write Protect is at V_{IL} , the lock-down is enabled and the protection status of the locked-down blocks cannot be changed. When Write Protect is at V_{IH} , the lock-down is disabled and the locked-down blocks can be locked or unlocked. (refer to *Table 17: Lock status*).

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2.7 Reset (\overline{RP})

The Reset input provides a hardware reset of the memory. When Reset is at V_{IL} , the memory is in reset mode: the outputs are high impedance and the current consumption is reduced to the reset supply current I_{DD2} . Refer to *Table 22: DC characteristics - currents* for the value of I_{DD2} . After Reset all blocks are in the locked state and the Configuration Register is reset. When Reset is at V_{IH} , the device is in normal operation. Upon exiting reset mode the device enters asynchronous read mode, but a negative transition of Chip Enable or Latch Enable is required to ensure valid data outputs.

2.8 Latch Enable (\overline{L})

Latch Enable latches the address bits on its rising edge. The address latch is transparent when Latch Enable is at V_{IL} and it is inhibited when Latch Enable is at V_{IH} . Latch Enable can be kept Low (also at board level) when the Latch Enable function is not required or supported.

2.9 Clock (K)

The clock input synchronizes the memory to the microcontroller during synchronous read operations; the address is latched on a Clock edge (rising or falling, according to the configuration settings) when Latch Enable is at $V_{\rm IL}$. Clock is 'don't care' during asynchronous read and in write operations.

2.10 Wait (WAIT)

Wait is an output signal used during synchronous read to indicate whether the data on the output bus are valid. This output is high impedance when Chip Enable is at V_{IH} or Reset is at V_{IL} . It can be configured to be active during the wait cycle or one clock cycle in advance. The WAIT signal is not gated by Output Enable.

2.11 V_{DD} supply voltage

V_{DD} provides the power supply to the internal core of the memory device. It is the main power supply for all operations (read, program and erase).

2.12 V_{DDQ} supply voltage

 V_{DDQ} provides the power supply to the I/O pins and enables all outputs to be powered independently of V_{DD} . V_{DDQ} can be tied to V_{DD} or can use a separate supply.

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2.13 V_{PP} program supply voltage

 V_{PP} is both a control input and a power supply pin. The two functions are selected by the voltage range applied to the pin.

If V_{PP} is kept in a low voltage range (0 V to V_{DDQ}) V_{PP} is seen as a control input. In this case a voltage lower than V_{PPLK} provides absolute protection against program or erase, while V_{PP} in the V_{PP1} range enables these functions (see Tables 22 and 23, DC characteristics for the relevant values). V_{PP} is only sampled at the beginning of a program or erase; a change in its value after the operation has started does not have any effect and program or erase operations continue.

If V_{PP} is in the range of V_{PPH} it acts as a power supply pin. In this condition V_{PP} must be stable until the program/erase algorithm is completed.

2.14 V_{SS} ground

V_{SS} ground is the reference for the core supply, and must be connected to the system ground.

2.15 V_{SSO} ground

 $\rm V_{SSQ}$ ground is the reference for the input/output circuitry driven by $\rm V_{DDQ}.~V_{SSQ}$ must be connected to $\rm V_{SS}$

Note:

Each device in a system should have V_{DD} , V_{DDQ} and V_{PP} decoupled with a 0.1 μ F ceramic capacitor close to the pin (high-frequency, inherently-low inductance capacitors should be as close as possible to the package). See Figure 11: AC measurement load circuit. The PCB track widths should be sufficient to carry the required V_{PP} program and erase currents.

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3 Bus operations

There are six standard bus operations that control the device. These are bus read, bus write, address latch, output disable, standby and reset. See *Table 5: Bus operations* for a summary.

Typically glitches of less than 5 ns on Chip Enable or Write Enable are ignored by the memory and do not affect bus write operations.

3.1 Bus read

Bus read operations output the contents of the memory array, the electronic signature, the Status Register and the common Flash interface. Both Chip Enable and Output Enable must be at V_{IL} in order to perform a read operation. The Chip Enable input should be used to enable the device. Output Enable should be used to gate data onto the output. The data read depends on the previous command written to the memory (see Section 4: Command interface). See Figures 12, 13, 14 and 15, read AC waveforms, and Tables 24 and 25, read AC characteristics, for details of when the output becomes valid.

3.2 Bus write

Bus write operations write commands to the memory or latch input data to be programmed. A bus write operation is initiated when Chip Enable and Write Enable are at V_{IL} with Output Enable at V_{IH} . Commands, input data and addresses are latched on the rising edge of Write Enable or Chip Enable, whichever occurs first. The addresses can also be latched prior to the write operation by toggling Latch Enable. In this case the Latch Enable should be tied to V_{IH} during the bus write operation.

See Figures 18 and 19, write AC waveforms, and Tables 26 and 27, write AC characteristics for details of the timing requirements.

3.3 Address Latch

Address latch operations input valid addresses. Both Chip enable and Latch Enable must be at V_{IL} during address latch operations. The addresses are latched on the rising edge of Latch Enable.

3.4 Output Disable

The outputs are high impedance when the Output Enable is at V_{IH}.

3.5 Standby

Standby disables most of the internal circuitry allowing a substantial reduction of the current consumption. The memory is in standby when Chip Enable and Reset are at V_{IH} . The power consumption is reduced to the standby level and the outputs are set to high impedance, independently from the Output Enable or Write Enable inputs. If Chip Enable switches to V_{IH} during a program or erase operation, the device enters standby mode when finished.

3.6 Reset

During reset mode the memory is deselected and the outputs are high impedance. The memory is in reset mode when Reset is at V_{IL} . The power consumption is reduced to the standby level, independently from the Chip Enable, Output Enable or Write Enable inputs. If Reset is pulled to V_{SS} during a program or erase, this operation is aborted and the memory content is no longer valid.

Table 5. Bus operations⁽¹⁾

Operation	Ē	G	W	Ī	RP	WAIT ⁽²⁾	DQ15-DQ0
Bus read	V_{IL}	V_{IL}	V _{IH}	V _{IL} (3)	V _{IH}		Data output
Bus write	V_{IL}	V_{IH}	V_{IL}	V _{IL} (3)	V _{IH}		Data input
Address latch	V _{IL}	Х	V _{IH}	V _{IL}	V _{IH}		Data output or Hi-Z (4)
Output disable	V _{IL}	V _{IH}	V _{IH}	Х	V _{IH}		Hi-Z
Standby	V_{IH}	Х	Х	Х	V _{IH}	Hi-Z	Hi-Z
Reset	Х	Х	Х	Х	V _{IL}	Hi-Z	Hi-Z

^{1.} X = 'don't care'

^{2.} WAIT signal polarity is configured using the Set Configuration Register command.

^{3.} \overline{L} can be tied to V_{IH} if the valid address has been previously latched.

^{4.} Depends on \overline{G} .

4 Command interface

All bus write operations to the memory are interpreted by the command interface. Commands consist of one or more sequential bus write operations. An internal Program/Erase Controller manages all timings and verifies the correct execution of the program and erase commands. The Program/Erase Controller provides a Status Register whose output may be read at any time to monitor the progress or the result of the operation.

The command interface is reset to read mode when power is first applied, when exiting from Reset, or whenever V_{DD} is lower than V_{LKO} . Command sequences must be followed exactly. Any invalid combination of commands is ignored.

Refer to *Table 6: Command codes*, and *Appendix D*, Tables *48*, *49*, *50* and *51*, command interface states - modify and lock tables, for a summary of the command interface.

The command interface is split into two types of commands: standard commands and factory program commands. The following sections explain in detail how to perform each command.

Table 6. Command codes

Hex Code	Command				
01h	Block Lock Confirm				
03h	Set Configuration Register Confirm				
10h	Alternative Program Setup				
20h	Block Erase Setup				
2Fh	Block Lock-Down Confirm				
30h	Enhanced Factory Program Setup				
35h	Double Word Program Setup				
40h	Program Setup				
50h	Clear Status Register				
56h	Quadruple Word Program Setup				
60h	Block Lock Setup, Block Unlock Setup, Block Lock Down Setup and Set Configuration Register Setup				
70h	Read Status Register				
75h	Quadruple Enhanced Factory Program Setup				
90h	Read Electronic Signature				
98h	Read CFI Query				
B0h	Program/Erase Suspend				
C0h	Protection Register Program				
D0h	Program/Erase Resume, Block Erase Confirm, Block Unlock Confirm or Enhanced Factory Program Confirm				
FFh	Read Array				

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5 Command interface - standard commands

The following commands are the basic commands used to read, write to and configure the device. Refer to *Table 7: Standard commands*, in conjunction with the following descriptions in this section.

5.1 Read Array command

The Read Array command returns the addressed bank to read array mode. One bus write cycle is required to issue the Read Array command and return the addressed bank to read array mode. Subsequent read operations read the addressed location and output the data. A Read Array command can be issued in one bank while programming or erasing in another bank. However, if a Read Array command is issued to a bank currently executing a program or erase operation the command is executed but the output data is not guaranteed.

5.2 Read Status Register command

The Status Register indicates when a program or erase operation is complete and the success or failure of operation itself. Issue a Read Status Register command to read the Status Register content. The Read Status Register command can be issued at any time, even during program or erase operations.

The following read operations output the content of the Status Register of the addressed bank. The Status Register is latched on the falling edge of \overline{E} or \overline{G} signals, and can be read until \overline{E} or \overline{G} returns to V_{IH} . Either \overline{E} or \overline{G} must be toggled to update the latched data. See *Table 10* for the description of the Status Register bits. This mode supports asynchronous or single synchronous reads only.

5.3 Read Electronic Signature command

The Read Electronic Signature command reads the manufacturer and device codes, the block locking status, the Protection Register, and the Configuration Register.

The Read Electronic Signature command consists of one write cycle to an address within one of the banks. A subsequent read operation in the same bank outputs the manufacturer code, the device code, the protection status of the blocks in the targeted bank, the Protection Register, or the Configuration Register (see *Table 8*).

Dual operations between the parameter bank and the electronic signature locations are not allowed (see *Table 16: Dual operation limitations*).

If a Read Electronic Signature command is issued in a bank that is executing a program or erase operation, the bank goes into read electronic signature mode, subsequent bus read cycles output the electronic signature data, and the Program/Erase Controller continues to program or erase in the background. This mode supports asynchronous or single synchronous reads only; it does not support page mode or synchronous burst reads.

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5.4 Read CFI Query command

The Read CFI Query command reads data from the common Flash interface (CFI). The Read CFI Query command consists of one bus write cycle to an address within one of the banks. Once the command is issued subsequent bus read operations in the same bank read from the common Flash interface.

If a Read CFI Query command is issued in a bank that is executing a program or erase operation, the bankgoes into Read CFI Query mode, subsequent bus read cycles output the CFI data, and the Program/Erase Controller continues to program or erase in the background. This mode supports asynchronous or single synchronous reads only; it does not support page mode or synchronous burst reads.

The status of the other banks is not affected by the command (see *Table 14*). After issuing a Read CFI Query command, a Read Array command should be issued to the addressed bank to return the bank to read array mode.

Dual operations between the parameter bank and the CFI memory space are not allowed (see *Table 16: Dual operation limitations* for details).

See Appendix B: Common Flash interface, Tables 38, 39, 40, 41, 42, 43, 44, 45, 46 and 47 for details on the information contained in the common Flash interface memory area.

5.5 Clear Status Register command

The Clear Status Register command resets (set to '0') error bits SR1, SR3, SR4 and SR5 in the Status Register. One bus write cycle is required to issue the Clear Status Register command. The Clear Status Register command does not change the read mode of the bank.

The error bits in the Status Register do not automatically return to '0' when a new command is issued. The error bits in the Status Register should be cleared before attempting a new program or erase command.

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5.6 Block Erase command

The Block Erase command erases a block. It sets all the bits within the selected block to '1'. All previous data in the block is lost. If the block is protected then the erase operation aborts, the data in the block does not change, and the Status Register outputs the error. The Block Erase command can be issued at any moment, regardless of whether the block has been programmed or not.

Two bus write cycles are required to issue the command:

- The first bus cycle sets up the erase command
- The second latches the block address in the Program/Erase Controller and starts it

If the second bus cycle is not Write Erase Confirm (D0h), Status Register bits SR4 and SR5 are set and the command aborts. Erase aborts if Reset turns to $V_{\rm IL}$. As data integrity cannot be guaranteed when the erase operation is aborted, the block must be erased again.

Once the command is issued, the device outputs the Status Register data when any address within the bank is read. At the end of the operation the bank remains in Read Status Register mode until a Read Array, Read CFI Query, or Read Electronic Signature command is issued.

During erase operations the bank containing the block being erased only accepts the Read Array, Read Status Register, Read Electronic Signature, Read CFI Query and the Program/Erase Suspend commands; all other commands are ignored. Refer to Section 10 for detailed information about simultaneous operations allowed in banks not being erased. Typical erase times are given in Table 18: Program, erase times and endurance cycles.

See Appendix C, Figure 27: Block erase flowchart and pseudo code for a suggested flowchart for using the Block Erase command.

5.7 Program command

The memory array can be programmed word-by-word. Only one word in one bank can be programmed at any one time. If the block is protected, the program operation aborts, the data in the block does not change, and the Status Register outputs the error.

Two bus write cycles are required to issue the Program command:

- The first bus cycle sets up the Program command
- The second latches the address and the data to be written and starts the Program/Erase Controller

After programming has started, read operations in the bank being programmed output the Status Register content.

During Program operations the bank being programmed only accepts the Read Array, Read Status Register, Read Electronic Signature, Read CFI Query and the Program/Erase Suspend commands. Refer to *Section 10* for detailed information about simultaneous operations allowed in banks not being programmed. Typical program times are given in *Table 18: Program, erase times and endurance cycles*.

Programming aborts if Reset goes to $V_{\rm IL}$. As data integrity cannot be guaranteed when the program operation is aborted, the memory location must be reprogrammed.

See *Appendix C*, *Figure 23: Program flowchart and pseudo code* for the flowchart for using the Program command.

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5.8 Program/Erase Suspend command

The Program/Erase Suspend command pauses a program or block erase operation.

One bus write cycle is required to issue the Program/Erase Suspend command. Once the Program/Erase Controller has paused bits SR7, SR6 and/ or SR2 of the Status Register are set to '1'. The command can be addressed to any bank.

During program/erase suspend the command interface accepts the Program/Erase Resume, Read Array (cannot read the erase-suspended block or the program-suspended word), Read Status Register, Read Electronic Signature, Clear Status Register, and Read CFI Query commands. In addition, if the suspended operation is erase then the Set Configuration Register, Program, Block Lock, Block Lock-Down or Block Unlock commands are also accepted. The block being erased may be protected by issuing the Block Lock, or Block Lock-Down commands. Only the blocks not being erased may be read or programmed correctly. When the Program/Erase Resume command is issued the operation completes. Refer to Section 10 for detailed information about simultaneous operations allowed during Program/Erase Suspend.

During a program/erase suspend, the device is placed in standby mode by taking Chip Enable to V_{IH} . Program/erase is aborted if Reset turns to V_{II} .

See Appendix C, Figure 26: Program suspend and resume flowchart and pseudo code, and Figure 28: Erase suspend and resume flowchart and pseudo code for flowcharts for using the Program/Erase Suspend command.

5.9 Program/Erase Resume command

The Program/Erase Resume command restarts the Program/Erase Controller after a Program/Erase Suspend command has paused it. One bus write cycle is required to issue the command. The command can be written to any address.

The Program/Erase Resume command does not change the read mode of the banks. If the suspended bank is in read Status Register, read electronic signature or read CFI query mode the bank remains in that mode and outputs the corresponding data. If the bank is in read array mode, subsequent read operations output invalid data.

If a Program command is issued during a block erase suspend, the erase cannot be resumed until the programming operation has completed. It is possible to accumulate suspend operations. For example, it is possible to suspend an erase operation, start a programming operation, suspend the programming operation, and then read the array. See Appendix C, Figure 26: Program suspend and resume flowchart and pseudo code and Figure 28: Erase suspend and resume flowchart and pseudo code for flowcharts for using the Program/Erase Resume command.

5.10 Protection Register Program command

The Protection Register Program command programs the 128-bit user OTP segment of the Protection Register and the Protection Register lock. The segment is programmed 16 bits at a time. When shipped, all bits in the segment are set to '1'. The user can only program the bits to '0'.

Two write cycles are required to issue the Protection Register Program command:

- The first bus cycle sets up the Protection Register Program command.
- The second latches the address and the data to be written to the Protection Register and starts the Program/Erase Controller.

Read operations output the Status Register content after the programming has started.

The segment can be protected by programming bit 1 of the Protection Lock Register (see *Figure 7: Protection Register memory map*). Attempting to program a previously protected Protection Register results in a Status Register error. The protection of the Protection Register is not reversible. The Protection Register program cannot be suspended. Dual operations between the parameter bank and the Protection Register memory space are not allowed (see *Table 16: Dual operation limitations*).

5.11 The Set Configuration Register command

The Set Configuration Register command writes a new value to the Configuration Register, which defines the burst length, type, X latency, synchronous/asynchronous read mode, and the valid Clock edge configuration.

Two bus write cycles are required to issue the Set Configuration Register command:

- The first cycle writes the setup command and the address corresponding to the Configuration Register content.
- The second cycle writes the Configuration Register data and the confirm command.

Read operations output the memory array content after the Set Configuration Register command is issued.

The value for the Configuration Register is always presented on A0-A15. CR0 is on A0, CR1 on A1, etc.; the other address bits are ignored.

5.12 Block Lock command

The Block Lock command locks a block and prevents program or erase operations from changing the data in it. All blocks are locked at power-up or reset.

Two bus write cycles are required to issue the Block Lock command:

- The first bus cycle sets up the Block Lock command.
- The second bus write cycle latches the block address.

The lock status can be monitored for each block using the Read Electronic Signature command. *Table 17* shows the lock status after issuing a Block Lock command.

The block lock bits are volatile; once set they remain set until a hardware reset or power-down/power-up. They are cleared by a Block Unlock command. Refer to Section 11: Block locking for a detailed explanation. See Appendix C, Figure 29: Locking operations flowchart and pseudo code for a flowchart for using the Lock command.

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5.13 Block Unlock command

The Block Unlock command unlocks a block, allowing the block to be programmed or erased. Two bus write cycles are required to issue the Block Unlock command:

- The first bus cycle sets up the Block Unlock command.
- The second bus write cycle latches the block address.

The lock status can be monitored for each block using the Read Electronic Signature command. *Table 17* shows the protection status after issuing a Block Unlock command. Refer to *Section 11: Block locking* for a detailed explanation and *Appendix C*, *Figure 29: Locking operations flowchart and pseudo code* for a flowchart for using the Unlock command.

5.14 Block Lock-Down command

A locked or unlocked block can be locked down by issuing the Block Lock-Down command. A locked-down block cannot be programmed or erased, or have its protection status changed when $\overline{\text{WP}}$ is low, V_{IL} . When $\overline{\text{WP}}$ is high, V_{IH} , the lock-down function is disabled and the locked blocks can be individually unlocked by the Block Unlock command.

Two bus write cycles are required to issue the Block Lock-Down command:

- The first bus cycle sets up the Block Lock command.
- The second bus write cycle latches the block address.

The lock status can be monitored for each block using the Read Electronic Signature command. Locked-down blocks revert to the locked (and not locked-down) state when the device is reset on power-down. *Table 17* shows the lock status after issuing a Block Lock-Down command. Refer to *Section 11: Block locking* for a detailed explanation and *Appendix C, Figure 29: Locking operations flowchart and pseudo code* for a flowchart for using the Lock-Down command.

Table 7. Standard commands

	Cycles	Bus operations ⁽¹⁾					
Commands		1st cycle			2nd cycle		
		Op.	Add	Data	Op.	Add	Data
Read Array	1+	Write	BKA	FFh	Read	WA	RD
Read Status Register	1+	Write	BKA	70h	Read	BKA ⁽²⁾	SRD
Read Electronic Signature	1+	Write	BKA	90h	Read	BKA ⁽²⁾	ESD
Read CFI Query	1+	Write	BKA	98h	Read	BKA ⁽²⁾	QD
Clear Status Register	1	Write	Х	50h			
Block Erase	2	Write	BKA or BA ⁽³⁾	20h	Write	BA	D0h
Program	2	Write	BKA or WA ⁽³⁾	40h or 10h	Write	WA	PD
Program/Erase Suspend	1	Write	Х	B0h			
Program/Erase Resume	1	Write	Х	D0h			
Protection Register Program	2	Write	PRA	C0h	Write	PRA	PRD
Set Configuration Register	2	Write	CRD	60h	Write	CRD	03h
Block Lock	2	Write	BKA or BA ⁽³⁾	60h	Write	ВА	01h
Block Unlock	2	Write	BKA or BA ⁽³⁾	60h	Write	ВА	D0h
Block Lock-Down	2	Write	BKA or BA ⁽³⁾	60h	Write	ВА	2Fh

X = 'don't care', WA = Word Address in targeted bank, RD = Read Data, SRD = Status Register Data, ESD = Electronic Signature Data, QD = Query Data, BA = Block Address, BKA = Bank Address, PD = Program Data, PRA = Protection Register Address, PRD = Protection Register Data, CRD = Configuration Register Data.

^{2.} Must be same bank as in the first cycle. The signature addresses are listed in *Table 8*.

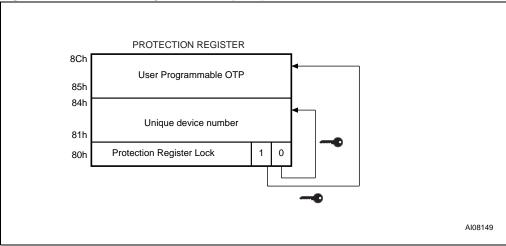
^{3.} Any address within the bank can be used.

Table 8. Electronic signature codes

	Code	Address (h)	Data (h)	
Manufacturer code		Bank address + 00	0020	
Davies sada	Тор	Bank address + 01	8812 (M58WR016KT) 8814 (M58WR032KT) 8810 (M58WR064KT)	
Device code	Bottom	Bank address + 00 Bank address + 01 Bank address + 01 Block address + 02 Bank address + 03 Bank address + 05 Bank address + 80	8813 (M58WR016KB) 8815 (M58WR032KB) 8811 (M58WR064KB)	
Block protection	Locked		0001	
	Unlocked	Plack address + 02	0000	
	Locked and locked-down	Block address + 02	0003	
	Unlocked and locked-down		0002	
Reserved	Reserved		Reserved	
Configuration Registe	er	Bank address + 05	CR ⁽¹⁾	
Protection Register lock	Numonyx factory default	Pank address + 90	0002	
	OTP area permanently locked	Balik addless + 60	0000	
Protection Register	Bank address + 84		Unique device number	
Trotection (Vegister		Bank address + 85 Bank address + 8C	OTP Area	

^{1.} CR = Configuration Register.

Figure 7. Protection Register memory map



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6 Command interface - factory program commands

The factory program commands are specifically designed to speed up programming. They require V_{PP} to be at V_{PPH}. Refer to *Table 9: Factory program commands* in conjunction with the descriptions in this section.

The use of factory program commands requires certain operating conditions:

- V_{PP} must be set to V_{PPH}.
- V_{DD} must be within operating range.
- Ambient temperature, T_A must be 25°C ± 5°C.
- The targeted block must be unlocked.

6.1 Double Word Program command

The Double Word Program command improves the programming throughput by writing a page of two adjacent words in parallel. The two words must only differ for the address A0.

If the block is protected, then the Double Word Program operation aborts, the data in the block does not change, and the Status Register outputs the error.

 V_{PP} must be set to V_{PPH} during Double Word Program, otherwise the command is ignored and the Status Register does not output any error.

Three bus write cycles are necessary to issue the Double Word Program command:

- The first bus cycle sets up the Double Word Program command.
- The second bus cycle latches the address and the data of the first word to be written.
- The third bus cycle latches the address and the data of the second word to be written and starts the Program/Erase Controller.

Read operations in the bank being programmed output the Status Register content after the programming has started.

During double word program operations the bank being programmed only accepts the Read Array, Read Status Register, Read Electronic Signature and Read CFI Query commands; all other commands are ignored. Dual operations are not supported during double word program operations and the command cannot be suspended. Typical program times are given in *Table 18: Program, erase times and endurance cycles*.

Programming aborts if Reset goes to V_{IL}. As data integrity cannot be guaranteed when the program operation is aborted, the memory locations must be reprogrammed.

See Appendix C, Figure 24: Double word program flowchart and pseudo code for the flowchart for using the Double Word Program command.

6.2 Quadruple Word Program command

The Quadruple Word Program command improves the programming throughput by writing a page of four adjacent words in parallel. The four words must only differ for the addresses A0 and A1.

V_{PP} must be set to V_{PPH} during Quadruple Word Program, otherwise the command is ignored and the Status Register does not output any error.

If the block is protected, then the Quadruple Word Program operation aborts, the data in the block does not change, and the Status Register outputs the error.

Five bus write cycles are necessary to issue the Quadruple Word Program command:

- The first bus cycle sets up the Double Word Program command.
- The second bus cycle latches the address and the data of the first word to be written.
- The third bus cycle latches the address and the data of the second word to be written.
- The fourth bus cycle latches the address and the data of the third word to be written.
- The fifth bus cycle latches the address and the data of the fourth word to be written and starts the Program/Erase Controller.

Read operations to the bank being programmed output the Status Register content after the programming has started.

Programming aborts if Reset goes to V_{IL} . As data integrity cannot be guaranteed when the program operation is aborted, the memory locations must be reprogrammed.

During Quadruple Word Program operations the bank being programmed only accepts the Read Array, Read Status Register, Read Electronic Signature and Read CFI Query commands; all other commands are ignored.

Dual operations are not supported during quadruple word program operations and the command cannot be suspended. Typical program times are given in *Table 18: Program, erase times and endurance cycles*.

See *Appendix C*, *Figure 25: Quadruple word program flowchart and pseudo code* for the flowchart for using the Quadruple Word Program command.

6.3 Enhanced Factory Program command

The Enhanced Factory Program command programs large streams of data within any one block. It greatly reduces the total programming time when a large number of words are written to a block at any one time.

Dual operations are not supported during the Enhanced Factory Program operation and the command cannot be suspended.

For optimum performance the Enhanced Factory Program commands should be limited to a maximum of 10 program/erase cycles per block. If this limit is exceeded the internal algorithm continues to work properly but some degradation in performance is possible. Typical program times are given in *Table 18*

If the block is protected then the Enhanced Factory Program operation aborts, the data in the block does not change, and the Status Register outputs the error.

The Enhanced Factory Program command has four phases: the setup phase, the program phase to program the data to the memory, the verify phase to check that the data has been correctly programmed and reprogram if necessary and the exit phase. Refer to *Table 9:*Factory program commands, and Figure 31: Enhanced factory program flowchart.

6.3.1 Setup phase

The Enhanced Factory Program command requires two bus write operations to initiate the command:

- The first bus cycle sets up the Enhanced Factory Program command
- The second bus cycle confirms the command.

The Status Register P/EC bit SR7 should be read to check that the P/EC is ready. After the confirm command is issued, read operations output the Status Register data. The read Status Register command must not be issued or it is interpreted as data to program.

If the second bus cycle is not EFP confirm (D0h), Status Register bits SR4 and SR5 are set and the command aborts.

 V_{PP} value must be in the V_{PPH} range during the confirm command, otherwise SR4 and SR3 are set and command are aborted.

6.3.2 Program phase

The program phase requires n+1 cycles, where n is the number of words (refer to *Table 9: Factory program commands*, and *Figure 31: Enhanced factory program flowchart*).

Three successive steps are required to issue and execute the program phase of the command:

 Use one bus write operation to latch the start address and the first word to be programmed, where the start address is the location of the first data to be programmed. The Status Register Bank Write Status bit SR0 should be read to check that the P/EC is ready for the next word.

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- 2. Each subsequent word to be programmed is latched with a new bus write operation. The address can either remain the start address, in which case the P/EC increments the address location. Or the address can be incremented, in which case the P/EC jumps to the new address. If any address is given that is not in the same block as the start address, the program phase terminates and the verify phase begins. The Status Register bit SR0 should be read between each bus write cycle to check that the P/EC is ready for the next word.
- Finally, after all words have been programmed, write one bus write operation to any address outside the block containing the start address, to terminate the programming phase.

The memory is now set to enter the verify phase.

6.3.3 Verify phase

The verify phase is similar to the program phase in that all words must be resent to the memory for them to be checked against the programmed data. The Program/Erase Controller checks the stream of data with the data that was programmed in the program phase and reprograms the memory location, if necessary.

Three successive steps are required to execute the verify phase of the command:

- Use one bus write operation to latch the start address and the first word to be verified.
 The Status Register bit SR0 should be read to check that the Program/Erase Controller
 is ready for the next word.
- 2. Each subsequent word to be verified is latched with a new bus write operation. The words must be written in the same order as in the program phase. The address can remain the start address or be incremented. If any address that is not in the same block as the start address is given, the verify phase terminates. Status Register bit SR0 should be read to check that the P/EC is ready for the next word.
- 3. Finally, after all words have been verified, write one bus write operation to any address outside the block containing the start address, to terminate the verify phase.

If the verify phase is successfully completed, the memory remains in read Status Register mode. If the Program/Erase Controller fails to reprogram a given location, the error is signaled in the Status Register.

6.3.4 Exit phase

Status Register P/EC bit SR7 set to '1' indicates that the device has returned to read mode. A full Status Register check should be done to ensure that the block has been successfully programmed. See *Section 7: Status Register* for more details.

6.4 Quadruple Enhanced Factory Program command

The Quadruple Enhanced Factory Program command programs one or more pages of four adjacent words in parallel. The four words must only differ for the addresses A0 and A1.

V_{PP} must be set to V_{PPH} during the Quadruple Enhanced Factory Program, otherwise the command is ignored and the Status Register does not output any error.

Dual operations are not supported during Quadruple Enhanced Factory Program operations and the command cannot be suspended.

If the block is protected then the Quadruple Enhanced Factory Program operation aborts, the data in the block does not change, and the Status Register outputs the error.

The Quadruple Enhanced Factory Program command has four phases: the setup phase, the load phase where the data is loaded into the buffer, the combined program and verify phase where the loaded data is programmed to the memory and then automatically checked and reprogrammed if necessary and the exit phase. Unlike the Enhanced Factory Program it is not necessary to resubmit the data for the verify phase. The load phase and the program and verify phase can be repeated to program any number of pages within the block.

6.4.1 Setup phase

The Quadruple Enhanced Factory Program command requires one bus write operation to initiate the load phase. After the setup command is issued, read operations output the Status Register data. The Read Status Register command must not be issued or it is interpreted as data to program.

6.4.2 Load phase

The load phase requires 4 cycles to load the data (refer to *Table 9: Factory program commands* and *Figure 32: Quadruple enhanced factory program flowchart*). Once the first word of each page is written it is impossible to exit the load phase until all four words have been written.

Two successive steps are required to issue and execute the load phase of the Quadruple Enhanced Factory Program command.

- 1. Use one bus write operation to latch the start address and the first word of the first page to be programmed, where the start address is the location of the first data to be programmed. For subsequent pages the first word address can remain the start address (in which case the next page is programmed) or can be any address in the same block. If any address is given that is not in the same block as the start address, the device enters the exit phase. For the first load phase Status Register bit SR7 should be read after the first word has been issued to check that the command has been accepted (bit SR7 set to '0'). This check is not required for subsequent load phases.
- Each subsequent word to be programmed is latched with a new bus write operation.
 The address is only checked for the first word of each page as the order of the words to be programmed is fixed.

The memory is now set to enter the program and verify phase.

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6.4.3 Program and verify phase

In the program and verify phase the four words that were loaded in the load phase are programmed in the memory array and then verified by the Program/Erase Controller. If any errors are found, the Program/Erase Controller reprograms the location. During this phase the Status Register shows that the Program/Erase Controller is busy, the Status Register bit SR7 is set to '0', and that the device is not waiting for new data (Status Register bit SR0 set to '1'). When Status Register bit SR0 is set to '0' the program and verify phase has terminated.

Once the verify phase has successfully completed, subsequent pages in the same block can be loaded and programmed. The device returns to the beginning of the load phase by issuing one bus write operation to latch the address and the first of the four new words to be programmed.

6.4.4 Exit phase

Finally, after all the pages have been programmed, write one bus write operation to any address outside the block containing the start address, to terminate the load and program and verify phases.

Status Register bit SR7 set to '1' and bit SR0 set to '0' indicate that the Quadruple Enhanced Factory Program command has terminated. A full Status Register check should be done to ensure that the block has been successfully programmed. See *Section 7: Status Register* for more details.

If the program and verify phase has successfully completed the memory returns to read mode. If the P/EC fails to program and reprogram a given location, the error is signaled in the Status Register.

Table 9. Factory program commands

		"	Bus write operations ⁽¹⁾										
Command	Phase	Cycles	1st		2nd	2nd		d		Fina	l -1	Fir	nal
		3	Add	Data	Add	Data	Add	Data		Add	Data	Add	Data
Double Word Program ⁽²⁾		3	BKA or WA1 ⁽³⁾	35h	WA1	PD1	WA2	PD2					
Quadruple Word Program ⁽⁴⁾		5	BKA or WA1 ⁽³⁾	56h	WA1	PD1	WA2	PD2		WA3	PD3	WA4	PD4
Enhanced Factory Program	Setup, Program	2+n+ 1	BKA or WA1 ⁽³⁾	30h	BA or WA1 ⁽⁶⁾	D0h	WA1 ⁽⁷⁾	PD1		WAn ⁽⁸⁾	PAn	NOT WA1 ⁽⁷⁾	
	Verify, Exit	n+1	WA1 ⁽⁷⁾	PD1	WA2 ⁽⁸⁾	PD2	WA3 ⁽⁸⁾	PD3		WAn ⁽⁸⁾	PAn	NOT WA1 ⁽⁷⁾	
	Setup, first Load	5	BKA or WA1 ⁽³⁾	75h	WA1 ⁽⁷⁾	PD1	WA2 ⁽⁹⁾	PD2	٠	WA3 ⁽⁹⁾	PD3	WA4 ⁽⁹⁾	PD4
Quadruple	First Program & Verify			Automatic									
Enhanced Factory Program	Subsequent Loads	4	WA1i (7)	PD1i	WA2i ⁽⁹⁾	PD2i	WA3i ⁽⁹⁾	PD3i				WA4i ⁽⁹	PD4i
(4),(5)	Subsequent Program & Verify			Automatic									
	Exit	1	NOT WA1 ⁽⁷⁾										

- 1. WA = Word Address in targeted bank, BKA = Bank Address, PD = Program Data, BA = Block Address.
- 2. Word addresses 1 and 2 must be consecutive Addresses differing only for A0.
- 3. Any address within the bank can be used.
- 4. Word addresses 1,2,3 and 4 must be consecutive addresses differing only for A0 and A1.
- 5. A bus read must be done between each write cycle where the data is programmed or verified to read the Status Register and check that the memory is ready to accept the next data. n = number of words, i = number of pages to be programmed.
- 6. Any address within the block can be used.
- 7. WA1 is the start address. NOT WA1 is any address that is not in the same block as WA1.
- 8. Address can remain starting address WA1 or be incremented.
- 9. Address is only checked for the first word of each page as the order to program the words in each page is fixed so subsequent words in each page can be written to any address.

7 Status Register

The Status Register provides information on the current or previous program or erase operations. Issue a Read Status Register command to read the contents of the Status Register (refer to Section 5.2: Read Status Register command for more details). To output the contents, the Status Register is latched and updated on the falling edge of the Chip Enable or Output Enable signals and can be read until Chip Enable or Output Enable returns to V_{IH} . The Status Register can only be read using single asynchronous or single synchronous reads. Bus read operations from any address within the bank always read the Status Register during Program and Erase operations, as long as no Read Array command has been issued.

The various bits convey information about the status and any errors of the operation. Bits SR7, SR6, SR2 and SR0 provide information on the status of the device and are set and reset by the device. Bits SR5, SR4, SR3 and SR1 provide information on errors. TThey are set by the device but must be reset by issuing a Clear Status Register command or a hardware reset. If an error bit is set to '1' the Status Register should be reset before issuing another command. SR7 to SR1 refer to the status of the device while SR0 refers to the status of the addressed bank.

The bits in the Status Register are summarized in *Table 10: Status Register bits*. Refer to *Table 10* in conjunction with the descriptions in the following sections.

7.1 Program/Erase Controller status bit (SR7)

The Program/Erase Controller status bit indicates whether the Program/Erase Controller is active or inactive in any bank. When the Program/Erase Controller status bit is Low (set to '0'), the Program/Erase Controller is active; when the bit is High (set to '1'), the Program/Erase Controller is inactive, and the device is ready to process a new command.

The Program/Erase Controller status is Low immediately after a Program/Erase Suspend command is issued until the Program/Erase Controller pauses. After the Program/Erase Controller pauses the bit is High.

During program and erase operations the Program/Erase Controller status bit can be polled to find the end of the operation. Other bits in the Status Register should not be tested until the Program/Erase Controller completes the operation and the bit is High.

After the Program/Erase Controller completes its operation the erase status, program status, V_{PP} status and block lock status bits should be tested for errors.

7.2 Erase suspend status bit (SR6)

The erase suspend status bit indicates that an erase operation has been suspended or is going to be suspended in the addressed block. When the erase suspend status bit is High (set to '1'), a Program/Erase Suspend command has been issued and the memory is waiting for a Program/Erase Resume command.

The erase suspend status should only be considered valid when the Program/Erase Controller status bit is High (Program/Erase Controller inactive). SR7 is set within the erase suspend latency time of the Program/Erase Suspend command being issued, therefore, the memory may still complete the operation rather than entering the suspend mode.

When a Program/Erase Resume command is issued the erase suspend status bit returns Low.

7.3 Erase status bit (SR5)

The erase status bit identifies if the memory has failed to verify that the block has erased correctly. When the erase status bit is High (set to '1'), the Program/Erase Controller has applied the maximum number of pulses to the block and still failed to verify that it has erased correctly. The erase status bit should be read once the Program/Erase Controller status bit is High (Program/Erase Controller inactive).

Once set High, the erase status bit can only be reset Low by a Clear Status Register command or a hardware reset. If set High it should be reset before a new program or erase command is issued, otherwise the new command appears to fail.

7.4 Program status bit (SR4)

The program status bit identifies a program failure or an attempt to program a '1' to an already programmed bit when $V_{PP} = V_{PPH}$.

When the program status bit is High (set to '1'), the Program/Erase Controller has applied the maximum number of pulses to the byte and still failed to verify that it has programmed correctly.

After an attempt to program a '1' to an already programmed bit, the program status bit SR4 only goes High (set to '1') if $V_{PP} = V_{PPH}$ (if V_{PP} is different from V_{PPH} , SR4 remains Low (set to '0') and the attempt is not shown).

The program status bit should be read once the Program/Erase Controller status bit is High (Program/Erase Controller inactive).

Once set High, the program status bit can only be reset Low by a Clear Status Register command or a hardware reset. If set High it should be reset before a new command is issued, otherwise the new command appears to fail.

7.5 V_{PP} status bit (SR3)

The V_{PP} status bit identifies an invalid voltage on the V_{PP} pin during program and erase operations. The V_{PP} pin is only sampled at the beginning of a program or erase operation. Indeterminate results can occur if V_{PP} becomes invalid during an operation.

When the V_{PP} status bit is Low (set to '0'), the voltage on the V_{PP} pin was sampled at a valid voltage. When the V_{PP} status bit is High (set to '1'), the V_{PP} pin has a voltage that is below the V_{PP} lockout voltage, V_{PPLK} , the memory is protected and program and erase operations cannot be performed.

Once set High, the V_{PP} status bit can only be reset Low by a Clear Status Register command or a hardware reset. If set High it should be reset before a new program or erase command is issued, otherwise the new command appears to fail.

7.6 Program suspend status bit (SR2)

The program suspend status bit indicates that a program operation has been suspended in the addressed block. When the program suspend status bit is High (set to '1'), a Program/Erase Suspend command has been issued and the memory is waiting for a Program/Erase Resume command. The program suspend status should only be considered valid when the Program/Erase Controller status bit is High (Program/Erase Controller inactive). SR2 is set within the program suspend latency time of the Program/Erase Suspend command being issued, therefore, the memory may still complete the operation rather than entering the suspend mode.

When a Program/Erase Resume command is issued, the program suspend status bit returns Low.

7.7 Block protection status bit (SR1)

The block protection status bit can be used to identify if a program or block erase operation has tried to modify the contents of a locked or locked-down block.

When the block protection status bit is High (set to '1'), a program or erase operation has been attempted on a locked or locked-down block.

Once set High, the block protection status bit can only be reset Low by a Clear Status Register command or a hardware reset. If set High it should be reset before a new command is issued, otherwise the new command appears to fail.

7.8 Bank write/multiple word program status bit (SR0)

The bank write status bit indicates whether the addressed bank is programming or erasing. In enhanced factory program mode the multiple word program bit shows if a word has finished programming or verifying depending on the phase. The bank write status bit should only be considered valid when the Program/Erase Controller status SR7 is Low (set to '0').

When both the Program/Erase Controller status bit and the bank write status bit are Low (set to '0'), the addressed bank is executing a program or erase operation. When the Program/Erase Controller status bit is Low (set to '0') and the bank write status bit is High (set to '1'), a program or erase operation is being executed in a bank other than the one being addressed.

In enhanced factory program mode if the multiple word program status bit is Low (set to '0'), the device is ready for the next word. If the multiple word program status bit is High (set to '1') the device is not ready for the next word.

Refer to Appendix C: Flowcharts and pseudo codes for using the Status Register.

Table 10. Status Register bits

Bit	Name	Туре	Logic level ⁽¹⁾	Definition			
SR7	P/EC status	Status	'1'	Ready			
3117	F/LO status	Status	'0'	Busy			
SR6	Erase suspend status	Status	'1'	Erase sus	pended		
Orto	Erado daspona diatas	Otatao	'0'	Erase in p	progress or completed		
SR5	Erase status	Error	'1'	Erase erro	or		
0110	27400 014140		'0'	Erase success			
SR4	Program status	Error	'1'	Program 6	error		
J. (1)	r rogram otatao	2.1.0.	'0'	Program success			
SR3	V _{PP} status	Error	'1'	V _{PP} invali	invalid, abort		
0110	· pp otatao	2.1.0.	'0'	V _{PP} OK			
SR2	Program suspend status	Status	'1'	Program suspended			
0.12	- regram easpens etatae	0.0	'0'	Program i	n progress or completed		
SR1	Block protection status	Error	'1'	Program/e	erase on protected block, abort		
• • • • • • • • • • • • • • • • • • • •	2.00m protoction ctatae		'0'	No operat	ion to protected blocks		
				SR7 = '1'	Not allowed		
			'1'	SR7 = '0'	Program or erase operation in a bank other than the addressed bank		
	Bank write status	Status	'0'	SR7 = '1'	No program or erase operation in the device		
SR0			O	SR7 = '0'	Program or erase operation in addressed bank		
				SR7 = '1'	Not allowed		
	Multiple word program status (enhanced factory	Status	'1'	SR7 = '0'	The device is NOT ready for the next word		
	program mode)		'0'	SR7 = '1'	The device is exiting EFP		
			U	SR7 = '0'	The device is ready for the next word		

^{1.} Logic level '1' is High, '0' is Low.

8 Configuration Register

The Configuration Register configures the type of bus access that the memory performs. Refer to *Section 9: Read modes* for details on read operations.

The Configuration Register is set through the command interface. After a reset or power-up the device is configured for asynchronous page read (CR15 = 1). The Configuration Register bits are described in *Table 12*. They specify the selection of the burst length, burst type, burst X latency, and the Read operation. Refer to Figures 8 and 9 for examples of synchronous burst configurations.

8.1 Read select bit (CR15)

The read select bit, CR15, switches between asynchronous and synchronous bus read operations. When the read select bit is set to '1', read operations are asynchronous; when the read select bit is set to '0', read operations are synchronous. Synchronous burst read is supported in both parameter and main blocks and can be performed across banks.

On reset or power-up the read select bit is set to'1' for asynchronous access.

8.2 X-latency bits (CR13-CR11)

The X-latency bits are used during synchronous read operations to set the number of clock cycles between the address being latched and the first data becoming available. For correct operation the X-latency bits can only assume the values in *Table 12: Configuration Register*.

*Table 11*shows how to set the X-latency parameter, taking into account the speed class of the device and the frequency used to read the Flash memory in synchronous mode.

fmax	t _K min	X-latency min
30 MHz	33 ns	2
40 MHz	25 ns	3
54 MHz	19 ns	4
66 MHz	15 ns	4

Table 11. Latency settings

8.3 Wait polarity bit (CR10)

In synchronous burst mode the Wait signal indicates whether the output data are valid or a WAIT state must be inserted. The wait polarity bit is used to set the polarity of the Wait signal. When the wait polarity bit is set to '0' the Wait signal is active Low. When the wait polarity bit is set to '1' the Wait signal is active High.

8.4 Data output configuration bit (CR9)

The Data Output Configuration bit determines whether the output remains valid for one or two clock cycles. When the data output configuration bit is '0' the output data is valid for one clock cycle. When the data output configuration bit is '1' the output data is valid for two clock cycles.

The data output configuration depends on the condition:

$$t_{K} > t_{KQV} + t_{QVK_CPU}$$

where t_K is the clock period, t_{QVK_CPU} is the data setup time required by the system CPU and t_{KQV} is the clock to data valid time. If this condition is not satisfied, the data output configuration bit should be set to '1' (two clock cycles). Refer to *Figure 8: X-latency and data output configuration example*.

8.5 Wait Configuration Bit (CR8)

In burst mode the Wait bit controls the timing of the Wait output pin, WAIT. When WAIT is asserted, data is not valid and when WAIT is de-asserted, data is valid. When the Wait bit is '0' the Wait output pin is asserted during the wait state. When the Wait bit is '1' the Wait output pin is asserted one clock cycle before the wait state.

8.6 Burst type bit (CR7)

The burst type bit configures the sequence of addresses read as sequential or interleaved. When the burst type bit is '0' the memory outputs from interleaved addresses. When the burst type bit is '1' the memory outputs from sequential addresses. See *Table 13: Burst type definition* for the sequence of addresses output from a given starting address in each mode.

8.7 Valid clock edge bit (CR6)

The valid clock edge bit, CR6, configures the active edge of the Clock, K, during synchronous burst read operations. When the valid clock edge bit is '0' the falling edge of the Clock is the active edge. When the Valid Clock Edge bit is '1' the rising edge of the Clock is active.

8.8 Wrap burst bit (CR3)

The burst reads can be confined inside the 4 or 8-word boundary (wrap) or overcome the boundary (no wrap). The wrap burst bit selects between wrap and no wrap. When the wrap burst bit is set to '0' the burst read wraps; when it is set to '1' the burst read does not wrap.

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8.9 Burst length bits (CR2-CR0)

The burst length bits set the number of words to be output during a synchronous burst read operation as result of a single address latch cycle. They can be set for 4 words, 8 words, 16 words or continuous burst, where all the words are read sequentially.

In continuous burst mode the burst sequence can cross bank boundaries.

In continuous burst mode or in 4, 8, 16 words no-wrap, depending on the starting address, the device asserts the WAIT output to indicate that a delay is necessary before the data is output.

If the starting address is aligned to a 4 word boundary no wait states are needed and the WAIT output is not asserted.

If the starting address is shifted by 1, 2 or 3 positions from the 4-word boundary, WAIT is asserted for 1, 2 or 3 clock cycles when the burst sequence crosses the first 16 word boundary to indicate that the device needs an internal delay to read the successive words in the array. WAIT is asserted only once during a continuous burst access. See also *Table 13: Burst type definition*.

CR14, CR5 and CR4 are reserved for future use.

Table 12. Configuration Register

Bit	Description	Value	Description
CR15	Read select	0	Synchronous read
CKIS	Read Select	1	Asynchronous read (default at power-on)
CR14	Reserved	•	
		010	2 clock latency
		011	3 clock latency
CR13-CR11	X-latency	100	4 clock latency
CK13-CK11	A-latericy	101	5 clock latency
		111	Reserved (default)
		Other con	figurations reserved
CR10	Wait polarity	0	WAIT is active Low
CKIU	vvait polarity	1	WAIT is active High (default)
CR9	Data output	0	Data held for one clock cycle
CK9	configuration	1	Data held for two clock cycles (default)
CR8	Wait	0	WAIT is active during wait state
CNO	configuration	1	WAIT is active one data cycle before wait state (default)
CR7	Puret type	0	Interleaved
CR7	Burst type	1	Sequential (default)
CR6	Valid clock	0	Falling Clock edge
CRO	edge	1	Rising Clock edge (default)
CR5-CR4	Reserved	•	
CR3	Wrap burst	0	Wrap
CKS	wrap burst	1	No wrap (default)
		001	4 words
CR2-CR0	Burst length	010	8 words
UNZ-UNU	Duist length	011	16 words
		111	Continuous (CR7 must be set to '1') (default)

Table 13. Burst type definition

de	Start	4 w	ords	8 w	ords	16 wo	ords	Continuous
Mode	add	Sequential	Interleaved	Sequential	Interleaved	Sequential	Interleaved	burst
	0	0-1-2-3	0-1-2-3	0-1-2-3-4- 5-6-7	0-1-2-3-4-5- 6-7	0-1-2-3-4-5-6- 7-8-9-10-11-12- 13-14-15	0-1-2-3-4-5-6- 7-8-9-10-11- 12-13-14-15	0-1-2-3-4-5-6
	1	1-2-3-0	1-0-3-2	1-2-3-4-5- 6-7-0	1-0-3-2-5-4- 7-6	1-2-3-4-5-6-7- 8-9-10-11-12- 13-14-15-0	1-0-3-2-5-4-7- 6-9-8-11-10- 13-12-15-14	1-2-3-4-5-6-7- 15-WAIT-16- 17-18
	2	2-3-0-1	2-3-0-1	2-3-4-5-6- 7-0-1	2-3-0-1-6-7- 4-5	2-3-4-5-6-7-8- 9-10-11-12-13- 14-15-0-1		2-3-4-5-6- 715-WAIT- WAIT-16-17- 18
	3	3-0-1-2	3-2-1-0	3-4-5-6-7- 0-1-2	3-2-1-0-7-6- 5-4	3-4-5-6-7-8-9- 10-11-12-13- 14-15-0-1-2		3-4-5-6-715- WAIT-WAIT- WAIT-16-17- 18
dβ								
Wrap	7	7-4-5-6	7-6-5-4	7-0-1-2-3- 4-5-6	7-6-5-4-3-2- 1-0	7-8-9-10-11-12- 13-14-15-0-1-2- 3-4-5-6	7-6-5-4-3-2-1- 0-15-14-13- 12-11-10-9-8	7-8-9-10-11-12- 13-14-15-WAIT- WAIT-WAIT-16- 17
	12							12-13-14-15- 16-17-18
	13							13-14-15-WAIT- 16-17-18
	14							14-15-WAIT- WAIT-16-17- 18
	15							15-WAIT-WAIT- WAIT-16-17- 18

Table 13. Burst type definition (continued)

ab <u>e</u>	Start		ords	·	ords	16 wo	ords	Continuous
Mode	add	Sequential	Interleaved	Sequential	Interleaved	Sequential	Interleaved	burst
	0	0-1-2-3		0-1-2-3-4- 5-6-7		0-1-2-3-4-5-6- 7-8-9-10-11-12- 13-14-15		
	1	1-2-3-4		1-2-3-4-5- 6-7-8		1-2-3-4-5-6-7- 8-9-10-11-12- 13-14-15- WAIT-16		
	2	2-3-4-5		2-3-4-5-6- 7-8-9		2-3-4-5-6-7-8- 9-10-11-12-13- 14-15-WAIT- WAIT-16-17		
	3	3-4-5-6		3-4-5-6-7- 8-9-10		3-4-5-6-7-8-9- 10-11-12-13- 14-15-WAIT- WAIT-WAIT- 16-17-18		
			•		•		•	
No-wrap	7	7-8-9-10		7-8-9-10- 11-12-13- 14		7-8-9-10-11-12- 13-14-15- WAIT-WAIT- WAIT-16-17- 18-19-20-21-22		Same as for Wrap (Wrap /No Wrap has no effect on
2			L		I			Continuous
	12	12-13-14- 15		12-13-14- 15-16-17- 18-19		12-13-14-15- 16-17-18-19- 20-21-22-23- 24-25-26-27		Burst)
	13	13-14-15- WAIT-16		13-14-15- WAIT-16- 17-18-19- 20		13-14-15- WAIT-16-17- 18-19-20-21- 22-23-24-25- 26-27-28		
	14	14-15- WAIT- WAIT-16- 17		14-15- WAIT- WAIT-16- 17-18-19- 20-21		14-15-WAIT- WAIT-16-17- 18-19-20-21- 22-23-24-25- 26-27-28-29		
	15	15-WAIT- WAIT- WAIT-16- 17-18		15-WAIT- WAIT- WAIT-16- 17-18-19- 20-21-22		15-WAIT- WAIT-WAIT- 16-17-18-19- 20-21-22-23- 24-25-26-27- 28-29-30		

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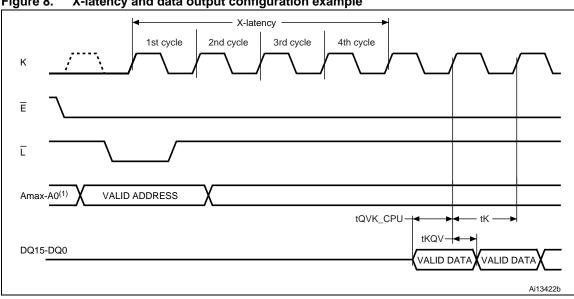


Figure 8. X-latency and data output configuration example

- 1. Amax is equal to A19 in the M58WR016KT/B, to A20 in the M58WR032KT/B and, to A21 in the M58WR064KT/B.
- 2. Settings shown: X-latency = 4, data output held for one clock cycle.

Figure 9. Wait configuration example Ē Κ Ē VALID ADDRESS Amax-A0(1) DQ15-DQ0 VALID DATA VALID DATA NOT VALID VALID DATA WAIT CR8 = '0' CR10 = '0'WAIT CR8 = '1' CR10 = '0' WAIT CR8 = '0' CR10 = '1'WAIT CR8 = '1' CR10 = '1' AI13423b

1. Amax is equal to A19 in the M58WR016KT/B, to A20 in the M58WR032KT/B and, to A21 in the M58WR064KT/B.

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9 Read modes

Read operations can be performed in two different ways depending on the settings in the Configuration Register. If the clock signal is 'don't care' for the data output, the read operation is asynchronous. If the data output is synchronized with clock, the read operation is synchronous.

The read mode and data output format are determined by the Configuration Register (see Section 8: Configuration Register for details). All banks supports both asynchronous and synchronous read operations. The multiple bank architecture allows read operations in one bank, while write operations are being executed in another (see Tables 14 and 15).

9.1 Asynchronous read mode

In asynchronous read operations the clock signal is 'don't care'. The device outputs the data corresponding to the address latched, that is the memory array, Status Register, common Flash interface or electronic signature, depending on the command issued. CR15 in the Configuration Register must be set to '1' for asynchronous operations.

In asynchronous read mode a page of data is internally read and stored in a page buffer. The page has a size of 4 words and is addressed by A0 and A1 address inputs. The address inputs A0 and A1 are not gated by Latch Enable in asynchronous read mode.

The first read operation within the page has a longer access time (T_{acc}, random access time), and subsequent reads within the same page have much shorter access times. If the page changes then the normal, longer timings apply again.

Asynchronous read operations can be performed in two different ways, Asynchronous random access read and asynchronous page read. Only asynchronous page read takes full advantage of the internal page storage so different timings are applied.

During asynchronous read operations, after a bus inactivity of 150 ns, the device automatically switches to automatic standby mode. In this condition the power consumption is reduced to the standby value and the outputs are still driven.

In asynchronous read mode, the WAIT signal is always asserted.

See Table 24: Asynchronous read AC characteristics, Figure 12: Asynchronous random access read AC waveforms and Figure 13: Asynchronous page read AC waveforms for details.

9.2 Synchronous burst read mode

In synchronous burst read mode the data is output in bursts synchronized with the clock. It is possible to perform burst reads across bank boundaries.

Synchronous burst read mode can only be used to read the memory array. For other read operations, such as read Status Register, read CFI, and read electronic signature, single synchronous read or asynchronous random access read must be used.

In synchronous burst read mode the flow of the data output depends on parameters that are configured in the Configuration Register.

A burst sequence is started at the first clock edge (rising or falling depending on valid clock edge bit CR6 in the Configuration Register) after the falling edge of Latch Enable or Chip Enable, whichever occurs last. Addresses are internally incremented and after a delay of 2 to 5 clock cycles (X latency bits CR13-CR11) the corresponding data is output on each clock cycle.

The number of words to be output during a synchronous burst read operation can be configured as 4, 8, 16 words, or continuous (burst length bits CR2-CR0). The data can be configured to remain valid for one or two clock cycles (data output configuration bit CR9).

The order of the data output can be modified through the burst type and the wrap burst bits in the Configuration Register. The burst sequence may be configured to be sequential or interleaved (CR7). The burst reads can be confined inside the 4, 8 or 16 word boundary (wrap) or overcome the boundary (no wrap). If the starting address is aligned to the burst length (4, 8 or 16 words) the wrapped configuration has no impact on the output sequence. Interleaved mode is not allowed in continuous burst read mode or with no wrap sequences.

A WAIT signal may be asserted to indicate to the system that an output delay occurs. This delay depends on the starting address of the burst sequence. The worst case delay occurs when the sequence is crossing a 16-word boundary and the starting address was at the end of a four word boundary.

WAIT is asserted during X latency, the Wait state, and at the end of 4-, 8- or 16-word burst. It is only de-asserted when output data are valid. In continuous burst read mode a Wait state occurs when crossing the first 16-word boundary. If the burst starting address is aligned to a 4-word page, the Wait state does not occur.

The WAIT signal can be configured to be active Low or active High by setting CR10 in the Configuration Register. The WAIT signal is meaningful only in synchronous burst read mode. In other modes, WAIT is always asserted (except for read array mode).

See Table 25: Synchronous read AC characteristics and Figure 14: Synchronous burst read AC waveforms for details.

9.3 Synchronous burst read suspend

A synchronous burst read operation can be suspended, freeing the data bus for other higher priority devices. It can be suspended during the initial access latency time (before data is output), or after the device has output data. When the synchronous burst read operation is suspended, internal array sensing continues and any previously latched internal data is retained. A burst sequence can be suspended and resumed as often as required as long as the operating conditions of the device are met.

A synchronous burst read operation is suspended when \overline{E} is low and the current address has been latched (on a Latch Enable rising edge or on a valid clock edge). The clock signal is then halted at V_{IH} or at V_{IL} , and \overline{G} goes high.

When \overline{G} becomes low again and the clock signal restarts, the synchronous burst read operation is resumed exactly where it stopped.

WAIT being gated by \overline{E} remains active and does not revert to high-impedance when \overline{G} goes high. Therefore, if two or more devices are connected to the system's READY signal, to prevent bus contention the WAIT signal of the Flash memory should not be directly connected to the system's READY signal.

See Table 25: Synchronous read AC characteristics and Figure 16: Synchronous burst read suspend AC waveforms for details.

9.4 Single synchronous read mode

Single synchronous read operations are similar to synchronous burst read operations except that only the first data output after the X latency is valid. Synchronous single reads are used to read the electronic signature, Status Register, CFI, block protection status, Configuration Register status or Protection Register status. When the addressed bank is in read CFI, read Status Register or read electronic signature mode, the WAIT signal is always asserted.

See Table 25: Synchronous read AC characteristics and Figure 15: Single synchronous read AC waveforms for details.

10 Dual operations and multiple bank architecture

The multiple bank architecture of the M58WRxxxKT/B provides flexibility for software developers by allowing code and data to be split with 4 Mbit granularity. The dual operations feature simplifies the software management of the device and allows code to be executed from one bank while another bank is being programmed or erased.

The dual operations feature means that while programming or erasing in one bank, read operations are possible in another bank with zero latency (only one bank at a time is allowed to be in program or erase mode). If a Read operation is required in a bank that is programming or erasing, the program or erase operation can be suspended. Also, if the suspended operation is erase then a program command can be issued to another block. This means the device can have one block in erase suspend mode, one programming, and other banks in read mode. Bus read operations are allowed in another bank between setup and confirm cycles of program or erase operations. The combination of these features means that read operations are possible at any moment.

Dual operations between the parameter bank and either the CFI, OTP, or the electronic signature memory space are not allowed. *Table 16*, however, shows dual operations that are allowed between the CFI, OTP, electronic signature locations, and the memory array.

Tables 14 and 15 show the dual operations possible in other banks and in the same bank. For a complete list of possible commands refer to *Appendix D: Command interface state tables*.

Table 14. Dual operations allowed in other banks

	Commands allowed in another bank										
Status of bank	Read Array	Read Status Register	Read CFI Query	Read Electronic Signature	Program	Block Erase	Program/ Erase Suspend	Program/ Erase Resume			
Idle	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes			
Programming	Yes	Yes	Yes	Yes	-	-	Yes	-			
Erasing	Yes	Yes	Yes	Yes	-	_	Yes	_			
Program suspended	Yes	Yes	Yes	Yes	-	_	-	Yes			
Erase suspended	Yes	Yes	Yes	Yes	Yes	ı	_	Yes			

Table 15. Dual operations allowed in same bank

		Commands allowed in same bank										
Status of bank	Read Array	Read Status Register	Read CFI Query	Read Electroni c Signature	Program	Block Erase	Program/ Erase Suspend	Program/ Erase Resume				
Idle	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes				
Programming	_(2)	Yes	Yes	Yes	-	-	Yes	-				
Erasing	_(2)	Yes	Yes	Yes	-	_	Yes	_				
Program suspended	Yes ⁽¹⁾	Yes	Yes	Yes	-	_	-	Yes				
Erase suspended	Yes ⁽¹⁾	Yes	Yes	Yes	Yes ⁽¹⁾	_	-	Yes				

^{1.} Not allowed in the block or word that is being erased or programmed.

Table 16. Dual operation limitations

			Commands allowed						
Curror	nt status	Read CFI / OTP /	Read	Read Main Blocks					
ourrent status		Electronic Signature	Parameter Blocks	Located in parameter bank	Not located in parameter bank				
_	ning/erasing ter blocks	No	No	No	Yes				
Programming/	Located in parameter bank	Yes	No	No	Yes				
erasing main blocks	Not located in parameter bank	Yes	Yes	Yes	In different bank only				
Programming OTP		No	No	No	No				

^{2.} The Read Array command is accepted but the data output is no guaranteed until the program or erase has completed.

11 Block locking

The M58WRxxxKT/B features an instant, individual block locking scheme that enables any block to be locked or unlocked with no latency. This locking scheme has three levels of protection.

- Lock/unlock this first level allows software-only control of block locking.
- Lock-down this second level requires hardware interaction before locking can be changed.
- V_{PP} ≤V_{PPLK} the third level offers a complete hardware protection against program and erase on all blocks.

The protection status of each block can be set to locked, unlocked, and lock-down. *Table 17*, defines all of the possible protection states (WP, DQ1, DQ0), and *Appendix C*, *Figure 29*, shows a flowchart for the locking operations.

11.1 Reading a block's lock status

The lock status of every block can be read in the read electronic signature mode of the device. To enter this mode write 90h to the device. Subsequent reads at the address specified in *Table 8* output the protection status of that block. The lock status is represented by DQ0 and DQ1. DQ0 indicates the block lock/unlock status and is set by the Lock command and cleared by the Unlock command. It is also automatically set when entering lock-down. DQ1 indicates the lock-down status and is set by the Lock-Down command. It cannot be cleared by software, only by a hardware reset or power-down.

The following sections explain the operation of the locking system.

11.2 Locked state

The default status of all blocks on power-up or after a hardware reset is locked (states (0,0,1) or (1,0,1)). Locked blocks are fully protected from any program or erase. Any program or erase operations attempted on a locked block returns an error in the Status Register. The status of a locked block can be changed to unlocked or lock-down using the appropriate software commands. An unlocked block can be locked by issuing the Lock command.

11.3 Unlocked state

Unlocked blocks (states (0,0,0), (1,0,0) (1,1,0)), can be programmed or erased. All unlocked blocks return to the locked state after a hardware reset or when the device is powered-down. The status of an unlocked block can be changed to locked or locked-down using the appropriate software commands. A locked block can be unlocked by issuing the Unlock command.

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11.4 Lock-down state

Blocks that are locked-down (state (0,1,x)) are protected from program and erase operations (as for locked blocks) but their protection status cannot be changed using software commands alone. A locked or unlocked block can be locked-down by issuing the Lock-Down command. Locked-down blocks revert to the locked state when the device is reset or powered-down.

The lock-down function is dependent on the \overline{WP} input pin. When \overline{WP} =0 (V_{IL}), the blocks in the lock-down state (0,1,x) are protected from program, erase and protection status changes. When \overline{WP} =1 (V_{IH}) the lock-down function is disabled (1,1,x) and locked-down blocks can be individually unlocked to the (1,1,0) state by issuing the software command, where they can be erased and programmed. These blocks can then be re-locked (1,1,1) and unlocked (1,1,0) as desired while \overline{WP} remains high. When \overline{WP} is Low, blocks that were previously locked-down return to the lock-down state (0,1,x) regardless of any changes made while \overline{WP} was High. Device reset or power-down resets all blocks, including those in lock-down, to the locked state.

11.5 Locking operations during erase suspend

Changes to block lock status can be performed during an erase suspend by using the standard locking command sequences to unlock, lock or lock down a block. This is useful in the case when another block needs to be updated while an erase operation is in progress.

To change block locking during an erase operation, first write the Erase Suspend command, then check the status register until it indicates that the erase operation has been suspended. Next ,write the desired lock command sequence to a block and the lock status changes. After completing any desired lock, read, or program operations, resume the erase operation with the Erase Resume command.

If a block is locked or locked down during an erase suspend of the same block, the locking status bits change immediately. But when the erase is resumed, the erase operation completes. Locking operations cannot be performed during a program suspend. Refer to *Appendix D: Command interface state tables* for detailed information on which commands are valid during erase suspend.

Table 17. Lock status

	ection status ⁽¹⁾ Q1, DQ0)	Next protection status ⁽¹⁾ (WP, DQ1, DQ0)						
Current state	Current state Program/erase allowed		After Block Unlock command	After Block Lock-Down command	After WP transition			
1,0,0	yes	1,0,1	1,0,0	1,1,1	0,0,0			
1,0,1 ⁽²⁾	no	1,0,1	1,0,0	1,1,1	0,0,1			
1,1,0	yes	1,1,1	1,1,0	1,1,1	0,1,1			
1,1,1	no	1,1,1	1,1,0	1,1,1	0,1,1			
0,0,0	yes	0,0,1	0,0,0	0,1,1	1,0,0			
0,0,1 ⁽²⁾	no	0,0,1	0,0,0	0,1,1	1,0,1			
0,1,1	no	0,1,1	0,1,1	0,1,1	1,1,1 or 1,1,0 ⁽³⁾			

The lock status is defined by the write protect pin and by DQ1 ('1' for a locked-down block) and DQ0 ('1' for a locked block) as read in the Read Electronic Signature command with A1 = V_{IH} and A0 = V_{IL}.

^{2.} All blocks are locked at power-up, so the default configuration is 001 or 101 according to $\overline{\text{WP}}$ status.

^{3.} A $\overline{\text{WP}}$ transition to V_{IH} on a locked block restores the previous DQ0 value, giving a 111 or 110.

12 Program and erase times and endurance cycles

The program and erase times and the number of program/ erase cycles per block are shown in *Table 18*. Exact erase times may change depending on the memory array condition. The best case is when all the bits in the block or bank are at '0' (preprogrammed). The worst case is when all the bits in the block or bank are at '1' (not preprogrammed). Usually, the system overhead is negligible with respect to the erase time. In the M58WRxxxKT/B the maximum number of program/ erase cycles depends on the V_{PP} voltage supply used.

Table 18. Program, erase times and endurance cycles⁽¹⁾

	Paramet	er	Condition	Min	Тур	Typical after 100 k W/E cycles	Max	Unit
		Parameter block (4 Kword) ⁽²⁾			0.3	1	2.5	s
	Erase	Main block (32	Preprogrammed		8.0	3	4	s
		Kword)	Not preprogrammed		1		4	s
۵		Word		12	12	100	μs	
. V	Program ⁽³⁾	Parameter block	(4 Kword)		40			ms
Vpp = V _{DD}		Main block (32 k	(word)		300			ms
>	Suspend latency	Program			5		10	μs
	Suspend laterity	Erase			5		20	μs
	Program/Erase	Main blocks		100 000				cycles
	Cycles (per Block)	Parameter block	100 000				cycles	
	Erase	Parameter block		0.25		2.5	s	
	Liase	Main block (32 k	,		8.0		4	s
		Word/ double wo	ord/ quadruple word ⁽⁴⁾		10		100	μs
			Quad-enhanced factory		11			ms
		Parameter	Enhanced factory		45			ms
		block (4 Kword)	Quadruple word ⁽⁴⁾		10			ms
PPH			Word		40			ms
Vpp = VppH	Program ⁽³⁾		Quad-enhanced factory		94			ms
γрр		Main block (Enhanced factory		360			ms
		32 Kword)	Quadruple word ⁽⁴⁾		80			ms
			Word		328			ms
		Bank (4 Mbit)	Quad-enhanced factory ⁽⁴⁾		0.75			s
		Darik (4 Mibit)	Quadruple word ⁽⁴⁾		0.65			s
	Program/erase	Main blocks					1000	cycles
	cycles (per block)	Parameter block	S				2500	cycles

^{1.} $T_A = -40$ to 85 °C; $V_{DD} = V_{DDQ} = 1.7$ V to 2 V.

^{2.} The difference between preprogrammed and not preprogrammed is not significant (< 30 ms).

^{3.} Values are liable to change with the external system-level overhead (command sequence and Status Register polling execution).

Measurements performed at 25°C. T_A = 30 °C ±10 °C for quadruple word, double word and quadruple enhanced factory program.

13 Maximum ratings

Stressing the device above the ratings listed in *Table 19: Absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the operating sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Refer also to the Numonyx SURE Program and other relevant quality documents.

Table 19. Absolute maximum ratings

Symbol	Parameter	Val	lue	Unit
Symbol	raiametei	Min	Max	Oille
T _A	Ambient operating temperature	-40	85	°C
T _{BIAS}	Temperature under bias	-40	125	°C
T _{STG}	Storage temperature	-65	155	°C
V _{IO}	Input or output voltage	-0.5	V _{DDQ} + 0.6	V
V _{DD}	Supply voltage	-0.2	2.45	V
V_{DDQ}	Input/output supply voltage	-0.2	2.45	V
V _{PP}	Program voltage	-0.2	10	V
Io	Output short circuit current		100	mA
t _{VPPH}	Time for V _{PP} at V _{PPH}		100	hours

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14 DC and AC parameters

This section summarizes the operating measurement conditions, and the DC and AC characteristics of the device. The parameters in the DC and AC characteristics tables in this section are derived from tests performed under the measurement conditions summarized in *Table 20: Operating and AC measurement conditions*. Designers should check that the operating conditions in their circuit match the operating conditions when relying on the quoted parameters.

Table 20. Operating and AC measurement conditions

Parameter	Min	Min Max	
V _{DD} supply voltage	1.7	2	V
V _{DDQ} supply voltage	1.7	2	V
V _{PP} supply voltage (factory environment)	8.5	9.5	V
V _{PP} supply voltage (application environment)	-0.4	V _{DDQ} +0.4	V
Ambient operating temperature	-40	85	°C
Load capacitance (C _L)		pF	
Input rise and fall times		ns	
Input pulse voltages	0 to	V	
Input and output timing ref. voltages	V	V	

Figure 10. AC measurement I/O waveform

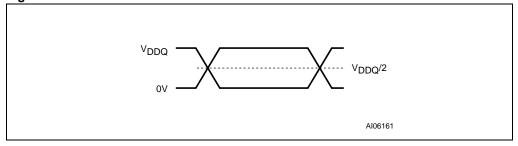


Figure 11. AC measurement load circuit

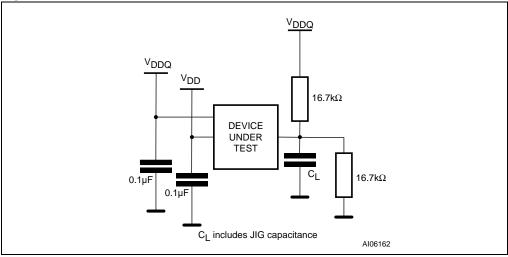


Table 21. Capacitance⁽¹⁾

Symbol	Parameter	Test condition	Min	Max	Unit
C _{IN}	Input capacitance	V _{IN} = 0 V	6	8	pF
C _{OUT}	Output capacitance	V _{OUT} = 0 V	8	12	pF

^{1.} Sampled only, not 100% tested.

Table 22. DC characteristics - currents

Symbol	Parameter	Test condition	Min	Тур	Max	Unit
I _{LI}	Input leakage current	0V ≤V _{IN} ≤V _{DDQ}			±1	μΑ
I _{LO}	Output leakage current	0V ≤V _{OUT} ≤V _{DDQ}			±1	μA
	Supply current asynchronous read (f = 5 MHz)	$\overline{E} = V_{IL}, \overline{G} = V_{IH}$		10	20	mA
		4 word		11	20	mA
I _{DD1}	Supply current	8 word		13	22	mA
	synchronous Read (f = 66 MHz)	16 word		15	27	mA
		Continuous		17	30	mA
I _{DD2}	Supply current (reset)	$\overline{RP} = V_{SS} \pm 0.2 \text{ V}$		15	50	μΑ
I _{DD3}	Supply current (standby)	$\overline{E} = V_{DDQ} \pm 0.2 \text{ V},$ $K = V_{SS}$		15	50	μΑ
I _{DD4}	Supply current (automatic standby)	$\overline{E} = V_{IL}, \overline{G} = V_{IH}$		15	50	μΑ
	Supply current (program)	$V_{PP} = V_{PPH}$		8	15	mA
I _{DD5} ⁽¹⁾	Supply current (program)	$V_{PP} = V_{DD}$		5	40	mA
'DD5	Supply current (erase)	$V_{PP} = V_{PPH}$		8	15	mA
	Supply current (erase)	$V_{PP} = V_{DD}$		10	40	mA
	Supply gurrent	Erase in one bank, asynchronous read in another bank		20	60	mA
I _{DD6} ⁽¹⁾⁽²⁾	Supply current (dual operations)	Erase in one bank, synchronous read (continuous burst 66 MHz) in another bank		27	70	mA
I _{DD7} ⁽¹⁾	Supply current program/ erase suspended (standby)	$\overline{E} = V_{DDQ} \pm 0.2 \text{ V},$ $K = V_{SS}$		15	50	μΑ
	// cumply ourrent (program)	$V_{PP} = V_{PPH}$		2	10	mA
I _{PP1} ⁽¹⁾	V _{PP} supply current (program)	$V_{PP} = V_{DD}$		0.2	5	μΑ
	V _{PP} supply current (erase)	$V_{PP} = V_{PPH}$		2	10	mA
	vpp supply culterit (clase)	$V_{PP} = V_{DD}$		0.2	5	μΑ
la	V _{PP} supply current (read)	$V_{PP} = V_{PPH}$		100	400	μΑ
I _{PP2}	vpp supply current (reau)	V _{PP} ≤V _{DD}		0.2	5	μΑ
I _{PP3} ⁽¹⁾	V _{PP} supply current (standby)	V _{PP} ≤V _{DD}		0.2	5	μΑ

^{1.} Sampled only, not 100% tested.

^{2.} V_{DD} dual operation current is the sum of read and program or erase currents.

Table 23. DC characteristics - voltages

Symbol	Parameter	Test condition	Min	Тур	Max	Unit
V _{IL}	Input low voltage		-0.5		0.4	V
V _{IH}	Input high voltage		V _{DDQ} -0.4		$V_{DDQ} + 0.4$	V
V _{OL}	Output low voltage	I _{OL} = 100 μA			0.1	٧
V _{OH}	Output high voltage	$I_{OH} = -100 \ \mu A$	V _{DDQ} -0.1			V
V _{PP1}	V _{PP} program voltage-logic	Program, erase	1.3		2.4	V
V _{PPH}	V _{PP} program voltage factory	Program, erase	8.5	9	9.5	٧
V _{PPLK}	Program or erase lockout				0.4	V
V _{LKO}	V _{DD} lock voltage				1	V

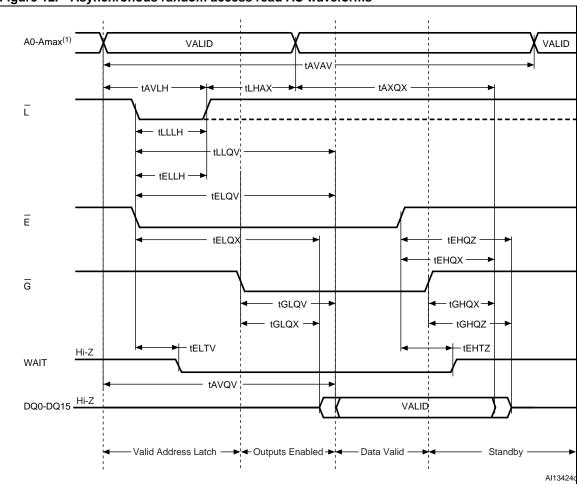


Figure 12. Asynchronous random access read AC waveforms

- 1. Amax is equal to A19 in the M58WR016KT/B, to A20 in the M58WR032KT/B and, to A21 in the M58WR064KT/B.
- 2. Write Enable, \overline{W} , is High, WAIT is active Low.

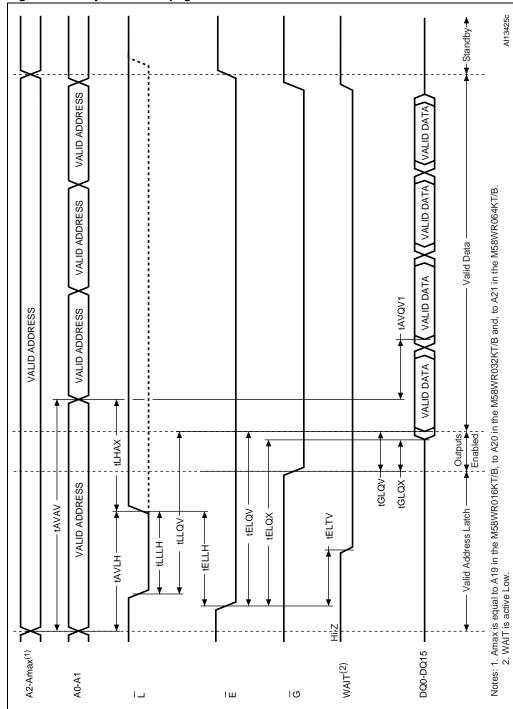


Figure 13. Asynchronous page read AC waveforms

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Table 24. Asynchronous read AC characteristics

Symbol Alt		Alt	Parameter		Value	Unit
	t _{AVAV}	t _{RC}	Address Valid to Next Address Valid	Min	70	ns
	t _{AVQV}	t _{ACC}	Address Valid to Output Valid (Random)	Max	70	ns
	t _{AVQV1}	t _{PAGE}	Address Valid to Output Valid (page)	Max	20	ns
	t _{AXQX} ⁽¹⁾	t _{OH}	Address Transition to Output Transition	Min	0	ns
	t _{ELTV}		Chip Enable Low to Wait Valid	Max	14	ns
gs	t _{ELQV} ⁽²⁾	t _{CE}	Chip Enable Low to Output Valid	Max	70	ns
imin	t _{ELQX} ⁽¹⁾	t _{LZ}	Chip Enable Low to Output Transition	Min	0	ns
Read Timings	t _{EHTZ}		Chip Enable High to Wait Hi-Z	Max	17	ns
Re	t _{EHQX} ⁽¹⁾	t _{OH}	Chip Enable High to Output Transition	Min	0	ns
	t _{EHQZ} ⁽¹⁾	t _{HZ}	Chip Enable High to Output Hi-Z	Max	17	ns
	t _{GLQV} ⁽²⁾	t _{OE}	Output Enable Low to Output Valid	Max	20	ns
	t _{GLQX} ⁽¹⁾	t _{OLZ}	Output Enable Low to Output Transition	Min	0	ns
	t _{GHQX} ⁽¹⁾	t _{OH}	Output Enable High to Output Transition	Min	0	ns
	t _{GHQZ} ⁽¹⁾	t _{DF}	Output Enable High to Output Hi-Z	Max	14	ns
	t _{AVLH}	t _{AVADVH}	Address Valid to Latch Enable High	Min	9	ns
Latch Timings	t _{ELLH}	t _{ELADVH}	Chip Enable Low to Latch Enable High	Min	10	ns
	t _{LHAX}	t _{ADVHAX}	Latch Enable High to Address Transition	Min	9	ns
tch .	t _{LLLH}	t _{ADVLADVH}	Latch Enable Pulse Width	Min	9	ns
La	t _{LLQV}	t _{ADVLQV}	Latch Enable Low to Output Valid (Random)	Max	70	ns

^{1.} Sampled only, not 100% tested.

^{2.} \overline{G} may be delayed by up to t_{ELQV} - t_{GLQV} after the falling edge of \overline{E} without increasing t_{ELQV} .

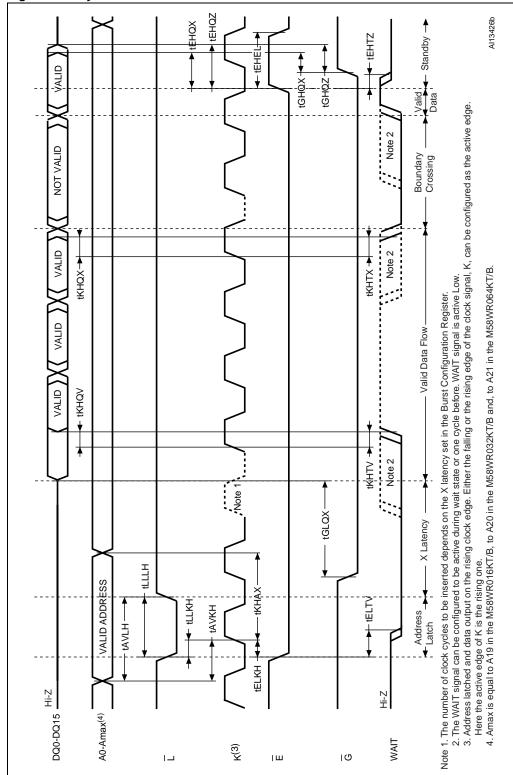


Figure 14. Synchronous burst read AC waveforms

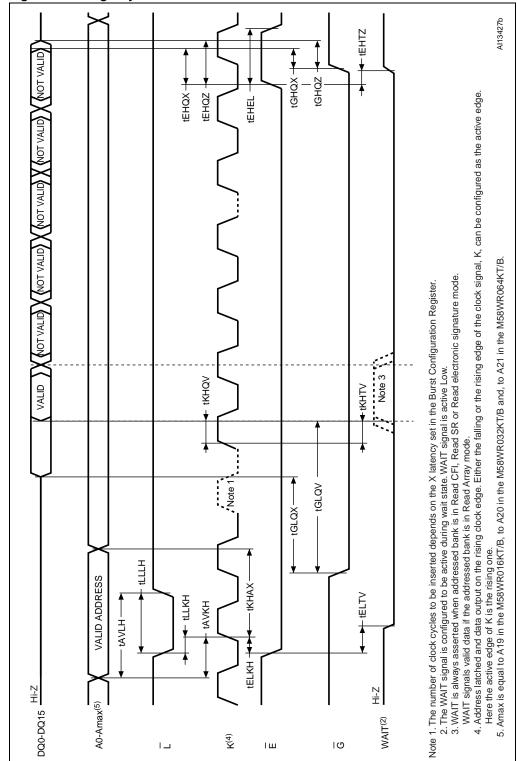


Figure 15. Single synchronous read AC waveforms

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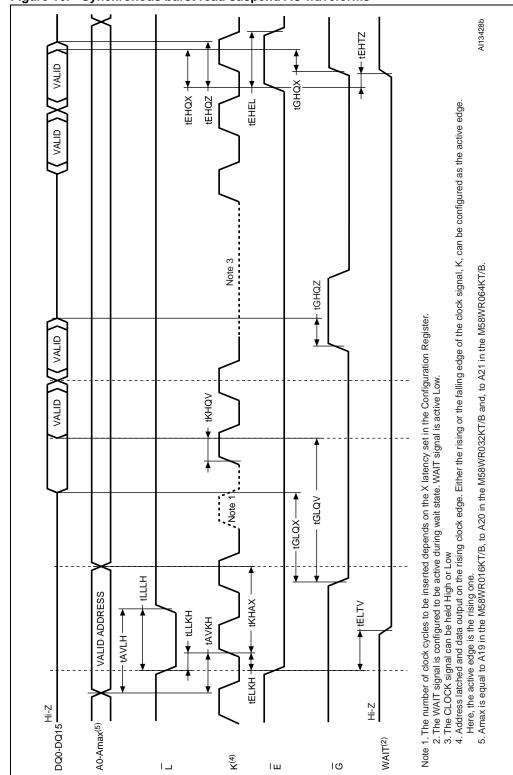


Figure 16. Synchronous burst read suspend AC waveforms

tKHKL

tKHKH

tKLKH

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Figure 17. Clock input AC waveform

Table 25. Synchronous read AC characteristics⁽¹⁾ (2)

Symbol		Alt	Parameter		Value	Unit
	t _{AVKH}	t _{AVCLKH}	Address Valid to Clock High	Min	9	ns
	t _{ELKH}	t _{ELCLKH}	Chip Enable Low to Clock High	Min	9	ns
Sg	t _{ELTV}		Chip Enable Low to Wait Valid	Max	14	ns
d timinę	t _{EHEL}		Chip Enable Pulse Width (subsequent synchronous reads)	Min	14	ns
rea	t _{EHTZ}		Chip Enable High to Wait Hi-Z	Max	14	ns
Snoc	t _{KHAX}	t _{CLKHAX}	Clock High to Address Transition	Min	9	ns
Synchronous read timings	t _{KHQV}	t _{CLKHQV}	Clock High to Output Valid Clock High to WAIT Valid	Max	11	ns
S	t _{KHQX}	t _{CLKHQX}	Clock High to Output Transition Clock High to WAIT Transition	Min	3	ns
	t _{LLKH}	t _{ADVLCLKH}	Latch Enable Low to Clock High	Min	9	ns
suc	t _{KHKH}	t _{CLK}	Clock Period (f=66MHz)	Min	15	ns
Clock specifications	t _{KHKL}		Clock High to Clock Low Clock Low to Clock High	Min	4.5	ns
	t _f t _r		Clock Fall or Rise Time	Max	3	ns

^{1.} Sampled only, not 100% tested.

^{2.} For other timings please refer to Table 24: Asynchronous read AC characteristics.

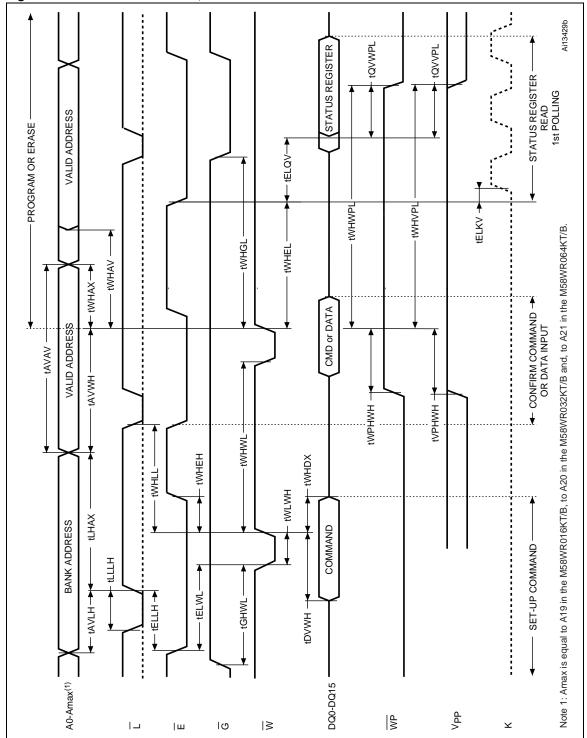


Figure 18. Write AC waveforms, Write Enable controlled

Table 26. Write AC characteristics, Write Enable controlled⁽¹⁾

5	Symbol	Alt	Parameter		Value	Unit
	t _{AVAV}	t _{WC}	Address Valid to Next Address Valid	Min	70	ns
	t _{AVLH}		Address Valid to Latch Enable High	Min	9	ns
	t _{AVWH} ⁽²⁾		Address Valid to Write Enable High	Min	45	ns
	t _{DVWH}	t _{DS}	Data Valid to Write Enable High	Min	45	ns
	t _{ELLH}		Chip Enable Low to Latch Enable High	Min	10	ns
	t _{ELWL}	t _{CS}	Chip Enable Low to Write Enable Low	Min	0	ns
gs	t _{ELQV}		Chip Enable Low to Output Valid	Min	70	ns
imin	t _{ELKV}		Chip Enable Low to Clock Valid	Min	9	ns
lled i	t _{GHWL}		Output Enable High to Write Enable Low	Min	17	ns
Write Enable controlled timings	t _{LHAX}		Latch Enable High to Address Transition	Min	9	ns
е со	t _{LLLH}		Latch Enable Pulse Width	Min	9	ns
nabl	t _{WHAV} (2)		Write Enable High to Address Valid	Min	0	ns
ite E	t _{WHAX} ⁽²⁾	t _{AH}	Write Enable High to Address Transition	Min	0	ns
W	t _{WHDX}	t _{DH}	Write Enable High to Input Transition	Min	0	ns
	t _{WHEH}	t _{CH}	Write Enable High to Chip Enable High	Min	0	ns
	t _{WHEL} (3)		Write Enable High to Chip Enable Low	Min	25	ns
	t _{WHGL}		Write Enable High to Output Enable Low	Min	0	ns
	t _{WHLL} (3)		Write Enable High to Latch Enable Low	Min	25	ns
	t _{WHWL}	t _{WPH}	Write Enable High to Write Enable Low	Min	25	ns
	t _{WLWH}	t _{WP}	Write Enable Low to Write Enable High	Min	45	ns
	t _{QVVPL}		Output (Status Register) Valid to V _{PP} Low	Min	0	ns
Protection timings	t _{QVWPL}		Output (Status Register) Valid to Write Protect Low	Min	0	ns
on ti	t _{VPHWH}	t _{VPS}	V _{PP} High to Write Enable High	Min	200	ns
tecti	t _{WHVPL}		Write Enable High to V _{PP} Low	Min	200	ns
Pro	t _{WHWPL}		Write Enable High to Write Protect Low	Min	200	ns
	t _{WPHWH}		Write Protect High to Write Enable High	Min	200	ns

^{1.} Sampled only, not 100% tested.

^{2.} Meaningful only if \overline{L} is always kept low.

^{3.} t_{WHEL} and t_{WHLL} have this value when reading in the targeted bank or when reading following a Set Configuration Register command. System designers should take this into account and may insert a software No-Op instruction to delay the first read in the same bank after issuing any command and to delay the first read to any address after issuing a Set Configuration Register command. If the first read after the command is a Read Array operation in a different bank and no changes to the Configuration Register have been issued, t_{WHEL} and t_{WHLL} are Ons.

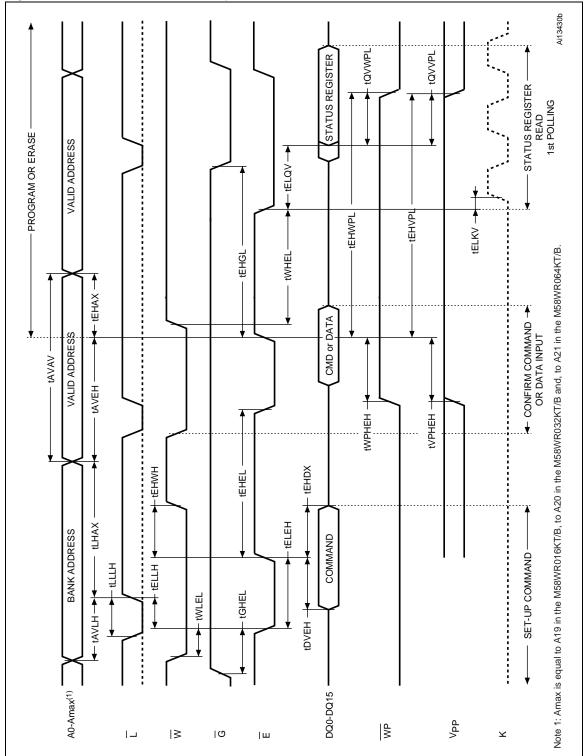


Figure 19. Write AC waveforms, Chip Enable controlled

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Table 27. Write AC characteristics, Chip Enable controlled⁽¹⁾

S	ymbol	Alt	Parameter		Value	Unit
	t _{AVAV}	t_{WC}	Address Valid to Next Address Valid	Min	70	ns
	t _{AVEH}		Address Valid to Chip Enable High	Min	45	ns
	t _{AVLH}		Address Valid to Latch Enable High	Min	9	ns
	t _{DVEH}	t _{DS}	Data Valid to Chip Enable High	Min	45	ns
	t _{EHAX}	t _{AH}	Chip Enable High to Address Transition	Min	0	ns
gs	t _{EHDX}	t _{DH}	Chip Enable High to Input Transition	Min	0	ns
Chip Enable controlled timings	t _{EHEL}	t _{CPH}	Chip Enable High to Chip Enable Low	Min	25	ns
led t	t _{EHGL}		Chip Enable High to Output Enable Low	Min	0	ns
ntrol	t _{EHWH}	t _{CH}	Chip Enable High to Write Enable High	Min	0	ns
0 0 0	t _{ELKV}		Chip Enable Low to Clock Valid	Min	9	ns
nabl	t _{ELEH}	t _{CP}	Chip Enable Low to Chip Enable High	Min	45	ns
ë E	t _{ELLH}		Chip Enable Low to Latch Enable High	Min	10	ns
င်	t _{ELQV}		Chip Enable Low to Output Valid	Min	70	ns
	t _{GHEL}		Output Enable High to Chip Enable Low	Min	17	ns
	t _{LHAX}		Latch Enable High to Address Transition	Min	9	ns
	t _{LLLH}		Latch Enable Pulse Width	Min	9	ns
	t _{WHEL} ⁽²⁾		Write Enable High to Chip Enable Low	Min	25	ns
	t _{WLEL}	t _{CS}	Write Enable Low to Chip Enable Low	Min	0	ns
	t _{EHVPL}		Chip Enable High to V _{PP} Low	Min	200	ns
sbu	t _{EHWPL}		Chip Enable High to Write Protect Low	Min	200	ns
timir	t _{QVVPL}		Output (Status Register) Valid to V _{PP} Low	Min	0	ns
Protection timings	t _{QVWPL}		Output (Status Register) Valid to Write Protect Low	Min	0	ns
Pro	t _{VPHEH}	t _{VPS}	V _{PP} High to Chip Enable High	Min	200	ns
L	t _{WPHEH}		Write Protect High to Chip Enable High	Min	200	ns

^{1.} Sampled only, not 100% tested.

^{2.} t_{WHEL} has this value when reading in the targeted bank or when reading following a Set Configuration Register command. System designers should take this into account and may insert a software No-Op instruction to delay the first read in the same bank after issuing any command and to delay the first read to any address after issuing a Set Configuration Register command. If the first read after the command is a Read Array operation in a different bank and no changes to the Configuration Register have been issued, t_{WHEL} is 0 ns.

Figure 20. Reset and power-up AC waveforms

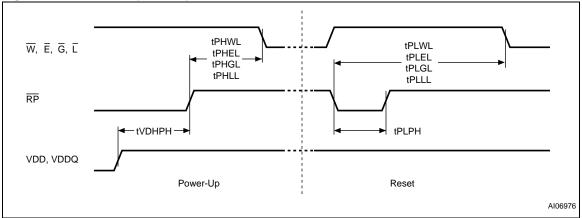


Table 28. Reset and power-up AC characteristics

Symbol	Parameter Test condition		n	Value	Unit
t _{PLWL}	Reset Low to Write Enable Low,	During program	Min	10	μs
t _{PLEL}	Reset Low to Chip Enable Low,	During erase	Min	20	μs
t _{PLGL} t _{PLLL}	Reset Low to Output Enable Low, Reset Low to Latch Enable Low	Other conditions	Min	80	ns
t _{PHWL} t _{PHEL} t _{PHGL} t _{PHLL}	Reset High to Write Enable Low Reset High to Chip Enable Low Reset High to Output Enable Low Reset High to Latch Enable Low		Min	30	ns
t _{PLPH} ^{(1),(2)}	RP pulse width		Min	50	ns
t _{VDHPH} (3)	Supply Voltages High to Reset High		Min	200	μs

^{1.} The device Reset is possible but not guaranteed if t_{PLPH} < 50 ns.

^{2.} Sampled only, not 100% tested.

^{3.} It is important to assert $\overline{\mathsf{RP}}$ in order to allow proper CPU initialization during power-up or reset.

15 Package mechanical

To meet environmental requirements, Numonyx offers the M58WRxxxKT/B in ECOPACK® packages, which have a lead-free, second-level interconnect. In compliance with JEDEC Standard JESD97, the category of second-level interconnect is marked on the package and on the inner box label.

The maximum ratings related to soldering conditions are also marked on the inner box label.

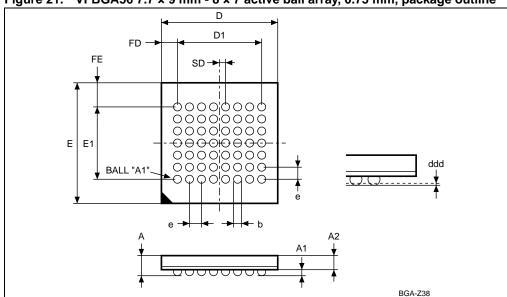


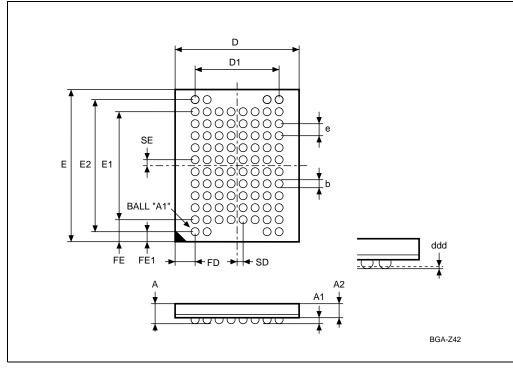
Figure 21. VFBGA56 7.7 × 9 mm - 8 × 7 active ball array, 0.75 mm, package outline

1. Drawing is not to scale.

Table 29. VFBGA56 7.7 × 9 mm - 8 × 7 active ball array, 0.75 mm, package mechanical data

Complete L		Millimeters		Inches		
Symbol	Тур	Min	Max	Тур	Min	Max
Α			1.000			0.0394
A1		0.200			0.0079	
A2	0.660			0.0260		
b	0.350	0.300	0.400	0.0138	0.0118	0.0157
D	7.700	7.600	7.800	0.3031	0.2992	0.3071
D1	5.250	-	_	0.2067	_	-
ddd			0.080			0.0031
е	0.750	-	-	0.0295	-	-
E	9.000	8.900	9.100	0.3543	0.3504	0.3583
E1	4.500	-	_	0.1772	_	-
FD	1.225	-	-	0.0482	-	-
FE	2.250	-	-	0.0886	-	-
SD	0.375	-	-	0.0148	-	-

Figure 22. TFBGA88 8x10mm - 8 x 10 ball array, 0.8 mm pitch, bottom view outline



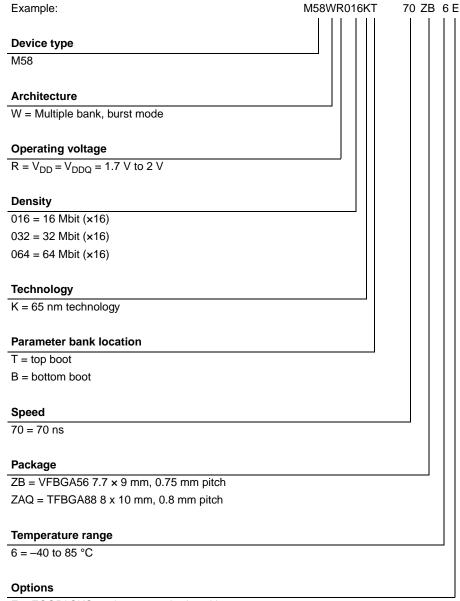
1. Drawing is not to scale.

Table 30. TFBGA88 8 x 10 mm - 8 x 10 ball array, 0.8 mm pitch, package data

Sumbal	Millimeters				Inches	
Symbol	Тур	Min	Max	Тур	Min	Max
Α			1.200			0.0472
A1		0.200			0.0079	
A2	0.850			0.0335		
b	0.350	0.300	0.400	0.0138	0.0118	0.0157
D	8.000	7.900	8.100	0.3150	0.3110	0.3189
D1	5.600			0.2205		
ddd			0.100			0.0039
Е	10.000	9.900	10.100	0.3937	0.3898	0.3976
E1	7.200			0.2835		
E2	8.800			0.3465		
е	0.800	-	_	0.0315	-	_
FD	1.200			0.0472		
FE	1.400			0.0551		
FE1	0.600			0.0236		
SD	0.400			0.0157		
SE	0.400			0.0157		

16 Part numbering

Table 31. Ordering information scheme



E = ECOPACK® package, standard packing

F = ECOPACK® package, tape and reel Packing

Devices are shipped from the factory with the memory content bits erased to '1'. For a list of available options (speed, etc.) or for further information on any aspect of this device, please contact the nearest Numonyx sales office.

Appendix A Block address tables

Table 32. Top boot block addresses, M58WR016KT

Bank ⁽¹⁾	#	Size (Kword)	Address range
	0	4	FF000-FFFFF
	1	4	FE000-FEFFF
	2	4	FD000-FDFFF
	3	4	FC000-FCFFF
	4	4	FB000-FBFFF
×	5	4	FA000-FAFFF
ban	6	4	F9000-F9FFF
Parameter bank	7	4	F8000-F8FFF
aram	8	32	F0000-F7FFF
g,	9	32	E8000-EFFFF
	10	32	E0000-E7FFF
	11	32	D8000-DFFFF
	12	32	D0000-D7FFF
	13	32	C8000-CFFFF
	14	32	C0000-C7FFF
	15	32	B8000-BFFFF
	16	32	B0000-B7FFF
	17	32	A8000-AFFFF
* _	18	32	A0000-A7FFF
Bank 1	19	32	98000-9FFFF
	20	32	90000-97FFF
	21	32	88000-8FFFF
	22	32	80000-87FFF
	23	32	78000-7FFFF
	24	32	70000-77FFF
	25	32	68000-6FFFF
天 0	26	32	60000-67FFF
Bank 2	27	32	58000-5FFFF
	28	32	50000-57FFF
	29	32	48000-4FFFF
	30	32	40000-47FFF

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Table 32. Top boot block addresses, M58WR016KT (continued)

Bank ⁽¹⁾	#	Size (Kword)	Address range
	31	32	38000-3FFFF
	32	32	30000-37FFF
	33	32	28000-2FFFF
S	34	32	20000-27FFF
Bank	35	32	18000-1FFFF
	36	32	10000-17FFF
	37	32	08000-0FFFF
	38	32	00000-07FFF

There are two Bank Regions: Bank Region 1 contains all the banks that are made up of main blocks only; Bank Region 2 contains the banks that are made up of the parameter and main blocks (parameter bank).

Table 33. Bottom boot block addresses, M58WR016KB

Bank ⁽¹⁾	#	Size (Kword)	Address range	
	38	32	F8000-FFFFF	
	37	32	F0000-F7FFF	
	36	32	E8000-EFFFF	
Bank 3	35	32	E0000-E7FFF	
Bar	34	32	D8000-DFFFF	
	33	32	D0000-D7FFF	
	32	32	C8000-CFFFF	
	31	32	C0000-C7FFF	
	30	32	B8000-BFFFF	
	29	32	B0000-B7FFF	
	28 32		A8000-AFFFF	
Bank 2	27	32	A0000-A7FFF	
Bar	26	32	98000-9FFFF	
	25	32	90000-97FFF	
	24	32	88000-8FFFF	
	23	32	80000-87FFF	

Table 33. Bottom boot block addresses, M58WR016KB (continued)

Bank ⁽¹⁾	#	Size (Kword)	Address range	
	22	32	78000-7FFFF	
	21	32	70000-77FFF	
	20	32	68000-6FFFF	
天 -	19	32	60000-67FFF	
Bank 1	18	32	58000-5FFFF	
	17	32	50000-57FFF	
	16	32	48000-4FFFF	
	15	32	40000-47FFF	
	14	32	38000-3FFFF	
	13	32	30000-37FFF	
	12	32	28000-2FFFF	
	11	32	20000-27FFF	
	10	32	18000-1FFFF	
¥	9	32	10000-17FFF	
ban	8	32	08000-0FFFF	
eter	7	4	07000-07FFF	
Parameter bank	6	4	06000-06FFF	
<u> </u>	5	4	05000-05FFF	
	4	4	04000-04FFF	
	3	4	03000-03FFF	
	2	4	02000-02FFF	
	1	4	01000-01FFF	
	0	4	00000-00FFF	

There are two bank regions: bank region 2 contains all the banks that are made up of main blocks only; bank region 1 contains the banks that are made up of the parameter and main blocks (parameter bank).

Table 34. Top boot block addresses, M58WR032KT

Bank ⁽¹⁾	#	Size (Kword)	Address range
	0	4	1FF000-1FFFFF
	1	4	1FE000-1FEFFF
	2	4	1FD000-1FDFFF
	3	4	1FC000-1FCFFF
	4	4	1FB000-1FBFFF
녿	5	4	1FA000-1FAFFF
. pai	6	4	1F9000-1F9FFF
Parameter bank	7	4	1F8000-1F8FFF
ıram	8	32	1F0000-1F7FFF
Ъа	9	32	1E8000-1EFFFF
	10	32	1E0000-1E7FFF
	11	32	1D8000-1DFFFF
	12	32	1D0000-1D7FFF
	13	32	1C8000-1CFFFF
	14	32	1C0000-1C7FFF
	15	32	1B8000-1BFFFF
	16	32	1B0000-1B7FFF
	17	32	1A8000-1AFFFF
ㅊ _	18	32	1A0000-1A7FFF
Bank 1	19	32	198000-19FFFF
	20	32	190000-197FFF
	21	32	188000-18FFFF
	22	32	180000-187FFF
	23	32	178000-17FFFF
	24	32	170000-177FFF
	25	32	168000-16FFFF
Bank 2	26	32	160000-167FFF
Bar	27	32	158000-15FFFF
	28	32	150000-157FFF
	29	32	148000-14FFFF
	30	32	140000-147FFF
	31	32	138000-13FFFF
	32	32	130000-137FFF
	33	32	128000-12FFFF
Bank 3	34	32	120000-127FFF
Bar	35	32	118000-11FFFF
	36	32	110000-117FFF
	37	32	108000-10FFFF
	38	32	100000-107FFF

Table 34. Top boot block addresses, M58WR032KT (continued)

Bank ⁽¹⁾	#	Size (Kword)	Address range
	39	32	0F8000-0FFFFF
	40	32	0F0000-0F7FFF
	41	32	0E8000-0EFFFF
추 4	42	32	0E0000-0E7FFF
Bank 4	43	32	0D8000-0DFFFF
	44	32	0D0000-0D7FFF
	45	32	0C8000-0CFFFF
	46	32	0C0000-0C7FFF
	47	32	0B8000-0BFFFF
	48	32	0B0000-0B7FFF
	49	32	0A8000-0AFFFF
Bank 5	50	32	0A0000-0A7FFF
Ban	51	32	098000-09FFFF
	52	32	090000-097FFF
	53	32	088000-08FFFF
	54	32	080000-087FFF
	55	32	078000-07FFFF
	56	32	070000-077FFF
	57	32	068000-06FFFF
Bank 6	58	32	060000-067FFF
Ban	59	32	058000-05FFFF
	60	32	050000-057FFF
	61	32	048000-04FFFF
	62	32	040000-047FFF
	63	32	038000-03FFFF
	64	32	030000-037FFF
	65	32	028000-02FFFF
× ×	66	32	020000-027FFF
Bank 7	67	32	018000-01FFFF
	68	32	010000-017FFF
	69	32	008000-00FFFF
	70	32	000000-007FFF

There are two Bank Regions: Bank Region 1 contains all the banks that are made up of main blocks only; Bank Region 2 contains the banks that are made up of the parameter and main blocks (parameter bank).

Table 35. Bottom boot block addresses, M58WR032KB

Bank ⁽¹⁾	#	Size (Kword)	Address range
	70	32	1F8000-1FFFFF
	69	32	1F0000-1F7FFF
	68	32	1E8000-1EFFFF
7	67	32	1E0000-1E7FFF
Bank 7	66	32	1D8000-1DFFFF
	65	32	1D0000-1D7FFF
	64	32	1C8000-1CFFFF
	63	32	1C0000-1C7FFF
	62	32	1B8000-1BFFFF
	61	32	1B0000-1B7FFF
	60	32	1A8000-1AFFFF
8 9	59	32	1A0000-1A7FFF
Bank 6	58	32	198000-19FFFF
	57	32	190000-197FFF
	56	32	188000-18FFFF
	55	32	180000-187FFF
	54	32	178000-17FFFF
	53	32	170000-177FFF
	52	32	168000-16FFFF
ج ت	51	32	160000-167FFF
Bank 5	50	32	158000-15FFFF
	49	32	150000-157FFF
	48	32	148000-14FFFF
	47	32	140000-147FFF
	46	32	138000-13FFFF
	45	32	130000-137FFF
	44	32	128000-12FFFF
ネ 4	43	32	120000-127FFF
Bank 4	42	32	118000-11FFFF
	41	32	110000-117FFF
	40	32	108000-10FFFF
	39	32	100000-107FFF

Table 35. Bottom boot block addresses, M58WR032KB (continued)

Bank ⁽¹⁾	#	Size (Kword)	Address range
	38	32	0F8000-0FFFF
	37	32	0F0000-0F7FFF
	36	32	0E8000-0EFFFF
∞ ×	35	32	0E0000-0E7FFF
Bank 3	34	32	0D8000-0DFFFF
	33	32	0D0000-0D7FFF
	32	32	0C8000-0CFFFF
	31	32	0C0000-0C7FFF
	30	32	0B8000-0BFFFF
	29	32	0B0000-0B7FFF
	28	32	0A8000-0AFFFF
× 2	27	32	0A0000-0A7FFF
Bank 2	26	32	098000-09FFFF
	25	32	090000-097FFF
	24	32	088000-08FFFF
	23	32	080000-087FFF
	22	32	078000-07FFFF
	21	32	070000-077FFF
	20	32	068000-06FFFF
天 ~	19	32	060000-067FFF
Bank 1	18	32	058000-05FFFF
	17	32	050000-057FFF
	16	32	048000-04FFFF
	15	32	040000-047FFF

Table 35. Bottom boot block addresses, M58WR032KB (continued)

Bank ⁽¹⁾	#	Size (Kword)	Address range
	14	32	038000-03FFFF
	13	32	030000-037FFF
	12	32	028000-02FFFF
	11	32	020000-027FFF
	10	32	018000-01FFFF
축	9	32	010000-017FFF
Parameter Bank	8	32	008000-00FFFF
eter	7	4	007000-007FFF
aram	6	4	006000-006FFF
ă.	5	4	005000-005FFF
	4	4	004000-004FFF
	3	4	003000-003FFF
	2	4	002000-002FFF
	1	4	001000-001FFF
	0	4	000000-000FFF

There are two bank regions: bank region 2 contains all the banks that are made up of main blocks only; bank region 1 contains the banks that are made up of the parameter and main blocks (parameter bank).

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Table 36. Top boot block addresses, M58WR064KT

### Page	Bank ⁽¹⁾	#	Size (Kword)	Address range
### 2		0	4	3FF000-3FFFFF
### A		1	4	3FE000-3FEFFF
Type		2	4	3FD000-3FDFFF
Type Sample		3	4	3FC000-3FCFFF
Page		4	4	3FB000-3FBFFF
10 32 3E0000-3E7FFF 11 32 3D8000-3DFFFF 12 32 3D0000-3D7FFF 13 32 3C8000-3CFFFF 14 32 3C0000-3CFFFF 15 32 3B8000-3BFFFF 16 32 3B8000-3BFFFF 17 32 3A8000-3AFFFF 18 32 3A9000-3A7FFF 19 32 398000-39FFFF 20 32 399000-39FFFF 21 32 388000-3BFFFF 22 32 389000-3FFFF 23 32 378000-37FFFF 24 32 370000-377FFF 25 32 368000-36FFFF 26 32 369000-36FFFF 27 32 358000-35FFFF 28 32 358000-35FFFF 29 32 348000-34FFFF 30 32 349000-34FFFF 31 32 338000-33FFFF 32 32 338000-33FFFF 33 32 328000-32FFFF 34 32 328000-32FFFF 35 32 318000-31FFFF 36 32 310000-317FFF 37 38 30000-317FFF 38 32 318000-31FFFF 39 30 32 318000-31FFFF 30 32 318000-31FFFF 31 32 328000-32FFFF 32 32 328000-32FFFF 33 32 328000-32FFFF 34 32 328000-32FFFF 35 32 318000-31FFFF 36 32 310000-317FFF 37 38 39 308000-30FFFF 38 39 308000-30FFFF 39 308000-30FFFF 30 308000-30FFFF 31 32 338000-31FFFF 32 338000-31FFFF 33 32 338000-31FFFF 34 32 328000-31FFFF 35 36 36 36 36 36 37 38 38 38 38 38 38 38	Z	5	4	3FA000-3FAFFF
10 32 3E0000-3E7FFF 11 32 3D8000-3DFFFF 12 32 3D0000-3D7FFF 13 32 3C8000-3CFFFF 14 32 3C0000-3CFFFF 15 32 3B8000-3BFFFF 16 32 3B8000-3BFFFF 17 32 3A8000-3AFFFF 18 32 3A9000-3A7FFF 19 32 398000-39FFFF 20 32 399000-39FFFF 21 32 388000-3BFFFF 22 32 389000-3FFFF 23 32 378000-37FFFF 24 32 370000-377FFF 25 32 368000-36FFFF 26 32 369000-36FFFF 27 32 358000-35FFFF 28 32 358000-35FFFF 29 32 348000-34FFFF 30 32 349000-34FFFF 31 32 338000-33FFFF 32 32 338000-33FFFF 33 32 328000-32FFFF 34 32 328000-32FFFF 35 32 318000-31FFFF 36 32 310000-317FFF 37 38 30000-317FFF 38 32 318000-31FFFF 39 30 32 318000-31FFFF 30 32 318000-31FFFF 31 32 328000-32FFFF 32 32 328000-32FFFF 33 32 328000-32FFFF 34 32 328000-32FFFF 35 32 318000-31FFFF 36 32 310000-317FFF 37 38 39 308000-30FFFF 38 39 308000-30FFFF 39 308000-30FFFF 30 308000-30FFFF 31 32 338000-31FFFF 32 338000-31FFFF 33 32 338000-31FFFF 34 32 328000-31FFFF 35 36 36 36 36 36 37 38 38 38 38 38 38 38	. pai	6	4	3F9000-3F9FFF
10 32 3E0000-3E7FFF 11 32 3D8000-3DFFFF 12 32 3D0000-3D7FFF 13 32 3C8000-3CFFFF 14 32 3C0000-3CFFFF 15 32 3B8000-3BFFFF 16 32 3B8000-3BFFFF 17 32 3A8000-3AFFFF 18 32 3A9000-3A7FFF 19 32 398000-39FFFF 20 32 399000-39FFFF 21 32 388000-3BFFFF 22 32 389000-3FFFF 23 32 378000-37FFFF 24 32 370000-377FFF 25 32 368000-36FFFF 26 32 369000-36FFFF 27 32 358000-35FFFF 28 32 358000-35FFFF 29 32 348000-34FFFF 30 32 349000-34FFFF 31 32 338000-33FFFF 32 32 338000-33FFFF 33 32 328000-32FFFF 34 32 328000-32FFFF 35 32 318000-31FFFF 36 32 310000-317FFF 37 38 30000-317FFF 38 32 318000-31FFFF 39 30 32 318000-31FFFF 30 32 318000-31FFFF 31 32 328000-32FFFF 32 32 328000-32FFFF 33 32 328000-32FFFF 34 32 328000-32FFFF 35 32 318000-31FFFF 36 32 310000-317FFF 37 38 39 308000-30FFFF 38 39 308000-30FFFF 39 308000-30FFFF 30 308000-30FFFF 31 32 338000-31FFFF 32 338000-31FFFF 33 32 338000-31FFFF 34 32 328000-31FFFF 35 36 36 36 36 36 37 38 38 38 38 38 38 38	eter	7	4	3F8000-3F8FFF
10 32 3E0000-3E7FFF 11 32 3D8000-3DFFFF 12 32 3D0000-3D7FFF 13 32 3C8000-3CFFFF 14 32 3C0000-3CFFFF 15 32 3B8000-3BFFFF 16 32 3B8000-3BFFFF 17 32 3A8000-3AFFFF 18 32 3A9000-3A7FFF 19 32 398000-39FFFF 20 32 399000-39FFFF 21 32 388000-3BFFFF 22 32 389000-3FFFF 23 32 378000-37FFFF 24 32 370000-377FFF 25 32 368000-36FFFF 26 32 369000-36FFFF 27 32 358000-35FFFF 28 32 358000-35FFFF 29 32 348000-34FFFF 30 32 349000-34FFFF 31 32 338000-33FFFF 32 32 338000-33FFFF 33 32 328000-32FFFF 34 32 328000-32FFFF 35 32 318000-31FFFF 36 32 310000-317FFF 37 38 30000-317FFF 38 32 318000-31FFFF 39 30 32 318000-31FFFF 30 32 318000-31FFFF 31 32 328000-32FFFF 32 32 328000-32FFFF 33 32 328000-32FFFF 34 32 328000-32FFFF 35 32 318000-31FFFF 36 32 310000-317FFF 37 38 39 308000-30FFFF 38 39 308000-30FFFF 39 308000-30FFFF 30 308000-30FFFF 31 32 338000-31FFFF 32 338000-31FFFF 33 32 338000-31FFFF 34 32 328000-31FFFF 35 36 36 36 36 36 37 38 38 38 38 38 38 38	ram	8	32	3F0000-3F7FFF
### Table	Ра	9	32	3E8000-3EFFFF
12 32 3D0000-3D7FFF		10	32	3E0000-3E7FFF
THE STATE OF THE S		11	32	3D8000-3DFFFF
THE STATE OF THE S		12	32	3D0000-3D7FFF
Type 15 32 388000-3BFFFF 16 32 380000-3B7FFF 17 32 3A8000-3AFFFF 18 32 3A0000-3AFFFF 19 32 398000-39FFFF 20 32 39000-39FFFF 21 32 388000-38FFFF 22 32 38000-38FFFF 22 32 38000-38FFFF 23 32 37000-37FFF 24 32 37000-37FFF 25 32 368000-36FFFF 26 32 368000-36FFFF 27 32 358000-35FFFF 28 32 350000-35FFFF 30 32 348000-34FFFF 30 32 338000-33FFFF 31 32 32 338000-33FFFF 32 32 338000-33FFFF 33 32 32 338000-33FFFF 34 32 32 330000-33FFFF 35 32 33 32 328000-32FFFF 36 36 32 310000-31FFFF 37 36 32 310000-31FFFF 37 32 308000-30FFFFF		13	32	3C8000-3CFFFF
Table 16 32 38000-387FFF 17 32 348000-3AFFFF 18 32 39000-397FFF 19 32 39000-397FFF 20 32 39000-397FFF 21 32 38000-387FFF 22 32 38000-387FFF 22 32 38000-387FFF 23 32 370000-377FFF 24 32 370000-377FFF 25 32 368000-367FFF 25 32 368000-367FFF 26 32 360000-367FFF 26 32 350000-357FFF 28 32 350000-357FFF 29 32 348000-347FFF 30 32 340000-347FFF 31 32 338000-337FFF 33 32 328000-327FFF 34 32 320000-327FFF 35 32 318000-317FFF 36 32 310000-317FFF 37 32 308000-307FFFF 37 32 308000-307FFFFFFFFFFFFFFFFFFFFFFFFFFFFFFFFF		14	32	3C0000-3C7FFF
YER 17 32 3A8000-3AFFFF 18 32 3A0000-3A7FFF 19 32 398000-39FFFF 20 32 390000-397FFF 21 32 388000-38FFFF 22 32 380000-38FFFF 23 32 378000-37FFFF 24 32 370000-37FFF 25 32 368000-36FFFF 26 32 350000-35FFFF 28 32 350000-35FFFF 29 32 348000-34FFFF 30 32 340000-34FFFF 31 32 338000-33FFFF 32 32 330000-33FFFF 33 32 328000-32FFFF 34 32 328000-32FFFF 35 32 318000-31FFFF 36 32 310000-317FFF 37 32 308000-30FFFF		15	32	3B8000-3BFFFF
18		16	32	3B0000-3B7FFF
20 32 390000-397FFF		17	32	3A8000-3AFFFF
20 32 390000-397FFF	ㅊ _	18	32	3A0000-3A7FFF
21 32 388000-38FFFF	Bar	19	32	398000-39FFFF
22 32 380000-387FFF		20	32	390000-397FFF
23 32 378000-37FFFF 24 32 370000-377FFF 25 32 368000-36FFFF 26 32 360000-367FFF 27 32 358000-35FFFF 28 32 350000-357FFF 29 32 348000-34FFFF 30 32 340000-347FFF 31 32 338000-33FFFF 32 32 330000-337FFF 33 32 328000-32FFFF 34 32 328000-32FFFF 35 32 318000-31FFFF 36 32 310000-317FFF 37 32 308000-30FFFFF 38 39 308000-30FFFFF 39 308000-30FFFFF 30 308000-30FFFFF 31 32 308000-30FFFFF 32 338000-30FFFFF 33 32 308000-30FFFFF 34 35 35 35 35 35 36 36 36 36 36 37 37 38 37 38 38 38 38 38 38 38		21	32	388000-38FFFF
24 32 370000-377FFF 25 32 368000-36FFFF 26 32 360000-367FFF 27 32 358000-35FFFF 28 32 350000-357FFF 29 32 348000-34FFFF 30 32 340000-347FFF 31 32 338000-337FFF 32 32 328000-327FFF 33 32 328000-327FFF 34 32 320000-327FFF 35 32 318000-317FFF 36 32 310000-317FFF 37 32 308000-30FFFF 38 39 308000-30FFFF 39 308000-30FFFF 30 308000-30FFFF 31 32 308000-30FFFF 32 308000-30FFFF 33 34 35 35 35 34 35 35 35 35 35 35 35		22	32	380000-387FFF
25 32 368000-36FFFF 26 32 360000-367FFF 27 32 358000-35FFFF 28 32 350000-357FFF 29 32 348000-34FFFF 30 32 340000-347FFF 31 32 338000-33FFFF 32 32 330000-337FFF 33 32 328000-32FFFF 34 32 320000-327FFF 35 32 318000-31FFFF 36 32 310000-317FFF 37 32 308000-30FFFF		23	32	378000-37FFFF
26 32 360000-367FFF 27 32 358000-35FFFF 28 32 350000-357FFF 29 32 348000-34FFFF 30 32 340000-347FFF 31 32 338000-33FFFF 32 32 330000-337FFF 33 32 328000-32FFFF 34 32 320000-327FFF 35 32 318000-31FFFF 36 32 310000-317FFF 37 32 308000-30FFFF		24	32	370000-377FFF
28 32 350000-357FFF 29 32 348000-34FFFF 30 32 340000-347FFF 31 32 338000-337FFF 32 32 320000-327FFF 33 32 320000-327FFF 34 32 320000-327FFF 35 32 318000-31FFFF 36 32 310000-317FFF 37 32 308000-30FFFF		25	32	368000-36FFFF
28 32 350000-357FFF 29 32 348000-34FFFF 30 32 340000-347FFF 31 32 338000-337FFF 32 32 320000-327FFF 33 32 320000-327FFF 34 32 320000-327FFF 35 32 318000-31FFFF 36 32 310000-317FFF 37 32 308000-30FFFF	도 2	26	32	360000-367FFF
28 32 350000-357FFF 29 32 348000-34FFFF 30 32 340000-347FFF 31 32 338000-337FFF 32 32 320000-327FFF 33 32 320000-327FFF 34 32 320000-327FFF 35 32 318000-31FFFF 36 32 310000-317FFF 37 32 308000-30FFFF	Bar	27	32	358000-35FFFF
30 32 340000-347FFF 31 32 338000-337FFF 32 32 320000-337FFF 33 32 328000-32FFFF 34 32 320000-327FFF 35 32 318000-31FFFF 36 32 310000-317FFF 37 32 308000-30FFFF		28	32	350000-357FFF
31 32 338000-33FFFF 32 32 320000-337FFF 33 32 328000-32FFFF 34 32 320000-327FFF 35 32 318000-31FFFF 36 32 310000-317FFF 37 32 308000-30FFFF		29	32	348000-34FFFF
32 32 330000-337FFF 33 32 328000-32FFFF 34 32 320000-327FFF 35 32 318000-31FFFF 36 32 310000-317FFF 37 32 308000-30FFFF		30	32	340000-347FFF
33 32 328000-32FFFF 34 32 320000-327FFF 35 32 318000-31FFFF 36 32 310000-317FFF 37 32 308000-30FFFF		31	32	338000-33FFFF
34 32 320000-327FFF 35 32 318000-31FFFF 36 32 310000-317FFF 37 32 308000-30FFFF		32	32	330000-337FFF
36 32 310000-317FFF 37 32 308000-30FFFF		33	32	328000-32FFFF
36 32 310000-317FFF 37 32 308000-30FFFF	χ ω	34	32	320000-327FFF
36 32 310000-317FFF 37 32 308000-30FFFF	Bar	35	32	318000-31FFFF
		36	32	310000-317FFF
38 32 300000-307FFF		37	32	308000-30FFFF
		38	32	300000-307FFF

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Table 36. Top boot block addresses, M58WR064KT (continued)

Bank ⁽¹⁾	#	Size (Kword)	Address range
	39	32	2F8000-2FFFFF
	40	32	2F0000-2F7FFF
	41	32	2E8000-2EFFFF
Bank 4	42	32	2E0000-2E7FFF
Bar	43	32	2D8000-2DFFFF
	44	32	2D0000-2D7FFF
	45	32	2C8000-2CFFFF
	46	32	2C0000-2C7FFF
	47	32	2B8000-2BFFFF
	48	32	2B0000-2B7FFF
	49	32	2A8000-2AFFFF
ਨ ਪ	50	32	2A0000-2A7FFF
Bank 5	51	32	298000-29FFFF
	52	32	290000-297FFF
	53	32	288000-28FFFF
	54	32	280000-287FFF
	55	32	278000-27FFFF
	56	32	270000-277FFF
	57	32	268000-26FFFF
주 0	58	32	260000-267FFF
Bank 6	59	32	258000-25FFFF
	60	32	250000-257FFF
	61	32	248000-24FFFF
	62	32	240000-247FFF
	63	32	238000-23FFFF
	64	32	230000-237FFF
	65	32	228000-22FFFF
<u>¥</u>	66	32	220000-227FFF
Bank 7	67	32	218000-21FFFF
	68	32	210000-217FFF
	69	32	208000-20FFFF
	70	32	200000-207FFF
	71	32	1F8000-1FFFFF
	72	32	1F0000-1F7FFF
	73	32	1E8000-1EFFFF
⊼ ∞	74	32	1E0000-1E7FFF
Bank 8	75	32	1D8000-1DFFFF
	76	32	1D0000-1D7FFF
	77	32	1C8000-1CFFFF
	78	32	1C0000-1C7FFF

Table 36. Top boot block addresses, M58WR064KT (continued)

79 32 188000-18FFFF 80 32 18000-187FFF 81 32 1A8000-1AFFFF 81 32 1A8000-1AFFFF 83 32 198000-19FFFF 84 32 190000-19FFFF 85 32 188000-18FFFF 86 32 178000-17FFFF 87 32 178000-17FFFF 89 32 168000-16FFFF 90 32 160000-167FFF 91 32 158000-15FFFF 92 32 150000-15FFFF 93 32 148000-14FFFF 94 32 148000-14FFFF 95 32 138000-13FFFF 96 32 138000-13FFFF 97 32 128000-12FFFF 98 32 128000-12FFFF 99 32 128000-12FFFF 100 32 110000-117FFF 101 32 100000-107FFFF 102 32 100000-107FFFF 104 32 0F8000-00FFFFF 105 32 0E8000-00FFFFF 106 32 0E8000-00FFFFF 107 32 0D8000-00FFFFF 108 32 0D8000-00FFFFF 119 32 0C8000-00FFFFF 110 32 0C8000-00FFFFF 111 32 0C8000-00FFFFF 112 32 0D8000-00FFFFF 113 32 0C8000-00FFFFF 114 32 0C8000-00FFFFF 115 32 0C8000-00FFFFF 116 32 0C9000-00FFFFF 117 32 0C8000-00FFFFF 118 32 0C8000-00FFFFF	Bank ⁽¹⁾	#	Size (Kword)	Address range
81 32 1A8000-1AFFFF 82 32 198000-19FFFF 84 32 190000-19FFFF 85 32 188000-18FFFF 86 32 18000-18FFFF 87 32 178000-17FFFF 88 32 170000-17FFFF 88 32 170000-17FFFF 89 32 168000-16FFFF 90 32 168000-16FFFF 91 32 158000-15FFFF 91 32 158000-15FFFF 92 32 158000-15FFFF 93 32 148000-14FFFF 94 32 140000-14FFFF 95 32 138000-13FFFF 96 32 130000-13FFFF 97 32 128000-12FFFF 98 32 128000-12FFFF 100 32 110000-117FFF 101 32 108000-10FFFF 102 32 100000-17FFFF 103 32 0F8000-0FFFFF 104 32 0F8000-0FFFFF 105 32 0E8000-0FFFFF 106 32 0E8000-0FFFFF 107 32 0D8000-0FFFFF 108 32 0C8000-0FFFFF 109 32 0C8000-0FFFFF 110 32 0C8000-0FFFFF 111 32 0B8000-0FFFFF 112 32 0B8000-0FFFFF 113 32 0B8000-0FFFFF 114 32 0B8000-0FFFFF 115 32 0B8000-0FFFFF 116 32 0B8000-0FFFFF 117 32 0B8000-0FFFFF		79	32	1B8000-1BFFFF
### 82 32 1A0000-1A7FFF ### 83 32 198000-19FFFF ### 84 32 190000-197FFF ### 85 32 188000-18FFFF ### 86 32 170000-177FFF ### 88 32 170000-177FFF ### 88 32 170000-177FFF ### 89 32 168000-16FFFF ### 90 32 168000-16FFFF ### 91 32 158000-15FFFF ### 92 32 150000-15FFFF ### 93 32 148000-13FFFF ### 94 32 148000-13FFFF ### 95 32 138000-13FFFF ### 96 32 130000-13FFFF ### 97 32 128000-12FFFF ### 99 32 118000-11FFFF ### 100 32 110000-10FFFF ### 101 32 108000-10FFFF ### 102 32 100000-10FFFF ### 103 32 0F8000-0FFFFF ### 104 32 0F8000-0FFFFF ### 105 32 0E8000-0FFFFF ### 106 32 0E0000-0FFFFF ### 107 32 0D8000-0DFFFFF ### 108 32 0D0000-0DFFFFF ### 109 32 0C8000-0FFFFF ### 110 32 0C8000-0FFFFF ### 111 32 0B8000-0BFFFF ### 112 32 0B0000-0BFFFF ### 113 32 0A8000-0BFFFF ### 114 32 0A8000-0AFFFF ### 115 32 098000-09FFFF ### 116 32 090000-09FFFF ### 117 32 088000-08FFFF ### 116 32 090000-09FFFF ### 116 32 090000-09FFFF ### 117 32 088000-08FFFF ### 118 32 098000-09FFFF ### 119 32 098000-09FFFF ### 110 32 098000-09FFFF ### 111 32 098000-09FFFF ### 115 32 098000-09FFFF ### 116 32 099000-09FFFF ### 117 32 088000-08FFFF ### 118 32 098000-09FFFF ### 119 32 098000-09FFFF ### 110 32 098000-09FFFF ### 110 32 098000-09FFFF ### 1110 32 098000-09FFFF ### 1111 32 088000-08FFFF ### 1111 32 088000-08FFFF ### 1112 32 098000-09FFFF ### 1113 32 098000-09FFFF ### 1114 32 098000-09FFFF ### 1115 32 098000-09FFFF ### 1116 32 098000-09FFFF ### 1117 32 088000-08FFFF ### 1118 32 098000-09FFFF ### 1118 32 098000-09FFFF ### 1118 32 098000-09FFFF ### 1118 32 098000-09FFFF ##		80	32	1B0000-1B7FFF
### 84		81	32	1A8000-1AFFFF
### 84	8 8	82	32	1A0000-1A7FFF
### 84	Ban	83	32	198000-19FFFF
### B66 32		84	32	190000-197FFF
### 17		85	32	188000-18FFFF
### B8		86	32	180000-187FFF
Section		87	32	178000-17FFFF
Page		88	32	170000-177FFF
92 32 150000-157FFF 93 32 148000-14FFFF 94 32 140000-147FFF 95 32 138000-13FFFF 96 32 130000-137FFF 97 32 128000-12FFFF 98 32 120000-12FFFF 99 32 118000-11FFFF 100 32 110000-117FFF 101 32 108000-10FFFF 102 32 100000-10FFFF 103 32 0F8000-0FFFFF 104 32 0F8000-0FFFFF 105 32 0E8000-0EFFFF 106 32 0E8000-0EFFFF 107 32 0D8000-0DFFFF 108 32 0D0000-0DFFFF 109 32 0C8000-0FFFF 110 32 0C8000-0FFFF 111 32 0B8000-0BFFFF 111 32 0B8000-0BFFFF 112 32 0B0000-0BFFFF 113 32 0B8000-0BFFFF 114 32 0B8000-0BFFFF 115 32 0B8000-0FFFF 116 32 0B8000-0FFFF 117 32 0B8000-0FFFF 118 32 0B8000-0FFFF 119 32 0B8000-0FFFF 110 32 0B8000-0FFFF 111 32 0B8000-0FFFF 112 32 0B8000-0FFFF 113 32 0B8000-0FFFF 114 32 0B8000-0FFFF 115 32 0B8000-0FFFF		89	32	168000-16FFFF
92 32 150000-157FFF 93 32 148000-14FFFF 94 32 140000-147FFF 95 32 138000-13FFFF 96 32 130000-137FFF 97 32 128000-12FFFF 98 32 120000-12FFFF 99 32 118000-11FFFF 100 32 110000-117FFF 101 32 108000-10FFFF 102 32 100000-10FFFF 103 32 0F8000-0FFFFF 104 32 0F8000-0FFFFF 105 32 0E8000-0EFFFF 106 32 0E8000-0EFFFF 107 32 0D8000-0DFFFF 108 32 0D0000-0DFFFF 109 32 0C8000-0FFFF 110 32 0C8000-0FFFF 111 32 0B8000-0BFFFF 111 32 0B8000-0BFFFF 112 32 0B0000-0BFFFF 113 32 0B8000-0BFFFF 114 32 0B8000-0BFFFF 115 32 0B8000-0FFFF 116 32 0B8000-0FFFF 117 32 0B8000-0FFFF 118 32 0B8000-0FFFF 119 32 0B8000-0FFFF 110 32 0B8000-0FFFF 111 32 0B8000-0FFFF 112 32 0B8000-0FFFF 113 32 0B8000-0FFFF 114 32 0B8000-0FFFF 115 32 0B8000-0FFFF	× 10	90	32	160000-167FFF
92 32 150000-157FFF 93 32 148000-14FFFF 94 32 140000-147FFF 95 32 138000-13FFFF 96 32 130000-137FFF 97 32 128000-12FFFF 98 32 120000-12FFFF 99 32 118000-11FFFF 100 32 110000-117FFF 101 32 108000-10FFFF 102 32 100000-10FFFF 103 32 0F8000-0FFFFF 104 32 0F8000-0FFFFF 105 32 0E8000-0EFFFF 106 32 0E8000-0EFFFF 107 32 0D8000-0DFFFF 108 32 0D0000-0DFFFF 109 32 0C8000-0FFFF 110 32 0C8000-0FFFF 111 32 0B8000-0BFFFF 111 32 0B8000-0BFFFF 112 32 0B0000-0BFFFF 113 32 0B8000-0BFFFF 114 32 0B8000-0BFFFF 115 32 0B8000-0FFFF 116 32 0B8000-0FFFF 117 32 0B8000-0FFFF 118 32 0B8000-0FFFF 119 32 0B8000-0FFFF 110 32 0B8000-0FFFF 111 32 0B8000-0FFFF 112 32 0B8000-0FFFF 113 32 0B8000-0FFFF 114 32 0B8000-0FFFF 115 32 0B8000-0FFFF	3ank	91	32	158000-15FFFF
94 32 140000-147FFF 95 32 138000-13FFFF 96 32 128000-12FFFF 97 32 128000-12FFFF 98 32 120000-12FFFF 100 32 118000-11FFFF 1100 32 110000-117FFF 1101 32 108000-10FFFF 1102 32 100000-10FFFF 1103 32 0F8000-0FFFFF 1104 32 0F8000-0FFFFF 1105 32 0E8000-0EFFFF 1106 32 0E0000-0EFFFF 1107 32 0D8000-0DFFFF 1109 32 0C8000-0FFFF 110 32 0C8000-0FFFF 111 32 0B8000-0BFFFF 112 32 0B8000-0BFFFF 113 32 0B8000-0BFFFF 114 32 0A8000-0AFFFF 115 32 098000-0FFFF 116 32 090000-0FFFF 117 32 088000-0BFFFF	ш	92	32	150000-157FFF
95 32 138000-13FFFF 96 32 130000-137FFF 97 32 128000-12FFFF 98 32 120000-127FFF 100 32 118000-11FFFF 1101 32 108000-10FFFF 1102 32 100000-107FFF 1103 32 0F8000-0FFFF 1104 32 0F8000-0FFFF 1105 32 0E8000-0EFFFF 1106 32 0E8000-0EFFFF 1109 32 0D8000-0DFFFF 1109 32 0C8000-0CFFFF 1109 32 0C8000-0FFFF 1110 32 0C8000-0FFFF 1111 32 0B8000-0BFFFF 1112 32 0B0000-0BFFFF 1114 32 0A8000-0AFFFF 115 32 098000-09FFFF 116 32 098000-09FFFF 117 32 088000-09FFFF		93	32	148000-14FFFF
96 32 130000-137FFF 97 32 128000-12FFFF 98 32 120000-12FFFF 99 32 118000-11FFFF 100 32 110000-117FFF 101 32 108000-10FFFF 102 32 100000-107FFF 103 32 0F8000-0FFFF 104 32 0F8000-0FFFF 105 32 0E8000-0EFFFF 106 32 0E8000-0EFFFF 108 32 0D0000-0D7FFF 109 32 0C8000-0CFFFF 109 32 0C8000-0CFFFF 110 32 0C8000-0CFFFF 111 32 0B8000-0BFFFF 112 32 0B8000-0BFFFF 113 32 0A8000-0AFFFF 114 32 0A9000-0AFFFF 115 32 098000-09FFFF 116 32 099000-097FFF 117 32 088000-08FFFF 117 32 088000-08FFFFF 118 32 098000-08FFFFF 119 32 088000-08FFFFF 110 32 088000-08FFFFF 111 32 088000-08FFFFF 112 32 088000-08FFFFF 113 32 088000-08FFFFF 114 32 088000-08FFFFF 115 32 088000-08FFFFF 116 32 088000-08FFFFF 117 32 088000-08FFFFF 118 32 088000-08FFFFF 119 32 088000-08FFFFFF 110 32 088000-08FFFFF 111 32 088000-08FFFFFFFFFFFFFFFFFFFFFFFFFFFFFF		94	32	140000-147FFF
97 32 128000-12FFFF 98 32 120000-127FFF 99 32 118000-11FFFF 100 32 110000-117FFF 101 32 108000-10FFFF 102 32 100000-107FFF 103 32 0F8000-0FFFFF 104 32 0F8000-0EFFFF 105 32 0E8000-0EFFFF 106 32 0E9000-0E7FFF 107 32 0D8000-0DFFFF 108 32 0D0000-0D7FFF 109 32 0C8000-0CFFFF 110 32 0C8000-0CFFFF 111 32 0B8000-0BFFFF 112 32 0B9000-0BFFFF 113 32 0A8000-0AFFFF 114 32 0A9000-0AFFFF 115 32 098000-09FFFF 116 32 090000-097FFF 117 32 088000-08FFFFF 117 32 088000-08FFFFFFFFFFFFFFFFFFFFFFFFFFFFFF		95	32	138000-13FFFF
98 32		96	32	130000-137FFF
100 32		97	32	128000-12FFFF
100 32	7 +	98	32	120000-127FFF
100 32	3anl	99	32	118000-11FFFF
102 32 100000-107FFF	ш	100	32	110000-117FFF
103 32 0F8000-0FFFF 104 32 0F0000-0F7FF 105 32 0E8000-0E7FFF 106 32 0E0000-0E7FFF 107 32 0D8000-0D7FFF 108 32 0D0000-0D7FFF 109 32 0C8000-0C7FFF 110 32 0C8000-0C7FFF 111 32 0B8000-0BFFFF 112 32 0B0000-0B7FFF 113 32 0A8000-0A7FFF 114 32 0A9000-0A7FFF 115 32 098000-097FFF 116 32 090000-097FFF 117 32 088000-08FFFF 118 119 1		101	32	108000-10FFFF
104 32 0F0000-0F7FFF 105 32 0E8000-0EFFFF 106 32 0E0000-0E7FFF 107 32 0D8000-0DFFFF 108 32 0D0000-0D7FFF 109 32 0C8000-0CFFFF 110 32 0C8000-0CFFFF 111 32 0B8000-0BFFFF 112 32 0B0000-0BFFFF 113 32 0A8000-0AFFFF 114 32 0A8000-0AFFFF 115 32 098000-09FFFF 116 32 090000-097FFF 117 32 088000-08FFFF 117 32 088000-08FFFF 117 32 088000-08FFFFF 118 117 32 088000-08FFFFF 119 110 1		102	32	100000-107FFF
105 32 0E8000-0EFFFF 106 32 0E0000-0E7FFF 107 32 0D8000-0DFFFF 108 32 0C8000-0CFFFF 109 32 0C8000-0CFFFF 110 32 0C8000-0CFFFF 111 32 0B8000-0BFFFF 112 32 0B0000-0BFFFF 113 32 0A8000-0AFFFF 114 32 0A9000-0A7FFF 115 32 098000-09FFFF 116 32 090000-09FFFF 117 32 088000-08FFFF 117 32 088000-08FFFF 117 32 088000-08FFFFF 117 32 088000-08FFFFF 117 32 088000-08FFFFF 118 32 088000-08FFFFF 119 32 088000-08FFFFF 110 32 088000-08FFFFF 111 32 088000-08FFFFF 112 32 088000-08FFFFF 113 32 088000-08FFFFF 114 32 088000-08FFFFF 115 32 088000-08FFFFF 116 32 088000-08FFFFF 117 32 088000-08FFFFF 118 119 119 119 119 119 119 119 110 110 119 119 110 110 119 110 110 119 111 111 119 112 119 119 113 119 119 114 115 119 115 116 119 116 117 119 117 119 119 118 119 119 119 119 119 110 119 110 119 110 119 110 119 111 119 111 119 112 119 113 119 114 119 115 119 116 119 117 119 118 119 119 119 110 119		103	32	0F8000-0FFFF
106 32 0E0000-0E7FFF		104	32	0F0000-0F7FFF
108 32 0D0000-0D7FFF 109 32 0C8000-0CFFFF 110 32 0C0000-0C7FFF 111 32 0B8000-0BFFFF 112 32 0B0000-0B7FFF 113 32 0A8000-0AFFFF 114 32 0A0000-0A7FFF 115 32 098000-09FFFF 116 32 098000-09FFFF 117 32 088000-08FFFF		105	32	0E8000-0EFFFF
108 32 0D0000-0D7FFF 109 32 0C8000-0CFFFF 110 32 0C0000-0C7FFF 111 32 0B8000-0BFFFF 112 32 0B0000-0B7FFF 113 32 0A8000-0AFFFF 114 32 0A0000-0A7FFF 115 32 098000-09FFFF 116 32 098000-09FFFF 117 32 088000-08FFFF	4 12	106	32	0E0000-0E7FFF
108 32 0D0000-0D7FFF 109 32 0C8000-0CFFFF 110 32 0C0000-0C7FFF 111 32 0B8000-0BFFFF 112 32 0B0000-0B7FFF 113 32 0A8000-0AFFFF 114 32 0A0000-0A7FFF 115 32 098000-09FFFF 116 32 098000-09FFFF 117 32 088000-08FFFF	3an	107	32	0D8000-0DFFFF
110 32 0C0000-0C7FFF 111 32 0B8000-0BFFFF 112 32 0B0000-0B7FFF 113 32 0A8000-0AFFFF 114 32 0A0000-0A7FFF 115 32 098000-09FFFF 116 32 090000-097FFF 117 32 088000-08FFFF		108	32	0D0000-0D7FFF
111 32 0B8000-0BFFFF 112 32 0B0000-0B7FFF 113 32 0A8000-0AFFFF 114 32 0A0000-0A7FFF 115 32 098000-09FFFF 116 32 090000-097FFF 117 32 088000-08FFFF		109	32	0C8000-0CFFFF
112 32 0B0000-0B7FFF 113 32 0A8000-0AFFFF 114 32 0A0000-0A7FFF 115 32 098000-09FFFF 116 32 090000-097FFF 117 32 088000-08FFFF		110	32	0C0000-0C7FFF
113 32 0A8000-0AFFFF 114 32 0A0000-0A7FFF 115 32 098000-09FFFF 116 32 090000-097FFF 117 32 088000-08FFFF		111	32	0B8000-0BFFFF
114 32 0A0000-0A7FFF 115 32 098000-09FFFF 116 32 090000-097FFF 117 32 088000-08FFFF		112	32	0B0000-0B7FFF
116 32 090000-097FFF 117 32 088000-08FFFF		113	32	0A8000-0AFFFF
116 32 090000-097FFF 117 32 088000-08FFFF	X 13	114	32	0A0000-0A7FFF
116 32 090000-097FFF 117 32 088000-08FFFF	Bani	115	32	098000-09FFFF
		116	32	090000-097FFF
118 32 080000-087FFF		117	32	088000-08FFFF
		118	32	080000-087FFF

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Table 36. Top boot block addresses, M58WR064KT (continued)

Bank ⁽¹⁾	#	Size (Kword)	Address range
	119	32	078000-07FFFF
	120	32	070000-077FFF
	121	32	068000-06FFFF
41	122	32	060000-067FFF
Bank	123	32	058000-05FFFF
ш	124	32	050000-057FFF
	125	32	048000-04FFFF
	126	32	040000-047FFF
	127	32	038000-03FFFF
	128	32	030000-037FFF
_	129	32	028000-02FFFF
x 15	130	32	020000-027FFF
Bank	131	32	018000-01FFFF
	132	32	010000-017FFF
	133	32	008000-00FFFF
	134	32	000000-007FFF

There are two bank regions: bank region 1 contains all the banks that are made up of main blocks only; bank region 2 contains the banks that are made up of the parameter and main blocks (parameter bank).

Table 37. Bottom boot block addresses, M58WR064KB

Bank ⁽¹⁾	#	Size (Kword)	Address range
	134	32	3F8000-3FFFFF
	133	32	3F0000-3F7FFF
	132	32	3E8000-3EFFFF
× 15	131	32	3E0000-3E7FFF
Bank 15	130	32	3D8000-3DFFFF
	129	32	3D0000-3D7FFF
	128	32	3C8000-3CFFFF
	127	32	3C0000-3C7FFF
	126	32	3B8000-3BFFFF
	125	32	3B0000-3B7FFF
	124	32	3A8000-3AFFFF
Bank 14	123	32	3A0000-3A7FFF
	122	32	398000-39FFFF
	121	32	390000-397FFF
	120	32	388000-38FFFF
	119	32	380000-387FFF

Table 37. Bottom boot block addresses, M58WR064KB (continued)

Bank ⁽¹⁾	#	Size (Kword)	Address range
	118	32	378000-37FFFF
	117	32	370000-377FFF
	116	32	368000-36FFFF
c 13	115	32	360000-367FFF
Bank 13	114	32	358000-35FFFF
	113	32	350000-357FFF
	112	32	348000-34FFFF
	111	32	340000-347FFF
	110	32	338000-33FFFF
	109	32	330000-337FFF
	108	32	328000-32FFFF
7 7 7 7 7 7 7 7 7 7 7 7 7 7 7 7 7 7 7 7	107	32	320000-327FFF
Bank 12	106	32	318000-31FFFF
	105	32	310000-317FFF
	104	32	308000-30FFFF
	103	32	300000-307FFF
	102	32	2F8000-2FFFFF
	101	32	2F0000-2F7FFF
	100	32	2E8000-2EFFFF
- -	99	32	2E0000-2E7FFF
Bank 11	98	32	2D8000-2DFFFF
	97	32	2D0000-2D7FFF
	96	32	2C8000-2CFFFF
	95	32	2C0000-2C7FFF
	94	32	2B8000-2BFFFF
	93	32	2B0000-2B7FFF
	92	32	2A8000-2AFFFF
Bank 10	91	32	2A0000-2A7FFF
Bani	90	32	298000-29FFFF
	89	32	290000-297FFF
	88	32	288000-28FFFF
	87	32	280000-287FFF

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Table 37. Bottom boot block addresses, M58WR064KB (continued)

Bank ⁽¹⁾	#	Size (Kword)	Address range
	86	32	278000-27FFFF
	85	32	270000-277FFF
	84	32	268000-26FFFF
ج و	83	32	260000-267FFF
Bank 9	82	32	258000-25FFFF
	81	32	250000-257FFF
	80	32	248000-24FFFF
	79	32	240000-247FFF
	78	32	238000-23FFFF
	77	32	230000-237FFF
	76	32	228000-22FFFF
Bank 8	75	32	220000-227FFF
Bar	74	32	218000-21FFFF
	73	32	210000-217FFF
	72	32	208000-20FFFF
	71	32	200000-207FFF
	70	32	1F8000-1FFFFF
	69	32	1F0000-1F7FFF
	68	32	1E8000-1EFFFF
Bank 7	67	32	1E0000-1E7FFF
Bar	66	32	1D8000-1DFFFF
	65	32	1D0000-1D7FFF
	64	32	1C8000-1CFFFF
	63	32	1C0000-1C7FFF
	62	32	1B8000-1BFFFF
	61	32	1B0000-1B7FFF
	60	32	1A8000-1AFFFF
Bank 6	59	32	1A0000-1A7FFF
Ban	58	32	198000-19FFFF
	57	32	190000-197FFF
	56	32	188000-18FFFF
	55	32	180000-187FFF

Table 37. Bottom boot block addresses, M58WR064KB (continued)

Bank ⁽¹⁾	#	Size (Kword)	Address range
	54	32	178000-17FFFF
	53	32	170000-177FFF
	52	32	168000-16FFFF
Bank 5	51	32	160000-167FFF
Bar	50	32	158000-15FFFF
	49	32	150000-157FFF
	48	32	148000-14FFFF
	47	32	140000-147FFF
	46	32	138000-13FFFF
	45	32	130000-137FFF
	44	32	128000-12FFFF
ㅊ 4	43	32	120000-127FFF
Bank 4	42	32	118000-11FFFF
	41	32	110000-117FFF
	40	32	108000-10FFFF
	39	32	100000-107FFF
	38	32	0F8000-0FFFF
	37	32	0F0000-0F7FFF
	36	32	0E8000-0EFFFF
Bank 3	35	32	0E0000-0E7FFF
Bar	34	32	0D8000-0DFFFF
	33	32	0D0000-0D7FFF
	32	32	0C8000-0CFFFF
	31	32	0C0000-0C7FFF
	30	32	0B8000-0BFFFF
	29	32	0B0000-0B7FFF
	28	32	0A8000-0AFFFF
× 2	27	32	0A0000-0A7FFF
Bank 2	26	32	098000-09FFFF
	25	32	090000-097FFF
	24	32	088000-08FFFF
	23	32	080000-087FFF

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Table 37. Bottom boot block addresses, M58WR064KB (continued)

Bank ⁽¹⁾	#	Size (Kword)	Address range
	22	32	078000-07FFFF
	21	32	070000-077FFF
	20	32	068000-06FFFF
Bank 1	19	32	060000-067FFF
Bar	18	32	058000-05FFFF
	17	32	050000-057FFF
	16	32	048000-04FFFF
	15	32	040000-047FFF
	14	32	038000-03FFFF
	13	32	030000-037FFF
	12	32	028000-02FFFF
	11	32	020000-027FFF
	10	32	018000-01FFFF
¥	9	32	010000-017FFF
Parameter bank	8	32	008000-00FFFF
leter	7	4	007000-007FFF
aram	6	4	006000-006FFF
2	5	4	005000-005FFF
	4	4	004000-004FFF
	3	4	003000-003FFF
	2	4	002000-002FFF
	1	4	001000-001FFF
	0	4	000000-000FFF

There are two bank regions: bank region 2 contains all the banks that are made up of main blocks only; bank region 1 contains the banks that are made up of the parameter and main blocks (parameter bank).

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Appendix B Common Flash interface

The common Flash interface is a JEDEC approved, standardized data structure that can be read from the Flash memory device. It allows a system software to query the device to determine various electrical and timing parameters, density information and functions supported by the memory. The system can interface easily with the device, enabling the software to upgrade itself when necessary.

When the Read CFI Query Command is issued the device enters CFI query mode and the data structure is read from the memory. Tables 38, 39, 40, 41, 42, 43, 44, 45, 46 and 47 show the addresses used to retrieve the data. The query data is always presented on the lowest order data outputs (DQ0-DQ7), the other outputs (DQ8-DQ15) are set to 0.

The CFI data structure also contains a security area where a 64-bit unique security number is written (see *Figure 7: Protection Register memory map*). This area can be accessed only in read mode by the final user. It is impossible to change the security number after it has been written by Numonyx. Issue a Read Array command to return to read mode.

Table 38. Query structure overview⁽¹⁾

Offset	Sub-section name	Description
00h	Reserved	Reserved for algorithm-specific information
10h	CFI Query Identification String	Command set ID and algorithm data offset
1Bh	System Interface Information	Device timing & voltage information
27h	Device Geometry Definition	Flash device layout
Р	Primary Algorithm-specific Extended Query table	Additional information specific to the Primary Algorithm (optional)
А	Alternate Algorithm-specific Extended Query table	Additional information specific to the Alternate Algorithm (optional)
80h	Security Code Area	Lock Protection Register Unique device Number and User Programmable OTP

The Flash memory display the CFI data structure when CFI Query command is issued. In this table are listed the main sub-sections detailed in Tables 39, 40, 41 and 42. Query data is always presented on the lowest order data outputs.

Table 39. CFI query identification string

	o. Or requery recommendation ourning						
Offset	Sub-section name	Description	Value				
00h	0020h	Manufacturer code	Numonyx				
	8812h		M58WR016KT (Top)				
	8814h		M58WR032KT (Top)				
01h	8810h	Device code	M58WR064KT (Top)				
UIII	8813h	Device code	M58WR016KB (Bottom)				
	8815h		M58WR032KB (Bottom)				
	8811h		M58WR064KB (Bottom)				
02h	reserved	Reserved					
03h	reserved	Reserved					
04h-0Fh	reserved	Reserved					
10h	0051h		"Q"				
11h	0052h	Query Unique ASCII String "QRY"	"R"				
12h	0059h		" Y "				
13h	0003h	Primary Algorithm Command Set and					
14h	0000h	Control Interface ID code 16 bit ID code defining a specific algorithm					
15h	offset = P = 0039h	Address for Primary Algorithm extended	p = 39h				
16h	0000h	Query table (see <i>Table 42</i>)	p = 3911				
17h	0000h	Alternate Vendor Command Set and	NIA				
18h	0000h	Control Interface ID Code second vendor - specified algorithm supported	NA				
19h	value = A = 0000h	Address for Alternate Algorithm extended	NA				
1Ah	0000h	Query table	INA				

Table 40. CFI query system interface information

Offset	Data	Description	Value
1Bh	0017h	V _{DD} Logic Supply Minimum Program/Erase or Write voltage bit 7 to 4 BCD value in volts bit 3 to 0 BCD value in 100 millivolts	
1Ch	0020h	V _{DD} Logic Supply Maximum Program/Erase or Write voltage bit 7 to 4 BCD value in volts bit 3 to 0 BCD value in 100 millivolts	
1Dh	0085h	V _{PP} [Programming] Supply Minimum Program/Erase voltage bit 7 to 4 HEX value in volts bit 3 to 0 BCD value in 100 millivolts	
1Eh	0095h	V _{PP} [Programming] Supply Maximum Program/Erase voltage bit 7 to 4 HEX value in volts bit 3 to 0 BCD value in 100 millivolts	
1Fh	0004h	Typical time-out per single byte/word program = 2 ⁿ μs	
20h	0000h	Typical time-out for multi-byte programming = 2 ⁿ µs	
21h	000Ah	Typical time-out per individual block erase = 2 ⁿ ms	1s
22h	0000h	Typical time-out for full chip erase = 2 ⁿ ms	
23h	0003h	Maximum time-out for word program = 2 ⁿ times typical	
24h	0000h	Maximum time-out for multi-byte programming = 2 ⁿ times typical	
25h	0002h	Maximum time-out per individual block erase = 2 ⁿ times typical	
26h	0000h	Maximum time-out for chip erase = 2 ⁿ times typical	NA

Table 41. Device geometry definition

	Offset word mode	Data	Description				
0015h		0015h	M58WR016KT/B Device Size = 2 ⁿ in number of bytes	2 Mbytes			
	27h	0016h	M58WR032KT/B Device Size = 2 ⁿ in number of bytes				
		0017h	M58WR064KT/B Device Size = 2 ⁿ in number of bytes				
	28h 29h	0001h 0000h	Flash Device Interface Code description	x16 Async.			
	2Ah 2Bh	0000h 0000h	Maximum number of bytes in multi-byte program or page = 2 ⁿ	NA			
	2Ch	0002h	Number of identical sized erase block regions within the device bit 7 to $0 = x =$ number of Erase Block Regions	2			
		001Eh 0000h	M58WR016KT Region 1 Information Number of identical-size erase blocks = 001Eh+1	31			
	2Dh 2Eh	003Eh 0000h	M58WR032KT Region 1 Information Number of identical-size erase blocks = 003Eh+1	63			
es		007Eh 0000h	M58WR064KT Region 1 Information Number of identical-size erase blocks = 007Eh+1	127			
Top devices	2Fh 0000h 30h 0001h		Region 1 Information Block size in Region 1 = 0100h * 256 byte	64 Kbyte			
ΤοT	31h 32h	0007h 0000h	Region 2 Information Number of identical-size erase blocks = 0007h+1	8			
	33h 34h	0020h 0000h	Region 2 Information Block size in Region 2 = 0020h * 256 byte	8 Kbyte			
	35h 38h Reserved		for future erase block region information	NA			
	2Dh 2Eh	0007h 0000h	Region 1 Information Number of identical-size erase block = 0007h+1	8			
	2Fh 30h	0020h 0000h	Region 1 Information Block size in Region 1 = 0020h * 256 byte	8 Kbyte			
ices		001Eh 0000h	M58WR016KB Region 1 Information Number of identical-size erase blocks = 001Eh+1	31			
Bottom device	31h 32h	003Eh 0000h	M58WR032KB Region 1 Information Number of identical-size erase blocks = 003Eh+1	63			
Bottc	Bottc	007Eh 0000h	M58WR064KB Region 1 Information Number of identical-size erase blocks = 007Eh+1	127			
	33h 34h	0000h 0001h	0000h Region 2 Information				
35h 38h Reserved		Reserved	for future erase block region information	NA			

Table 42. Primary algorithm-specific extended query table⁽¹⁾

Offset	Data	Description	Value		
(P)h = 39h	0050h		"P"		
	0052h	Primary Algorithm extended Query table unique ASCII string "PRI"	"R"		
	0049h		" "		
(P+3)h = 3Ch	0031h	Major version number, ASCII	"1"		
(P+4)h = 3Dh	0033h	Minor version number, ASCII	"3"		
(P+5)h = 3Eh	00E6h	Extended Query table contents for Primary Algorithm. Address (P+5)h contains			
	0003h	less significant byte.			
(P+7)h = 40h	0000h	bit 0 Chip Erase supported (1 = Yes, 0 = No)			
		bit 1 Erase Suspend supported (1 = Yes, 0 = No)	No		
		bit 2 Program Suspend supported (1 = Yes, 0 = No)	Yes		
İ		bit 3 Legacy Lock/Unlock supported (1 = Yes, 0 = No)	Yes		
		bit 4 Queued Erase supported (1 = Yes, 0 = No)	No		
		bit 5 Instant individual block locking supported (1 = Yes, 0 = No)	No		
(P+8)h = 41h	0000h	bit 6 Protection bits supported (1 = Yes, 0 = No)	Yes		
		bit 7 Page mode read supported (1 = Yes, 0 = No)	Yes		
		bit 8 Synchronous read supported (1 = Yes, 0 = No)	Yes		
		bit 9 Simultaneous operation supported (1 = Yes, 0 = No)	Yes		
		bit 10 to 31 Reserved; undefined bits are '0'. If bit 31 is '1' then another 31 bit field of optional features follows at the end of the bit-30 field.	Yes		
		Supported Functions after Suspend			
		Read Array, Read Status Register and CFI Query			
(P+9)h = 42h	0001h	, , , , , , , , , , , , , , , , , , ,	Yes		
(1 1 2)11		bit 0 Program supported after Erase Suspend (1 = Yes, 0 = No)			
		bit 7 to 1 Reserved; undefined bits are '0'			
(P+A)h = 43h	0003h	Block Protect status			
(1.7.1)		Defines which bits in the Block Status Register section of the Query are			
		implemented.			
(P+B)h = 44h	0000h	hit O Black, protect Ctatus Bogistar Lock/Uplack, hit active (4. Vec. O. No.)			
,		bit 0 Block protect Status Register Lock/Unlock bit active (1 = Yes, 0 = No)	.,		
		bit 1 Block Lock Status Register lock-down bit active (1 = Yes, 0 = No)	Yes		
		bit 15 to 2 Reserved for future use; undefined bits are '0'	Yes		
		V _{DD} Logic Supply Optimum Program/Erase voltage (highest performance)			
(P+C)h = 45h	0018h	hit 7 to 4 LICV value in valte	1.8V		
		bit 7 to 4 HEX value in volts			
		bit 3 to 0 BCD value in 100 mV			
		V _{PP} Supply Optimum Program/Erase voltage			
(P+D)h = 46h	0090h	bit 7 to 4 HEX value in volts	9V		
		bit 3 to 0 BCD value in 100 mV			
		DICO TO O DOD VAINE III TOO IIIV			

^{1.} The variable P is a pointer that is defined at CFI offset 15h.

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Table 43. Protection Register information⁽¹⁾

Offset	Data	Description	Value
(P+E)h = 47h	0001h	Number of protection register fields in JEDEC ID space. 0000h indicates that 256 fields are available.	1
(P+F)h = 48h	0080h	Protection Field 1: Protection Description	0080h
(P+10)h = 49h	0000h	Bits 0-7 Lower byte of protection register address	000011
(P+11)h = 4Ah	0003h	Bits 8-15 Upper byte of protection register address Bits 16-23 2 ⁿ bytes in factory pre-programmed region	
(P+12)h= 4Bh	0004h	Bits 24-31 2 ⁿ bytes in user programmable region	16 bytes

^{1.} The variable P is a pointer that is defined at CFI offset 15h.

Table 44. Burst Read information⁽¹⁾

Offset	Data	Description			
(P+13)h = 4Ch	0003h	Page-mode read capability bits 0-7 'n' such that 2 ⁿ HEX value represents the number of read-page bytes. See offset 28h for device word width to determine page-mode data output width.	8 bytes		
(P+14)h = 4Dh	0004h	Number of synchronous mode read configuration fields that follow.	4		
(P+15)h = 4Eh	0001h	Synchronous mode read capability configuration 1 bit 3-7 Reserved bit 0-2 'n' such that 2 ⁿ⁺¹ HEX value represents the maximum number of continuous synchronous reads when the device is configured for its maximum word width. A value of 07h indicates that the device is capable of continuous linear bursts that will output data until the internal burst counter reaches the end of the device's burstable address space. This field's 3-bit value can be written directly to the read configuration register bit 0-2 if the device is configured for its maximum word width. See offset 28h for word width to determine the burst data output width.	4		
(P+16)h = 4Fh	0002h	Synchronous mode read capability configuration 2	8		
(P+17)h = 50h	0003h	Synchronous mode read capability configuration 3	16		
(P+18)h = 51h	0007h	Synchronous mode read capability configuration 4	Cont.		

^{1.} The variable P is a pointer that is defined at CFI offset 15h.

Table 45. Bank and erase block region information^{(1) (2)}

M58WR016KT, M58WR032KT, M58WR064KT		M58WR016KB, M58WR032KB, M58WR064KB		Description
Offset	Data	Offset	Data	
(P+19)h = 52h	02h	(P+19)h = 52h	02h	Number of Bank Regions within the device

^{1.} The variable P is a pointer that is defined at CFI offset 15h.

^{2.} Bank Regions. There are two Bank Regions, see Tables 32, 33, 34, 35, 36 and 37.

Table 46. Bank and erase block region 1 information⁽¹⁾

M58WR016KT, M58WR032KT, M58WR064KT		M58WR016KB, M58WR032KB, M58WR064KB		Description
Offset	Data	Offset	Data	
(P+1A)h = 53h	03h ⁽²⁾ 07h ⁽³⁾ 0Fh ⁽⁴⁾	(P+1A)h = 53h	01h	Number of identical banks within Bank Region 1
(P+1B)h = 54h	00h	(P+1B)h = 54h	00h	
(P+1C)h = 55h	11h	(P+1C)h = 55h	11h	Number of program or erase operations allowed in Bank Region 1: Bits 0-3: Number of simultaneous program operations Bits 4-7: Number of simultaneous erase operations
(P+1D)h = 56h	00h	(P+1D)h = 56h	00h	Number of program or erase operations allowed in other banks while a bank in same region is programming Bits 0-3: Number of simultaneous program operations Bits 4-7: Number of simultaneous erase operations
(P+1E)h = 57h	00h	(P+1E)h = 57h	00h	Number of program or erase operations allowed in other banks while a bank in this region is erasing Bits 0-3: Number of simultaneous program operations Bits 4-7: Number of simultaneous erase operations
(P+1F)h = 58h	01h	(P+1F)h = 58h	02h	Types of erase block regions in Bank Region 1 n = number of erase block regions with contiguous same-size erase blocks. Symmetrically blocked banks have one blocking region. (5)
(P+20)h = 59h	07h	(P+20)h = 59h	07h	
(P+21)h = 5Ah	00h	(P+21)h = 5Ah	00h	Bank Region 1 Erase Block Type 1 Information
(P+22)h = 5Bh	00h	(P+22)h = 5Bh	20h	Bits 0-15: n+1 = number of identical-sized erase blocks Bits 16-31: n×256 = number of bytes in erase block region
(P+23)h = 5Ch	01h	(P+23)h = 5Ch	00h	, , , , , , , , , , , , , , , , , , ,
(P+24)h = 5Dh	64h	(P+24)h = 5Dh	64h	Bank Region 1 (Erase Block Type 1)
(P+25)h = 5Eh	00h	(P+25)h = 5Eh	00h	Minimum block erase cycles × 1000
(P+26)h = 5Fh	01h	(P+26)h = 5Fh	01h	Bank Region 1 (Erase Block Type 1): Blts per cell, internal ECC Bits 0-3: bits per cell in erase region Bit 4: reserved for "internal ECC used" Blts 5-7: reserved 5Eh 01 5Eh 01
(P+27)h = 60h	03h	(P+27)h = 60h	03h	Bank Region 1 (Erase Block Type 1): page mode and synchronous mode capabilities Bit 0: Page-mode reads permitted Bit 1: Synchronous reads permitted Bit 2: Synchronous writes permitted Bits 3-7: reserved

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Table 46. Bank and erase block region 1 information⁽¹⁾ (continued)

M58WR0	M58WR016KT, M58WR032KT, M58WR064KT		KB, KB, IKB	Description
Offset	Data	Offset	Data	
		(P+28)h = 61h	06h	Deal Decision A Francisco
		(P+29)h = 62h	00h	Bank Region 1 Erase Block Type 2 Information
		(P+2A)h = 63h	00h	Bits 0-15: n+1 = number of identical-sized erase blocks Bits 16-31: n×256 = number of bytes in erase block region
		(P+2B)h = 64h	01h	bits 10 31. Tix250 = Humber of bytes in crase block region
		(P+2C)h = 65h	64h	Bank Region 1 (Erase Block Type 2)
		(P+2D)h = 66h	00h	Minimum block erase cycles × 1000
		(P+2E)h = 67h	01h	Bank Regions 1 (Erase Block Type 2): Blts per cell, internal ECC Bits 0-3: bits per cell in erase region Bit 4: reserved for "internal ECC used" Blts 5-7: reserved
		(P+2F)h = 68h	03h	Bank Region 1 (Erase Block Type 2): page mode and synchronous mode capabilities Bit 0: Page-mode reads permitted Bit 1: Synchronous reads permitted Bit 2: Synchronous writes permitted Bits 3-7: reserved

^{1.} The variable P is a pointer which is defined at CFI offset 15h.

^{2.} Applies to M58WR016KT.

^{3.} Applies to M58WR032KT.

^{4.} Applies to M58WR064KT.

^{5.} Bank Regions. There are two Bank Regions, see Tables 32, 33, 34, 35, 36 and 37.

Table 47. Bank and Erase block region 2 information⁽¹⁾

M58WR016KT, M58WR032KT, M58WR064KT		M58WR016KB, M58WR032KB, M58WR064KB		Description
Offset	Data	Offset	Data	
(P+28)h = 61h	01h	(P+30)h = 69h	03h ⁽²⁾ 07h ⁽³⁾ 0Fh ⁽⁴⁾	Number of identical banks within Bank Region 2
(P+29)h = 62h	00h	(P+31)h = 6Ah	00h	
(P+2A)h = 63h	11h	(P+32)h = 6Bh	11h	Number of program or erase operations allowed in Bank Region 2: Bits 0-3: Number of simultaneous program operations Bits 4-7: Number of simultaneous erase operations
(P+2B)h = 64h	00h	(P+33)h = 6Ch	00h	Number of program or erase operations allowed in other banks while a bank in this region is programming Bits 0-3: Number of simultaneous program operations Bits 4-7: Number of simultaneous erase operations
(P+2C)h = 65h	00h	(P+34)h = 6Dh	00h	Number of program or erase operations allowed in other banks while a bank in this region is erasing Bits 0-3: Number of simultaneous program operations Bits 4-7: Number of simultaneous erase operations
(P+2D)h = 66h	02h	(P+35)h = 6Eh	01h	Types of erase block regions in Bank Region 2 n = number of erase block regions with contiguous same-size erase blocks. Symmetrically blocked banks have one blocking region. ⁽⁵⁾
(P+2E)h = 67h	06h	(P+36)h = 6Fh	07h	
(P+2F)h = 68h	00h	(P+37)h = 70h	00h	Bank Region 2 Erase Block Type 1 Information Bits 0-15: n+1 = number of identical-sized erase blocks
(P+30)h = 69h	00h	(P+38)h = 71h	00h	Bits 16-31: n×256 = number of bytes in erase block region
(P+31)h = 6Ah	01h	(P+39)h = 72h	01h	
(P+32)h = 6Bh	64h	(P+3A)h = 73h	64h	Bank Region 2 (Erase Block Type 1)
(P+33)h = 6Ch	00h	(P+3B)h = 74h	00h	Minimum block erase cycles × 1000
(P+34)h = 6Dh	01h	(P+3C)h = 75h	01h	Bank Region 2 (Erase Block Type 1): Blts per cell, internal ECC Bits 0-3: bits per cell in erase region Bit 4: reserved for "internal ECC used" Blts 5-7: reserved
(P+35)h = 6Eh	03h	(P+3D)h = 76h	03h	Bank Region 2 (Erase Block Type 1): page mode and synchronous mode capabilities (defined in <i>Table 44</i>) Bit 0: Page-mode reads permitted Bit 1: Synchronous reads permitted Bit 2: Synchronous writes permitted Bits 3-7: reserved

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Table 47. Bank and Erase block region 2 information⁽¹⁾ (continued)

M58WR016KT, M58WR032KT, M58WR064KT		M58WR016KB, M58WR032KB, M58WR064KB		Description
Offset	Data	Offset	Data	
(P+36)h = 6Fh	07h			
(P+37)h = 70h	00h			Bank Region 2 Erase Block Type 2 Information
(P+38)h = 71h	20h			Bits 0-15: n+1 = number of identical-sized erase blocks Bits 16-31: n×256 = number of bytes in erase block region
(P+39)h = 72h	00h			
(P+3A)h = 73h	64h			Bank Region 2 (Erase Block Type 2)
(P+3B)h = 74h	00h			Minimum block erase cycles × 1000
(P+3C)h = 75h	01h			Bank Region 2 (Erase Block Type 2): Blts per cell, internal ECC Bits 0-3: bits per cell in erase region Bit 4: reserved for "internal ECC used" Blts 5-7: reserved
(P+3D)h = 76h	03h			Bank Region 2 (Erase Block Type 2): page mode and synchronous mode capabilities (defined in <i>Table 44</i>) Bit 0: Page-mode reads permitted Bit 1: Synchronous reads permitted Bit 2: Synchronous writes permitted Bits 3-7: reserved
(P+3E)h = 77h		(P+3E)h = 77h		Feature Space definitions
(P+3F)h = 78h		(P+3F)h = 78h		Reserved

^{1.} The variable P is a pointer which is defined at CFI offset 15h.

^{2.} Applies to M58WR016KB.

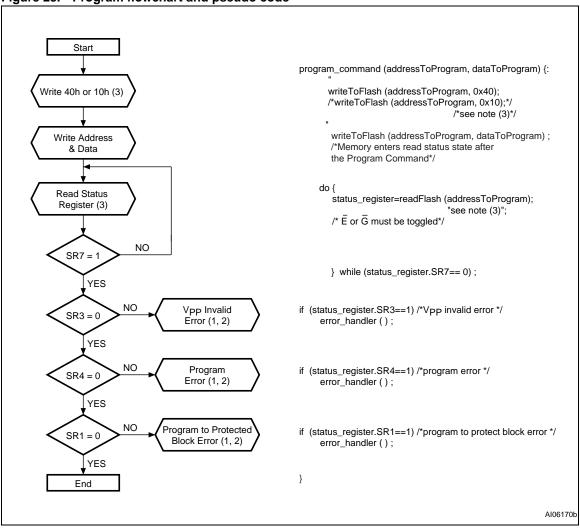
^{3.} Applies to M58WR032KB.

^{4.} Applies to M58WR064KB.

^{5.} Bank Regions. There are two Bank Regions, see Tables 32, 33, 34, 35, 36 and 37.

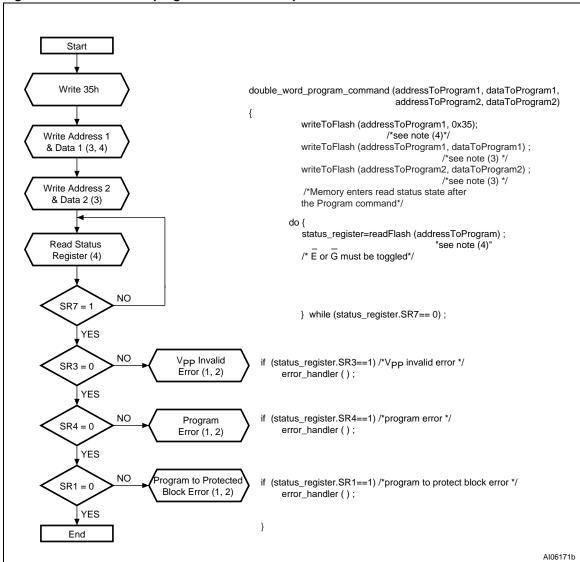
Appendix C Flowcharts and pseudo codes

Figure 23. Program flowchart and pseudo code



- Status check of SR1 (Protected Block), SR3 (V_{PP} Invalid) and SR4 (Program Error) can be made after each program operation or after a sequence.
- 2. If an error is found, the Status Register must be cleared before further Program/Erase Controller operations.
- Any address within the bank can equally be used.

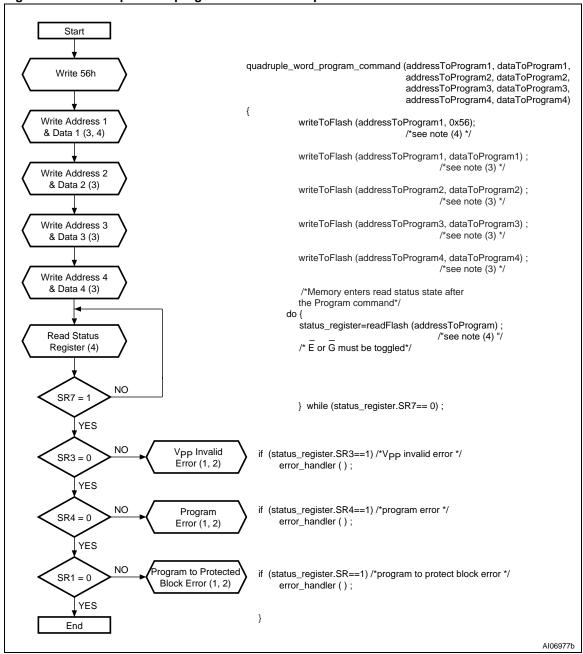
Figure 24. Double word program flowchart and pseudo code



- Status check of SR1 (Protected Block), SR3 (V_{PP} Invalid) and SR4 (Program Error) can be made after each program operation or after a sequence.
- 2. If an error is found, the Status Register must be cleared before further Program/Erase operations.
- 3. Address 1 and Address 2 must be consecutive addresses differing only for bit A0.
- 4. Any address within the bank can equally be used.

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Figure 25. Quadruple word program flowchart and pseudo code



- Status check of SR1 (Protected Block), SR3 (V_{PP} Invalid) and SR4 (Program Error) can be made after each program operation or after a sequence.
- 2. If an error is found, the Status Register must be cleared before further Program/Erase operations.
- 3. Address 1 to Address 4 must be consecutive addresses differing only for bits A0 and A1.
- 4. Any address within the bank can equally be used.

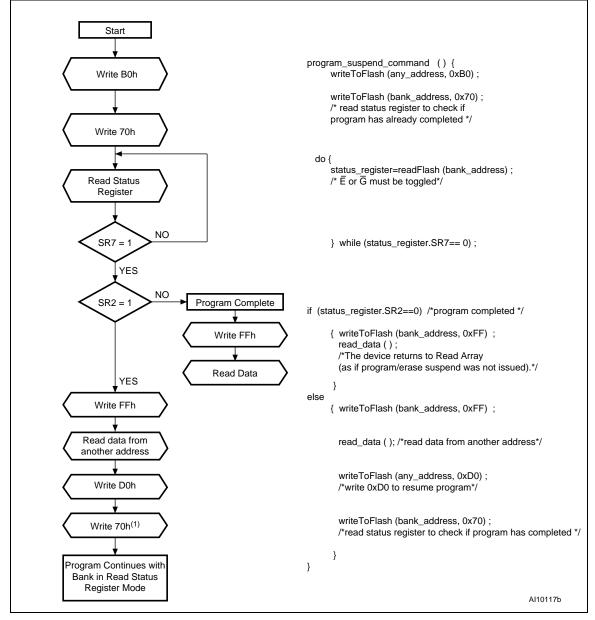
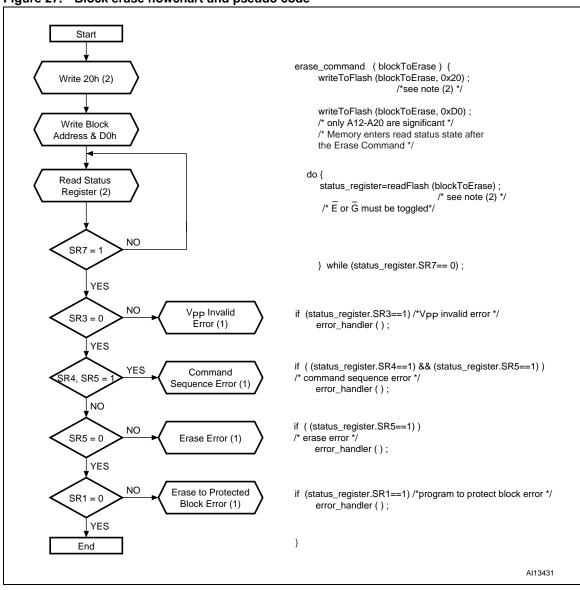


Figure 26. Program suspend and resume flowchart and pseudo code

1. The Read Status Register command (Write 70h) can be issued just before or just after the Program Resume command.

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Figure 27. Block erase flowchart and pseudo code



- 1. If an error is found, the Status Register must be cleared before further Program/Erase operations.
- 2. Any address within the bank can be used also.

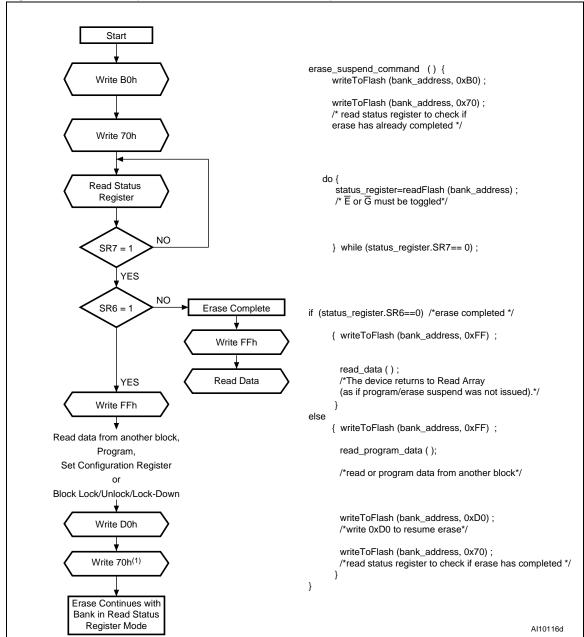
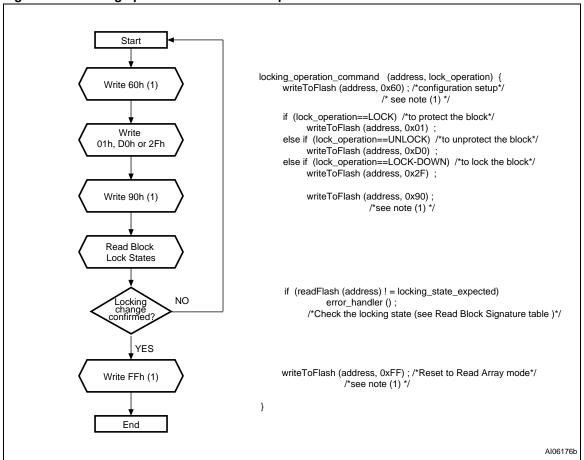


Figure 28. Erase suspend and resume flowchart and pseudo code

1. The Read Status Register command (Write 70h) can be issued just before or just after the Erase Resume command.

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Figure 29. Locking operations flowchart and pseudo code



1. Any address within the bank can equally be used.

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Start protection_register_program_command (addressToProgram, dataToProgram) {: Write C0h (3) writeToFlash (addressToProgram, 0xC0); /*see note (3) */ writeToFlash (addressToProgram, dataToProgram) ; Write Address /*Memory enters read status state after & Data the Program Command*/ Read Status status_register=readFlash (addressToProgram); Register (3) /* see note (3) */ /* E or G must be toggled*/ NO SR7 = 1} while (status_register.SR7== 0); YES NO V_{PP} Invalid if (status_register.SR3==1) /*VPP invalid error */ SR3 = 0Error (1, 2) error_handler(); YES NO Program if (status_register.SR4==1) /*program error */ SR4 = 0 Error (1, 2) error_handler(); YES NO Program to Protected if (status_register.SR1==1) /*program to protect block error */ SR1 = 0 Block Error (1, 2) error_handler(); YES End AI06177b

Figure 30. Protection Register program flowchart and pseudo code

- Status check of SR1 (Protected Block), SR3 (V_{PP} Invalid) and SR4 (Program Error) can be made after each program operation or after a sequence.
- 2. If an error is found, the Status Register must be cleared before further Program/Erase Controller operations.
- 3. Any address within the bank can equally be used.

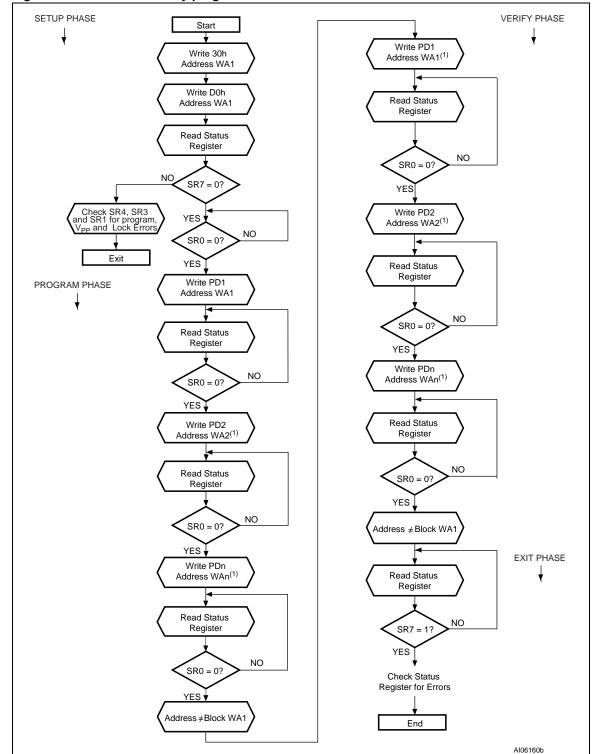


Figure 31. Enhanced factory program flowchart

1. Address can remain Starting Address WA1 or be incremented.

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16.1 Enhanced factory program pseudo code

```
efp command(addressFlow,dataFlow,n)
/* n is the number of data to be programmed */
{
   /* setup phase */
  writeToFlash(addressFlow[0],0x30);
  writeToFlash(addressFlow[0],0xD0);
  status register=readFlash(any address);
  if (status_register.SR7==1) {
      /*EFP aborted for an error*/
     if (status register.SR4==1) /*program error*/
        error_handler();
      if (status register.SR3==1) /*VPP invalid error*/
        error_handler();
     if (status register.SR1==1) /*program to protect block error*/
        error handler();
  else{
      /*Program Phase*/
        status_register=readFlash(any_address);
         /* E or G must be toggled*/
      } while (status_register.SR0==1)
      /*Ready for first data*/
      for (i=0; i++; i < n) {
        writeToFlash(addressFlow[i],dataFlow[i]);
         /* status register polling*/
        do{
           status register=readFlash(any address);
            /* E or G must be toggled*/
         } while (status register.SR0==1);
         /* Ready for a new data */
      writeToFlash(another_block_address,any_data);
      /* Verify Phase */
     for (i=0; i++; i < n) {
        writeToFlash(addressFlow[i],dataFlow[i]);
         /* status register polling*/
        do{
           status_register=readFlash(any_address);
            /* E or G must be toggled*/
         } while (status_register.SR0==1);
         /* Ready for a new data */
     writeToFlash(another block address, any data);
      /* exit program phase */
      /* Exit Phase */
      /* status register polling */
     do{
        status register=readFlash(any address);
        /* E or G must be toggled */
      } while (status_register.SR7==0);
      if (status register.SR4==1) /*program failure error*/
        error handler();
      if (status_register.SR3==1) /*VPP invalid error*/
        error handler();
     if (status register.SR1==1) /*program to protect block error*/
        error handler();
}
```

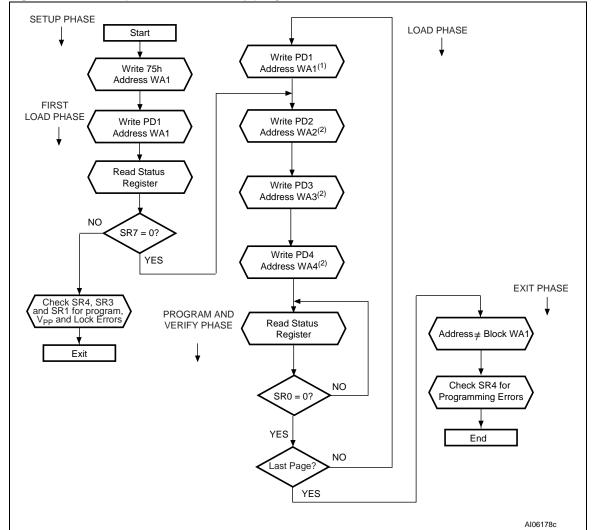


Figure 32. Quadruple enhanced factory program flowchart

- Address can remain Starting Address WA1 (in which case the next page is programmed) or can be any address in the same block.
- The address is only checked for the first word of each page as the order to program the words is fixed, so subsequent words in each page can be written to any address.

16.2 Quadruple enhanced factory program pseudo code

```
quad_efp_command(addressFlow,dataFlow,n)
/* n is the number of pages to be programmed.*/
            {
      /* Setup phase */
   writeToFlash(addressFlow[0],0x75);
     for (i=0; i++; i < n) {
                              /*Data Load Phase*/
      /*First Data*/
      writeToFlash(addressFlow[i],dataFlow[i,0]);
            /*at the first data of the first page, Quad-EFP may be aborted*/
      if (First_Page) {
                  status register=readFlash(any address);
                  if (status_register.SR7==1) {
            /*EFP aborted for an error*/
                       if (status_register.SR4==1) /*program error*/
               error handler();
                       if (status register.SR3==1) /*VPP invalid error*/
               error handler();
                        if (status register.SR1==1) /*program to protect block
error*/
              error handler();
        }
      /*2nd data*/
            writeToFlash(addressFlow[i],dataFlow[i,1]);
      /*3rd data*/
                  writeToFlash(addressFlow[i],dataFlow[i,2]);
            writeToFlash(addressFlow[i],dataFlow[i,3]);
      /* Program&Verify Phase */
     do{
        status_register=readFlash(any_address);
         /* E or G must be toggled*/
      }while (status register.SR0==1)
   /* Exit Phase */
   writeToFlash(another block address, any data);
      /* status register polling */
     status_register=readFlash(any_address);
      /* E or G must be toggled */
   } while (status register.SR7==0);
        if (status_register.SR1==1) /*program to protected block error*/
      error handler();
     if (status register.SR3==1) /*VPP invalid error*/
     error handler();
     if (status_register.SR4==1) /*program failure error*/
      error handler();
}
```

Appendix D Command interface state tables

Table 48. Command interface states - modify table, next state⁽¹⁾

		Command Input											
Current CI State		Read Array ⁽²⁾ (FFh)	WP setup ⁽³⁾⁽⁴⁾ (10/40h)	DWP, QWP Setup ⁽³⁾⁽⁴⁾ (35h, 56h)	Block Erase Setup ⁽³⁾⁽⁴⁾ (20h)	EFP Setup (30h)	Quad-EFP Setup (75h)	Erase Confirm, P/E Resume, Block Unlock confirm, EFP Confirm (D0h)	Program/ Erase Suspend (B0h)	Read Status Register (70h)	Clear Status Register (5) (50h)	Read Electronic signature, Read CFI Query (90h, 98h)	
						Quad-EFP Setup		-	Ready				
Lock/	CR Setup			Ready (Loc	k Error)			Ready		Ready (L	ock Error)	
	Setup						OTP Bu	sy					
ОТР	Busy	OTP Busy		IS in	n OTP busy				0	TP Busy			
	IS in OTP busy		OTP busy										
	Setup						Program E	Busy					
	Busy	Program busy									Program busy		
Program	IS in Program busy	Program Busy											
	Suspend	PS		IS in Pro	ogram Susp	end		Program Busy	rogram Busy Program Suspend				
	IS in PS		Program suspend										
	Setup		Ready (error)						Ready (error)				
	Busy	Erase Busy		IS in	Erase busy	/		Erase Busy	ES Erase Busy			sy	
	IS in Erase busy	Erase busy											
	Suspend	ES	Program in ES	Į:	S in Erase S	Suspen	d	Erase Busy	Erase Suspend				
	IS in ES	ES Erase Suspend											
	Setup	Program Busy in Erase Suspend											
	Busy	Program Busy in ES	IS ii	n Program E	pend	Program Busy in ES	PS in ES	Progr	am Busy i Suspend				
	IS in Program busy in ES				F	Progran	n Busy in Er	rase Suspend					
	Suspend	PS in ES			Program Busy in ES Program Suspend in Erase Suspend								
	IS in PS in ES	Program Suspend in Erase Suspend											
Lock/CR	Setup in ES		Eras	e Suspend		ES	Erase Suspend (Lock Error)						

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Table 48. Command interface states - modify table, next state⁽¹⁾ (continued)

			Command Input											
Current CI State		Read Array ⁽²⁾ (FFh)		DWP, QWP Setup ⁽³⁾⁽⁴⁾ (35h, 56h)	Block Erase Setup ⁽³⁾⁽⁴⁾ (20h)		Quad-EFP Setup (75h)	Erase Confirm, P/E Resume, Block Unlock confirm, EFP Confirm (D0h)	Program/ Erase Suspend (B0h)	01-1	Clear Status Register (5)	Read Electronic signature, Read CFI Query (90h, 98h)		
	Setup		Ready (error)						Ready (error)					
EFP	Busy	EFP Busy ⁽⁶⁾ EFP Verify ⁽⁶⁾												
	Verify													
Quad	Setup	Quad EFP Busy ⁽⁶⁾												
EFP	Busy		•		•	(Quad EFP B	Busy ⁽⁶⁾						

- CI = Command Interface, CR = Configuration Register, EFP = Enhanced Factory Program, Quad EFP = Quadruple Enhanced Factory Program, DWP = Double Word Program, QWP = Quadruple Word Program, P/EC = Program/Erase Controller, PS = program suspend, ES = erase suspend, IS = Illegal state.
- 2. At Power-Up, all banks are in read array mode. A Read Array command issued to a busy bank, results in undetermined data output.
- 3. The two cycle command should be issued to the same bank address.
- 4. If the P/EC is active, both cycles are ignored.
- 5. The Clear Status Register command clears the Status Register error bits except when the P/EC is busy or suspended.
- EFP and Quad EFP are allowed only when Status Register bit SR0 is set to '0'.EFP and Quad EFP are busy if Block Address is first EFP Address. Any other commands are treated as data.

Table 49. Command interface states - modify table, next output⁽¹⁾

	Command Input ⁽²⁾									
Current CI State	Read Array ⁽³⁾ (FFh)	DWP, QWP Setup ⁽⁴⁾⁽⁵⁾ (35h, 56h)	Block Erase Setup ⁽⁴⁾⁽⁵⁾ (20h)	EFP Setup (30h)	Quad- EFP Setup (75h)	Erase Confirm P/E Resume, Block Unlock confirm, EFP Confirm (D0h)	Program/ Erase Suspend (B0h)	Read Status Register (70h)	Clear Status Register ⁽⁶⁾ (50h)	Read Electronic signature, Read CFI Query (90h, 98h)
Program Setup										
Erase Setup										
OTP Setup										
Program Setup in Erase Suspend										
EFP Setup										
EFP Busy						Status Register				
EFP Verify										
Quad EFP Setup										
Quad EFP Busy										
Lock/CR Setup										
Lock/CR Setup in Erase Suspend										
OTP Busy										Status Register
Ready										
Program Busy										
Erase Busy								Status	Output	
Program/Erase Suspend	Array	Array Status Register		gister		Output Uncl	Output Unchanged	Status Register	Unchanged	Electronic Signature/CFI
Program Busy in Erase Suspend										
Program Suspend in Erase Suspend										
Illegal State		Output Unchanged								

- CI = Command Interface, CR = Configuration Register, EFP = Enhanced Factory Program, Quad EFP = Quadruple Enhanced Factory Program, DWP = Double Word Program, QWP = Quadruple Word Program, P/EC = Program/Erase Controller, IS = Illegal State, ES = Erase suspend, PS = Program suspend.
- 2. The output state shows the type of data that appears at the outputs if the bank address is the same as the command address. A bank can be placed in read array, Read Status Register, Read Electronic Signature or Read CFI Query mode, depending on the command issued. Each bank remains in its last output state until a new command is issued. The next state does not depend on the bank's output state.
- 3. At Power-Up, all banks are in read array mode. A Read Array command issued to a busy bank, results in undetermined data output.
- 4. The two cycle command should be issued to the same bank address.
- 5. If the P/EC is active, both cycles are ignored.
- 6. The Clear Status Register command clears the Status Register error bits except when the P/EC is busy or suspended.

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Table 50. Command interface states - Lock table, next state⁽¹⁾

			Command Input									
Curr	Current CI State		OTP Setup ⁽²⁾ (C0h)	Block Lock Confirm (01h)	Block Lock- Down Confirm (2Fh)	Set CR Confirm (03h)	EFP Exit, Quad EFP Exit ⁽³⁾	Illegal Command ⁽⁴⁾	P/E. C. Operation Completed			
Ready		Lock/CR Setup	OTP Setup			Ready			N/A			
Loc	k/CR Setup	Ready (Loc	k error)		Ready		Ready (Ready (Lock error)				
	Setup	OTP Busy										
ОТР	Busy	IS in OTP busy OTP Busy										
	IS in OTP busy				OTP Busy				IS Ready			
	Setup			Pi	rogram Busy				N/A			
	Busy	IS in Progra	m busy		Pro	ogram Bus	sy		Ready			
Program	IS in Program busy			Р	rogram busy				IS Ready			
	Suspend	IS in F	'S		N/A							
	IS in PS	Program Suspend							N/A			
	Setup	Ready (error)							N/A			
	Busy	IS in Erase	Busy		Ready							
Erase	IS in Erase Busy	Erase Busy										
	Suspend	Lock/CR Setup in ES							N/A			
	IS in ES	Erase Suspend							N/A			
	Setup	Program Busy in Erase Suspend										
	Busy	IS in Program I	busy in ES		ES							
Program in Erase Suspend	IS in Program busy in ES			Prog	IS in ES							
	Suspend	IS in PS i	n ES		N/A							
	IS in PS in ES	Program Suspend in Erase Suspend							14/74			
Lock/C	ER Setup in ES Erase Suspend (Lock error)		(Lock error)	Erase Suspend			Erase Suspe	N/A				
	Setup			R	N/A							
EFP	Busy		E	EFP Busy ⁽⁵⁾			EFP Verify	EFP Busy ⁽⁵⁾	N/A			
	Verify		E	FP Verify ⁽⁵⁾	Ready							
QuadEFP	Setup			Qua	id EFP Busy ⁽⁵⁾				N/A			
QuaderP	Busy	Quad EFP Busy ⁽⁵⁾						Quad EFP Busy ⁽⁴⁾	Ready			

CI = Command Interface, CR = Configuration Register, EFP = Enhanced Factory Program, Quad EFP = Quadruple Enhanced Factory Program, P/EC = Program/Erase Controller, IS = Illegal state, ES = Erase suspend, PS = Program suspend.

- 2. If the P/EC is active, both cycles are ignored.
- 3. EFP and Quad EFP exit when block address is different from first block address.
- 4. Illegal commands are those not defined in the command set.
- 5. EFP and Quad EFP are allowed only when Status Register bit SR0 is set to '0'. EFP and Quad EFP are busy if Block Address is first EFP Address. Any other commands are treated as data.

Table 51. Command interface states - lock table, next output⁽¹⁾

	Command Input								
Current CI State	Lock/CR Setup ⁽²⁾ (60h)	OTP Setup ⁽²⁾ (C0h)	Block Lock Confirm (01h)	Block Lock- Down Confirm (2Fh)	Set CR Confirm (03h)	EFP Exit, Quad EFP Exit ⁽³⁾	Illegal Command ⁽⁴⁾	P/E. C. Operation Completed	
Program Setup									
Erase Setup									
OTP Setup									
Program Setup in Erase Suspend									
EFP Setup				Status Register					
EFP Busy									
EFP Verify									
Quad EFP Setup									
Quad EFP Busy									
Lock/CR Setup					_			Output Unchanged	
Lock/CR Setup in Erase Suspend	Status Register Array						Status Register		
OTP Busy									
Ready									
Program Busy									
Erase Busy	Ctatus F	Da mintan					Output Unchanged		
Program/Erase Suspend	Status F	xegister		output Unchange	ea	Array			
Program Busy in Erase Suspend									
Program Suspend in Erase Suspend									
Illegal State		Output Unchanged							

CI = Command Interface, CR = Configuration Register, EFP = Enhanced Factory Program, Quad EFP = Quadruple Enhanced Factory Program, P/E. C. = Program/Erase Controller.

- 2. If the P/EC is active, both cycles are ignored.
- 3. EFP and Quad EFP exit when Block Address is different from first Block Address.
- 4. Illegal commands are those not defined in the command set.

Revision history

Table 52. Document revision history

Date	Revision	Changes
15-Feb-2007	1	Initial release.
21-Nov-2007	2	Changed Section 6.3.1 through Section 6.3.4, and Section 6.4.1 through Section 6.4.4 to third-level headings. Changed NOT VALID to VALID for the DQ0-DQ15 timing in Figure 16: Synchronous burst read suspend AC waveforms. Changed the Synchronous burst read mode value from 86 MHz to 66 MHz in the Features on page 1 and in Section 1: Description. Removed the 60 ns speed class from the entire document, specifically Table 11: Latency settings, Table 20: Operating and AC measurement conditions, Table 24: Asynchronous read AC characteristics, Table 25: Synchronous read AC characteristics, Table 26: Write AC characteristics, Write Enable controlled, Table 27: Write AC characteristics, Chip Enable controlled, Table 28: Reset and power-up AC characteristics, and Table 31: Ordering information scheme. Deleted the 86 MHz currents from Table 22: DC characteristics - currents and Table 25. Changed the t _{KHQX} value from 3 ns to 4 ns in Table 25.
06-Mar-2008	3	Added the ZAQ package information in Figure 3: TFBGA88 connections (top view through package), Figure 22: TFBGA88 8x10mm - 8 x 10 ball array, 0.8 mm pitch, bottom view outline, Table 30: TFBGA88 8 x 10 mm - 8 x 10 ball array, 0.8 mm pitch, package data, and Table 31: Ordering information scheme. Changed the IDD ₂ values from 2 and 10 to 15 and 50 respectively in Table 22: DC characteristics - currents. Removed t _{LHGL} from Figure 12: Asynchronous random access read AC waveforms, Figure 13: Asynchronous page read AC waveforms, and Table 22: DC characteristics - currents
24-Apr-2008	4	Changed several values in <i>Table 22: DC characteristics - currents</i> . Applied Numonyx branding.

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